



# Status and perspectives of SiPMs

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# Fondazione Bruno Kessler

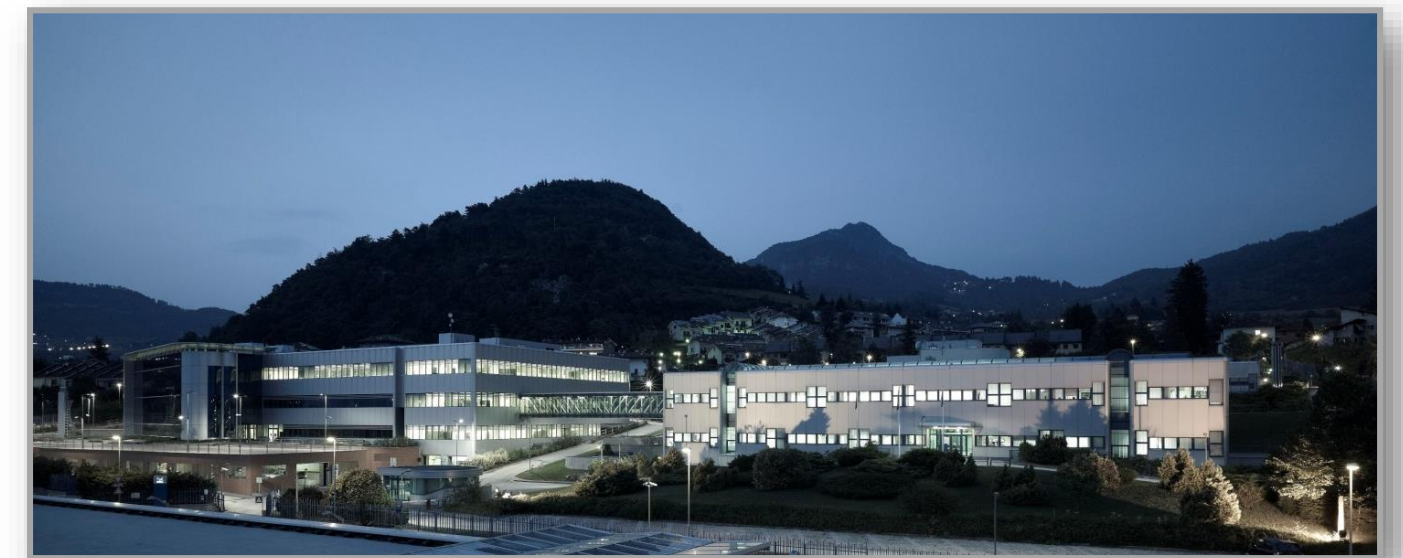
## Custom Silicon Photomultipliers



Detector-grade clean-room, 6 inches, class 10 and 100



Silicon Photomultipliers account for a significant portion of the detectors fabricated here.



Private Research Foundation

- ~400 researchers in different fields, ranging from Microelectronics to Information Technology
- 50% funding from local government
- 50% self-funding rate
  - 25% from publicly funded research
  - 25% from collaboration with companies

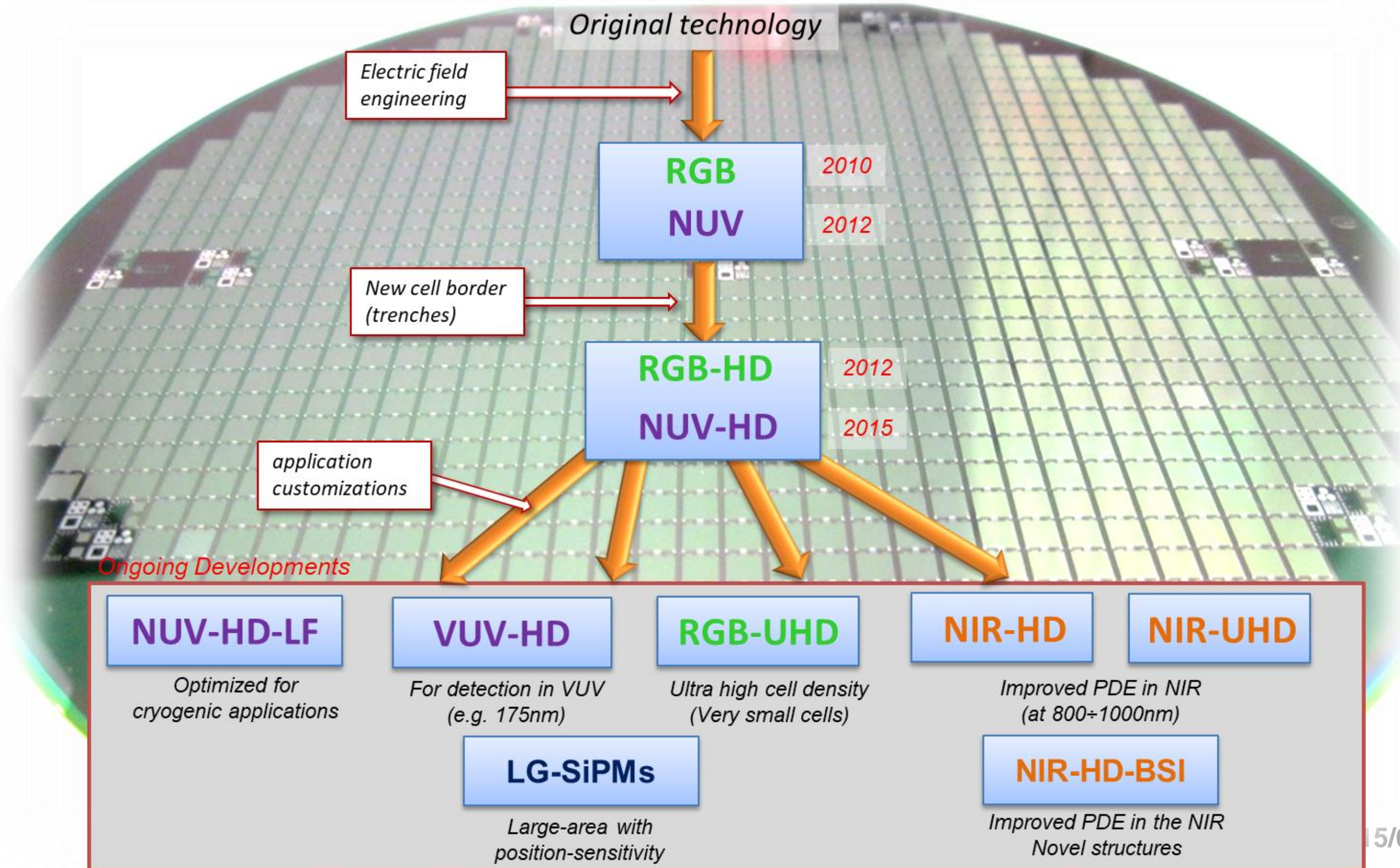
FBK is typically interested in R&D activities and collaborations to improve and customize SiPM technology for specific applications.

Large area productions can be carried out in FBK (up to ~5 sqm) or relying on external partners (low cost): success stories of technology transfers.



# Fondazione Bruno Kessler

## Custom SiPM technology roadmap

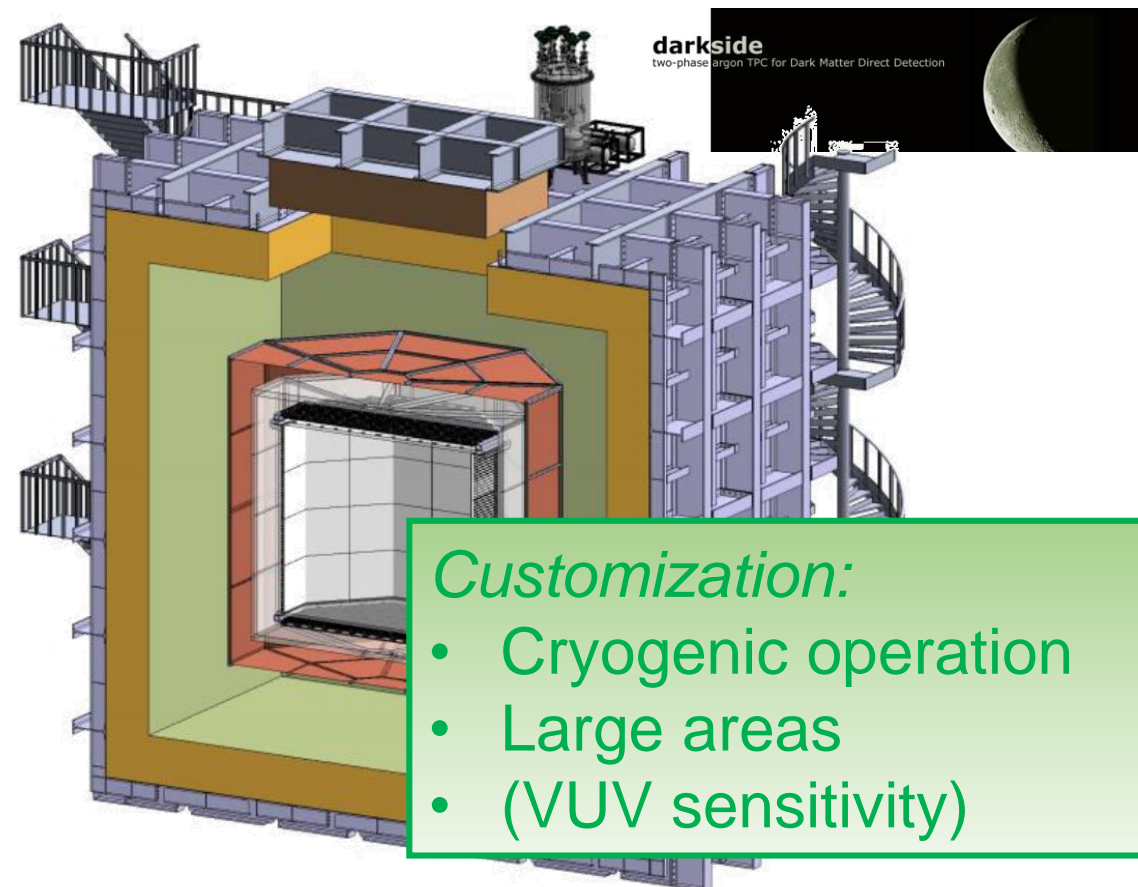


# FBK SiPM technologies

## Use in Big Physics Experiments

Thanks to constant *performance improvement*, SiPM technologies are now used in several upgrades of Big Physics Experiments: *deep customization is often required*.

### Cryogenic TPCs



#### Customization:

- Cryogenic operation
- Large areas
- (VUV sensitivity)

Cryogenic SiPMs will be employed in experiments such as DarkSide-20k

### CTA



#### Customization:

- Low CT
- Maximum PDE

Prototype pSCT installed in the VERITAS, equipped with FBK SiPMs.

### HEP



#### Customization:

- Radiation hardness
- Timing

NUV-HD SiPMs are being evaluated for the MIP timing detector of CMS (LYSO scintillator readout).

# **FBK SiPM technologies**

## **Current R&D activities and Roadmap**

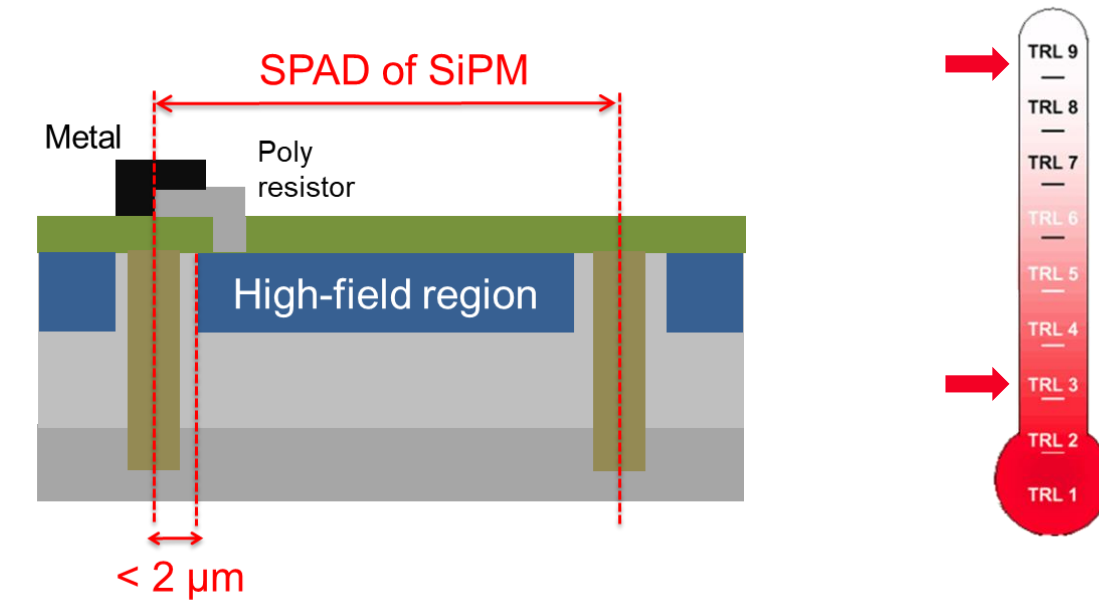
Outline:

- **Timing performance**
- **Reduction of Optical Crosstalk**
- **Cryogenic operation**
- **Radiation Hardness**
- **Light concentration**
- **Future developments: 2.5 and 3D integration**

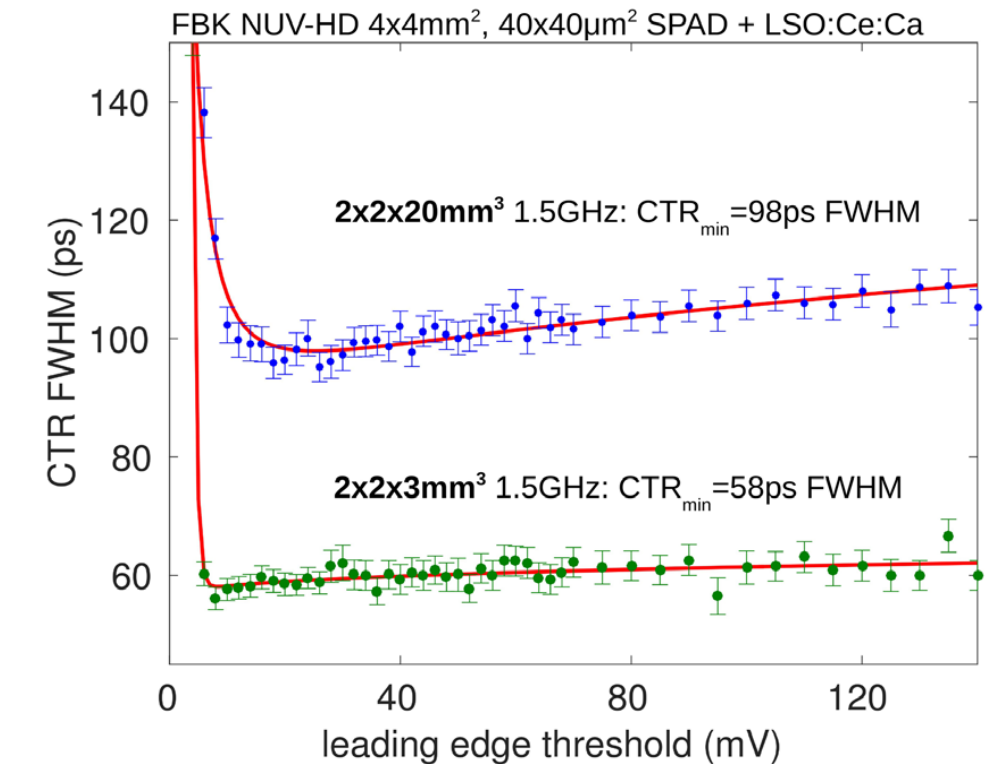
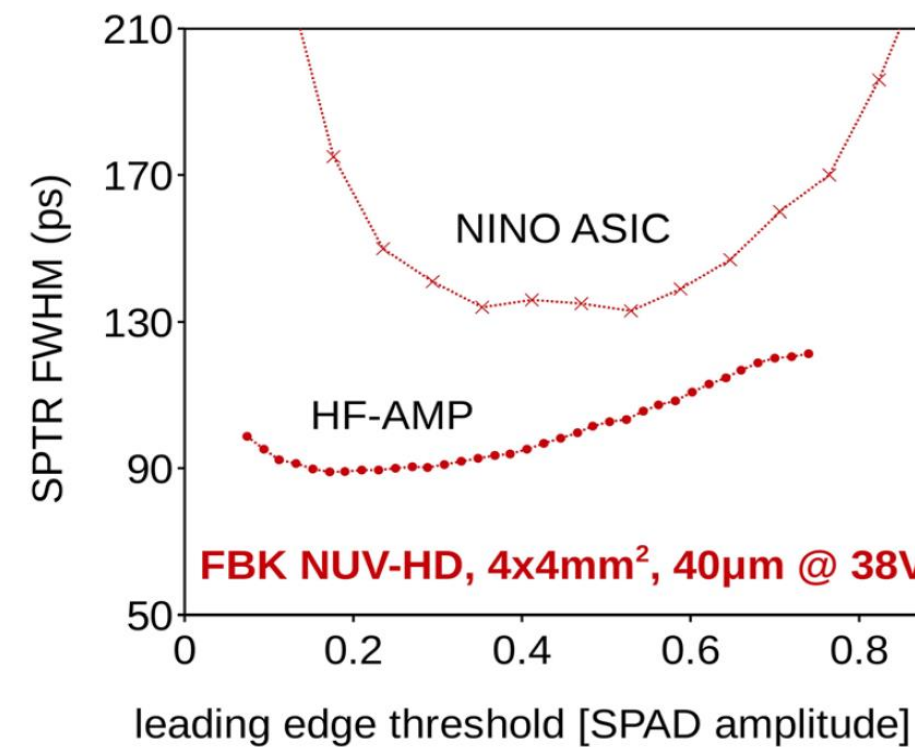
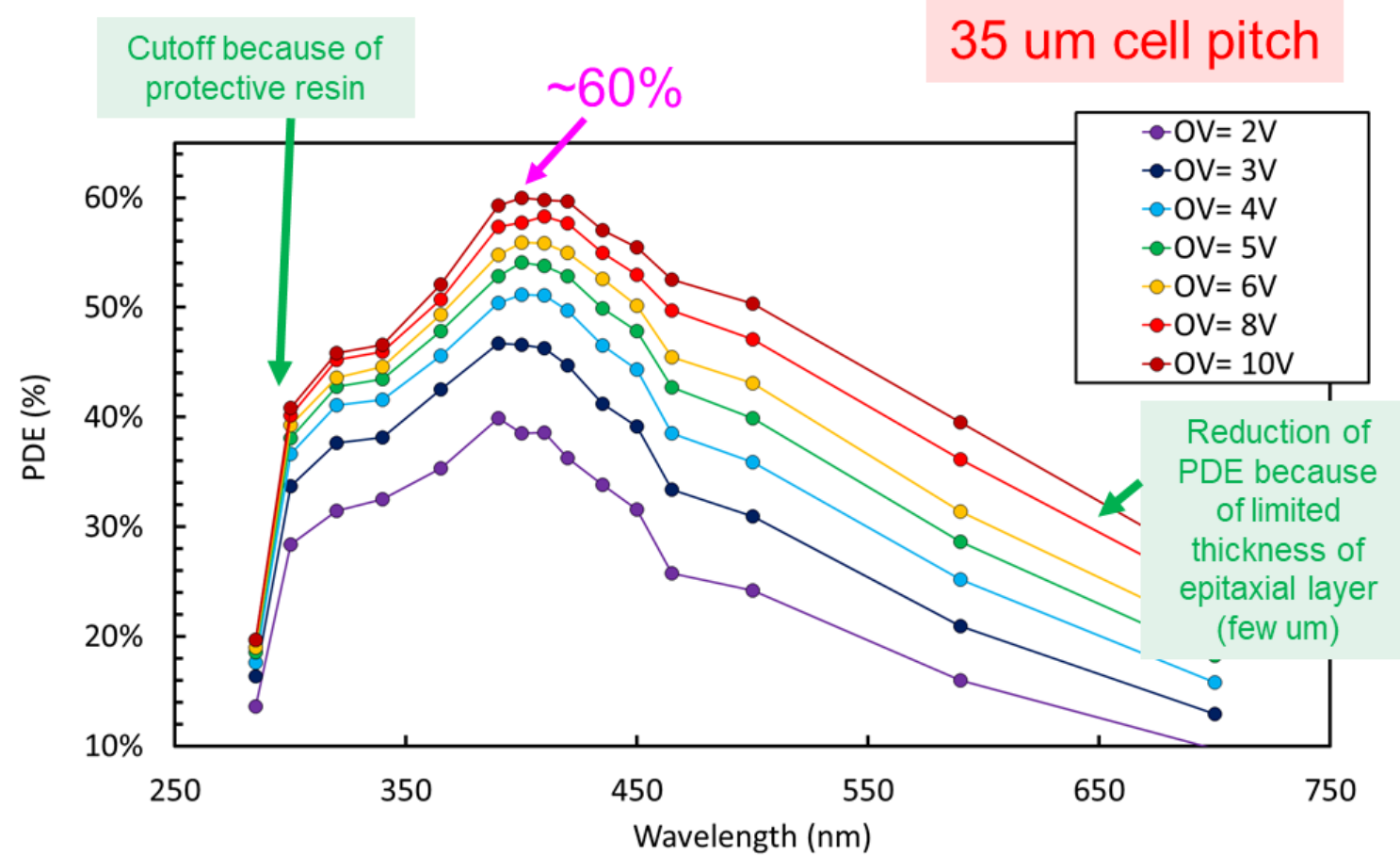
# FBK SiPM technologies

## NUV-HD SiPM technology

NUV-HD SiPMs provide *state-of-the-art performance* for single photon detection, timing and for scintillation light readout.



Timing with High-frequency readout (FWHM)



Gola, A et al. (2019). "NUV-Sensitive Silicon Photomultiplier Technologies Developed at Fondazione Bruno Kessler." *Sensors*, 19(2), 308.

World record timing resolution: Single Photon Time resolution (SPTR, left) and Coincidence Resolving Time (CRT) in LYSO readout (right).

Gundacker, Stefan, et al. "High-frequency SiPM readout advances measured coincidence time resolution limits in TOF-PET." *Physics in Medicine & Biology* 64.5 (2019): 055012.

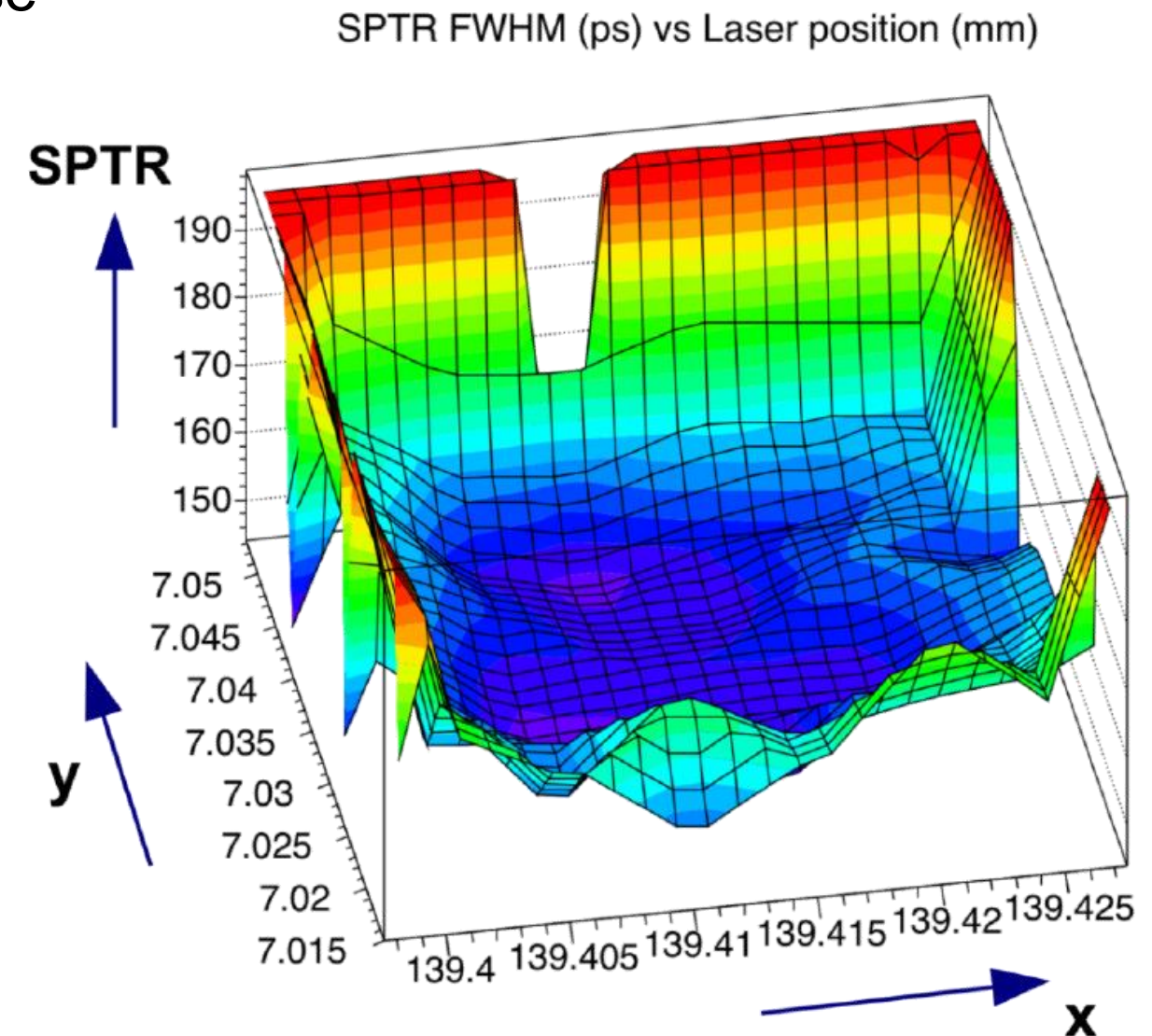
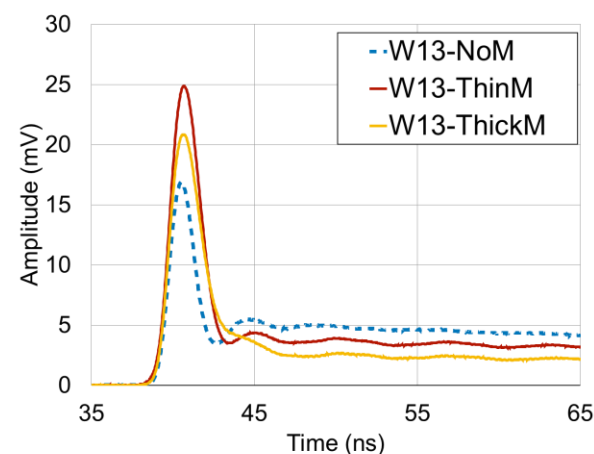
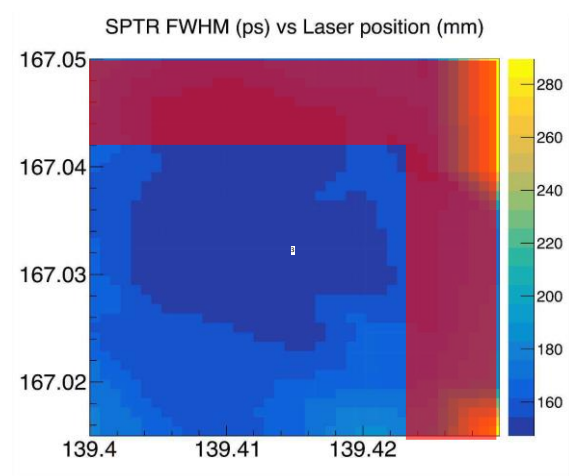
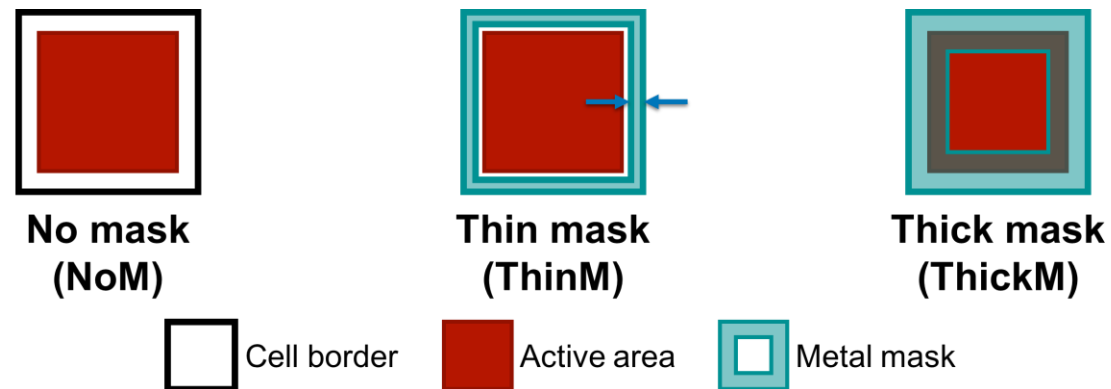


# Timing performance

## Optimization of SPTR with masking: CHK-HD

CHK-HD SiPMs is a variant of the NUV-HD SiPMs built to *experiment solutions to improve SPTR and detection efficiency* in applications where it matters the most, such as Cherenkov light readout.

- **Masking of outer regions of SPAD:** Improve signal peaking and mask areas of SPAD with worse SPTR
- Changes to the **Electric field:** low-field + different spectral response



FBK NUV-HD  
Traditional readout

Masking of outer regions of the SPAD that have worse "local" SPTR.

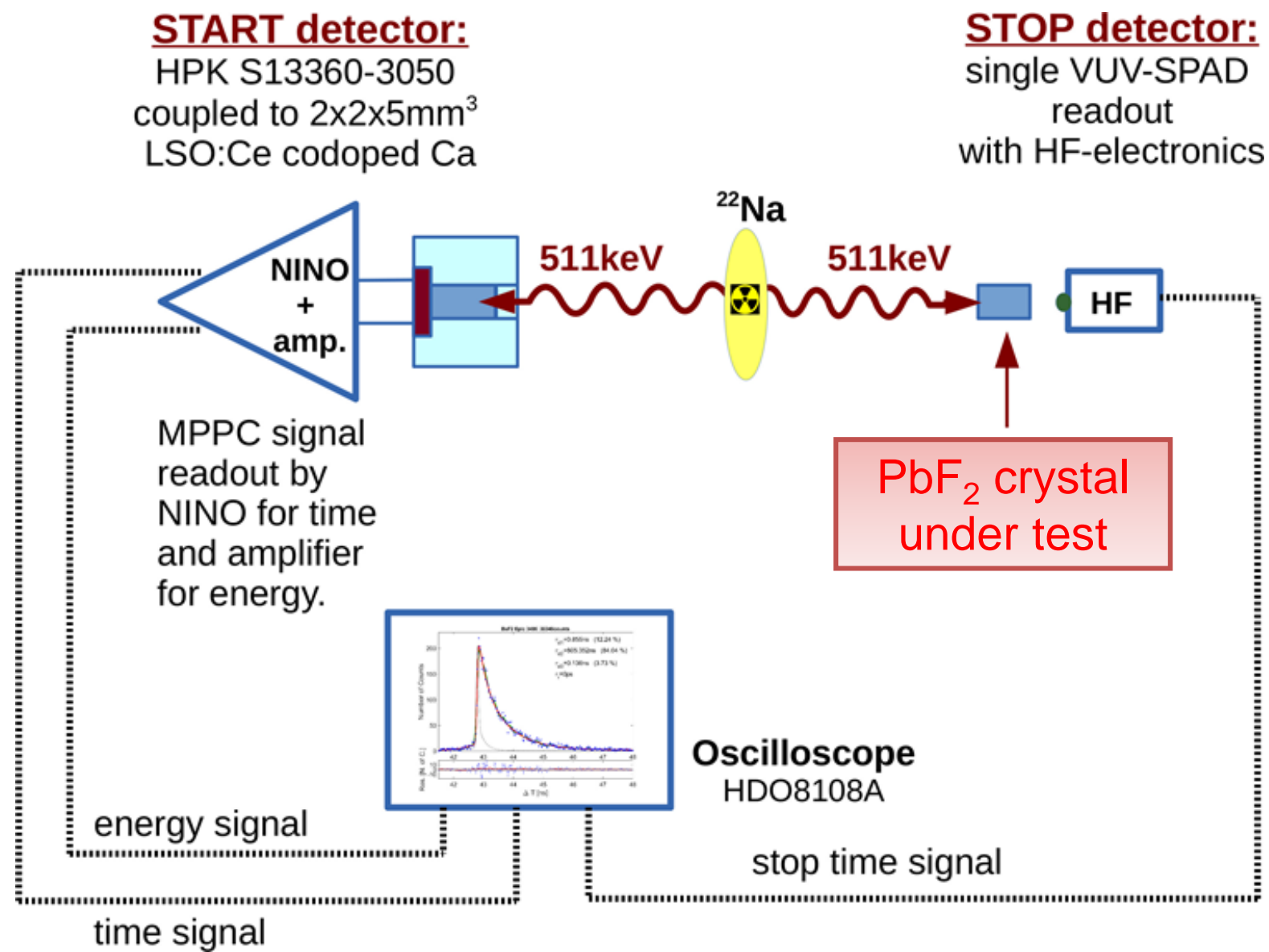
Increase of fast component of single photoelectron signal in accordance with masking extension.



Nemallapudi, M. V., et al. "Single photon time resolution of state of the art SiPMs." *Journal of Instrumentation* 11.10 (2016): P10016.

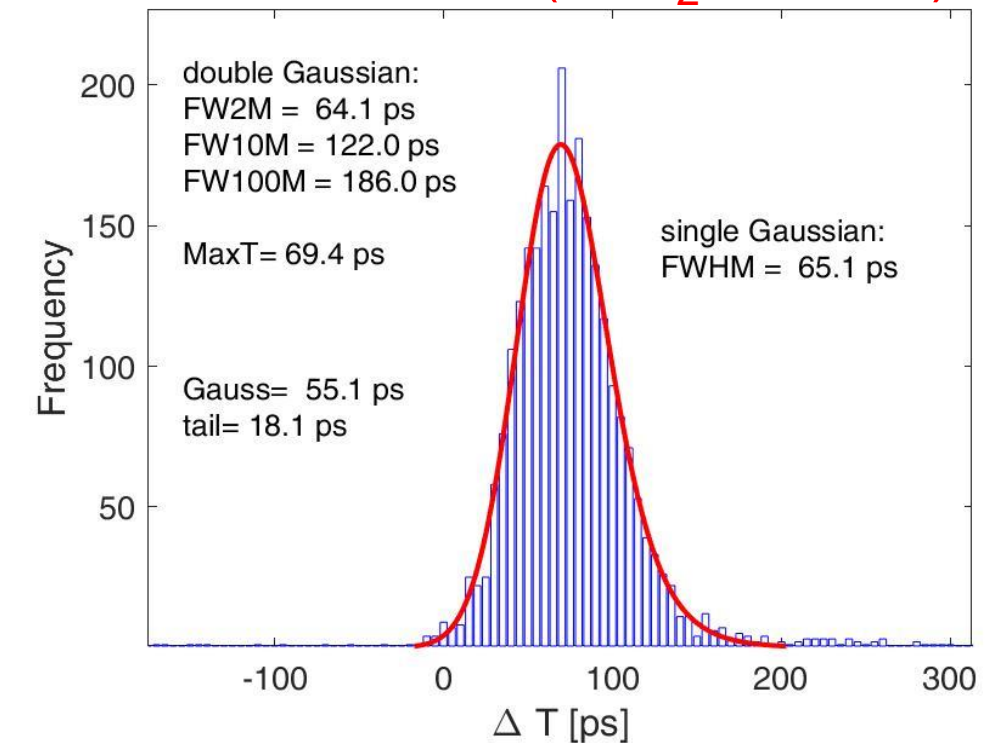
# Timing performance Optimization of SPTR with masking: CHK-HD

Using CHK-HD and high-frequency readout, S. Gundacker was able to measure excellent Single Photon Time Resolution, with a 3x3 mm<sup>2</sup> SiPM.



Intrinsic SPTR

SPTR FWHM (PbF<sub>2</sub> method)



$$SPTR_{intrinsic} = \sqrt{65^2 - 47^2 - 21^2} = 39.6 \text{ ps}$$



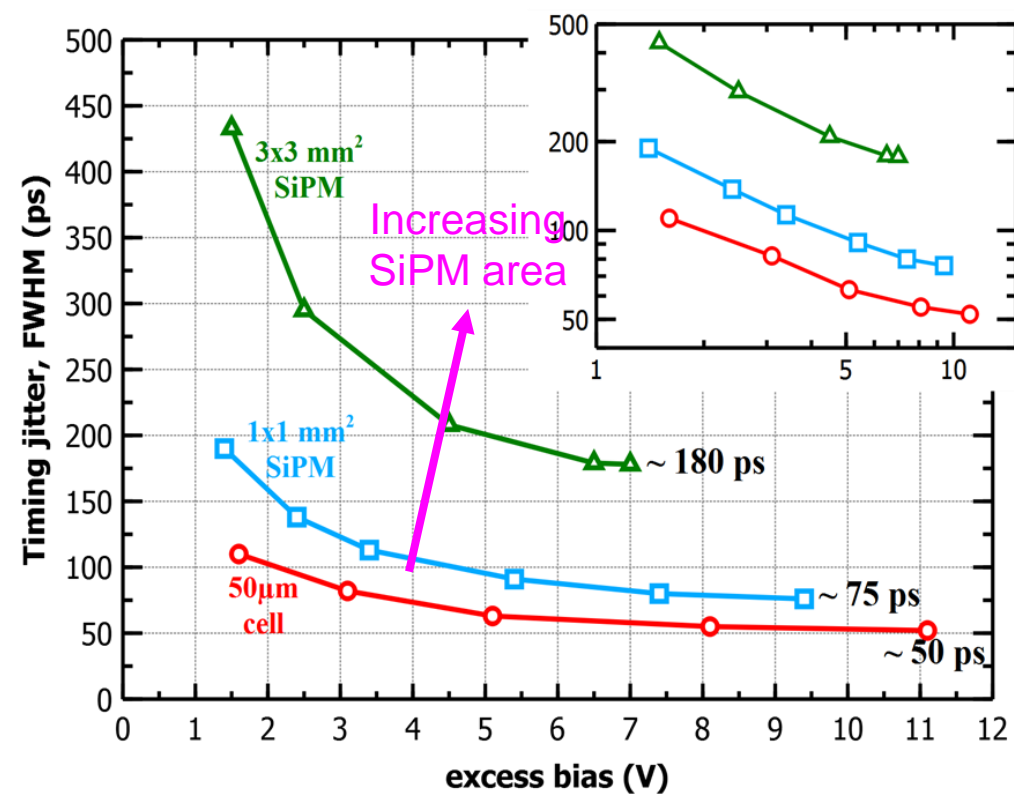
# Timing performance

## Effect of SiPM area on SPTR

*SPTR and CRT performance is degraded* when reading out SiPMs with *large areas*.

A possible solution can be the *segmentation of the active area into small pixels*, with separate readout, followed by signal summation or combination of time pick-off information.

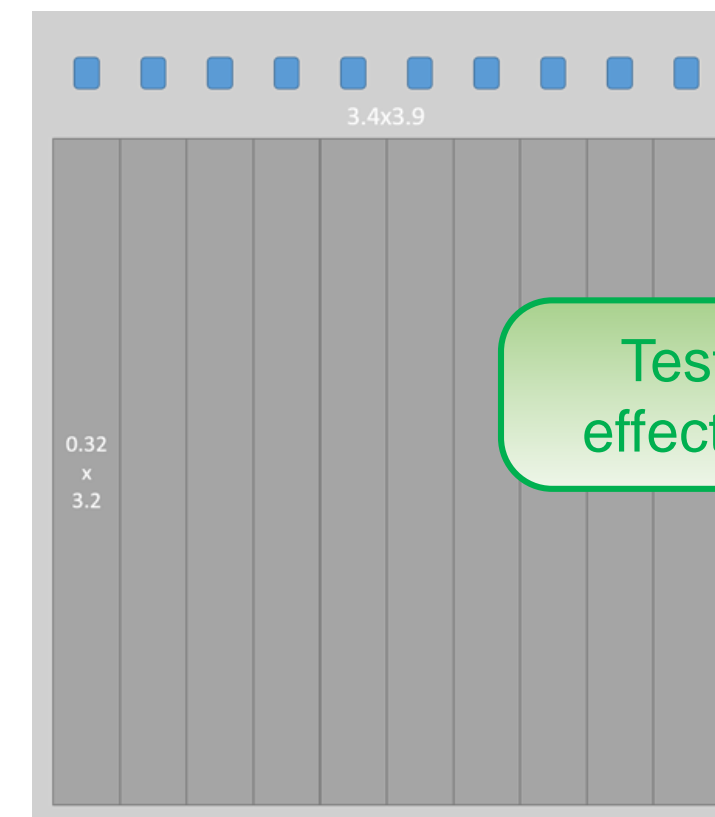
SPTR with standard FBK amplifier



SPTR vs. excess bias for different SiPM sizes, *with traditional amplifier*.

Acerbi, Fabio, et al. "Characterization of single-photon time resolution: from single SPAD to silicon photomultiplier." *IEEE Transactions on Nuclear Science* 61.5 (2014): 2678-2686.

Strip SiPMs



**10 strips**  
0.32 x 3.2 mm<sup>2</sup>  
each, no dead border  
between strips

Example of segmented SiPM layout: a 3x3 mm<sup>2</sup> active area is divided in 10 0.3x3 mm<sup>2</sup> strip-SiPMs.

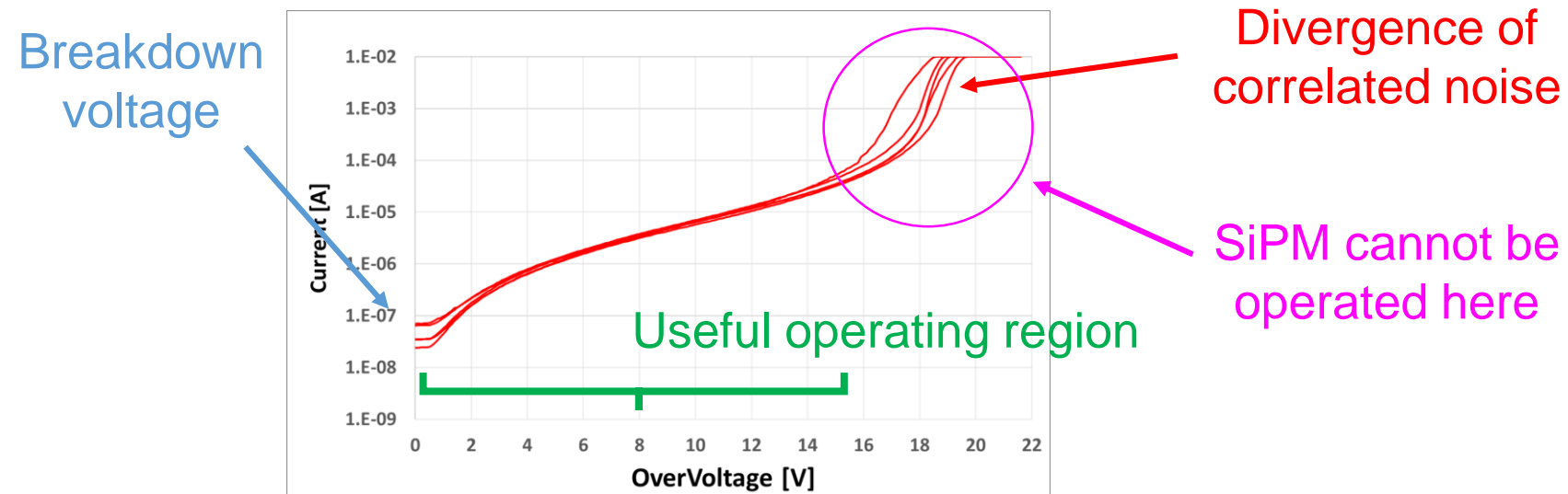


# Optical Crosstalk

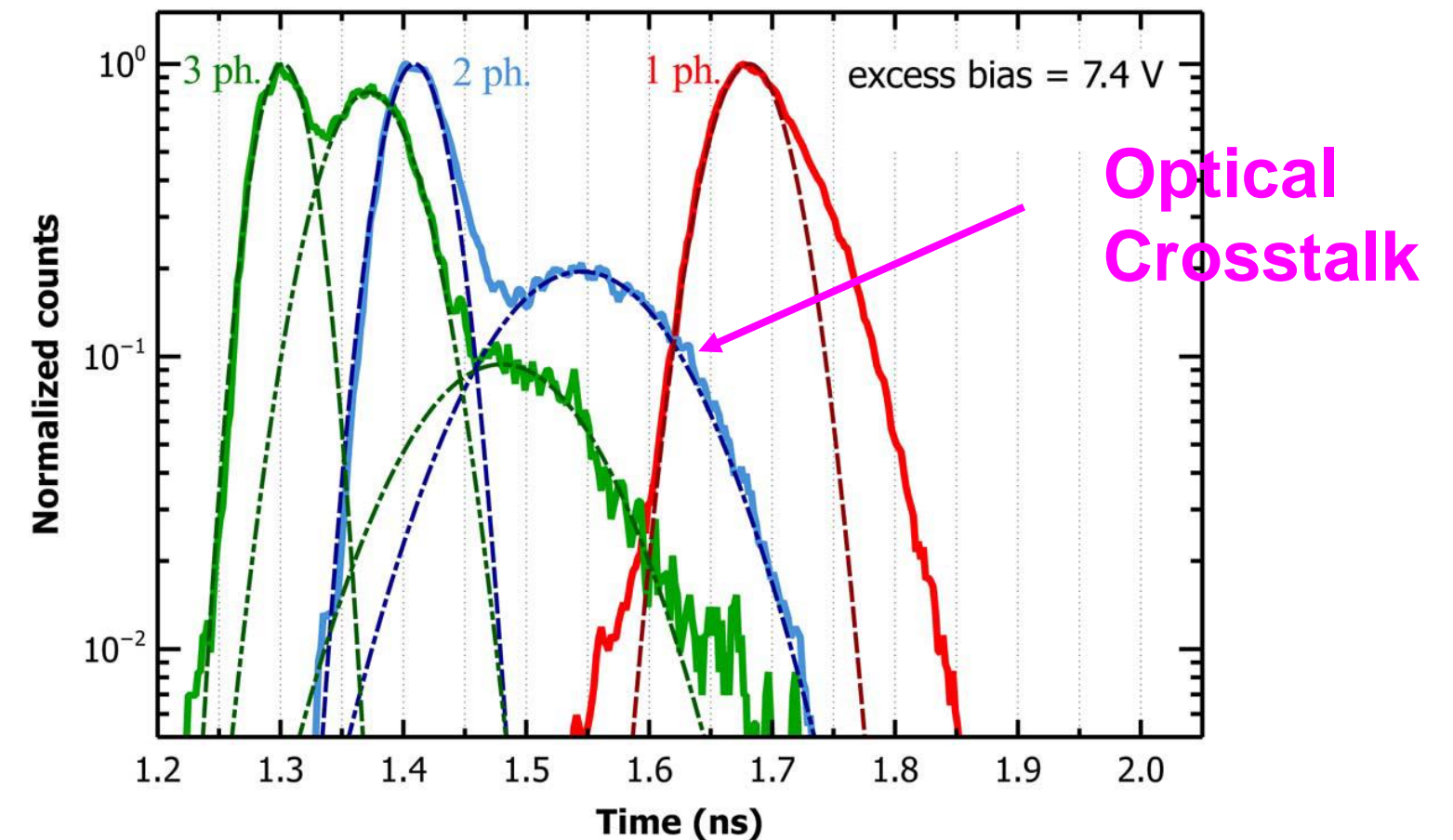
## Worsening of the performance of the detection system

Optical Crosstalk worsens the performance of the detection system both by *limiting the maximum excess bias* that can be applied to the SiPM and by *worsening the photon time of arrival statistics*.

Limiting the maximum excess bias



Worsening of the Few Photons Time Resolution



Few-photon time resolution measured with Leading-edge discriminator  
Additional peaks are most likely generated by (delayed) correlated noise.

Above a certain over-voltage the number of dark counts and, thus, the reverse current diverge.

- Lower PDE, Gain.
- Worse SPTR

$$ECF \cong \frac{1}{1 - P_{CN}}$$

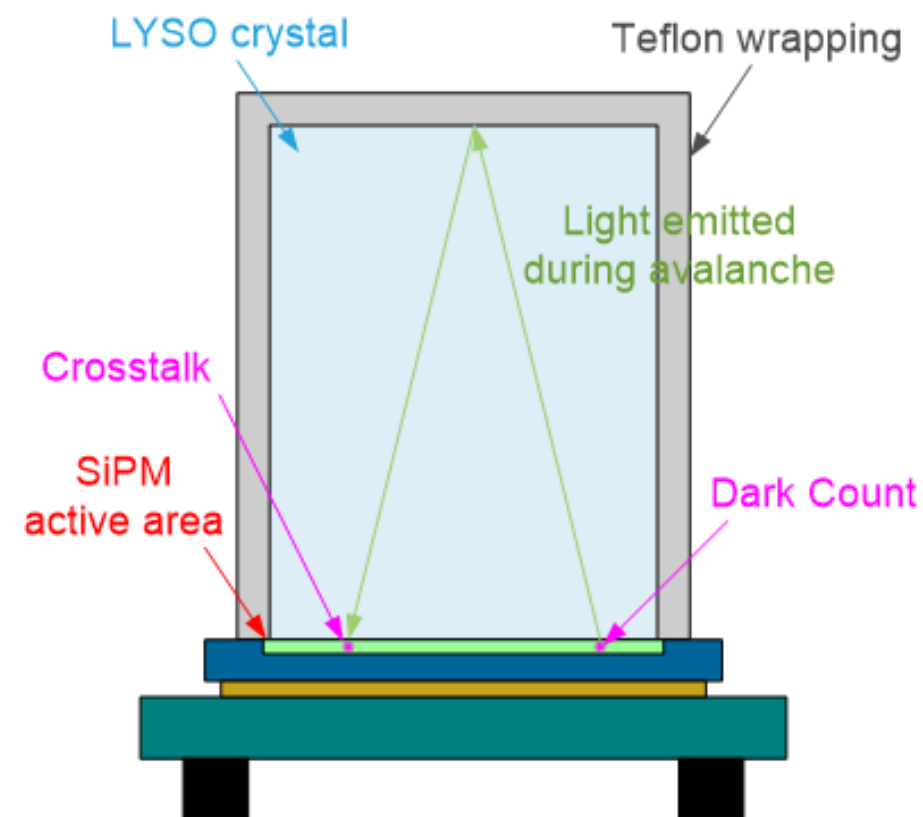
Geometric series approximation of the **Excess Charge Factor**.



# Optical crosstalk

## External Crosstalk

Optical crosstalk probability is enhanced by the presence of the scintillator: external crosstalk.

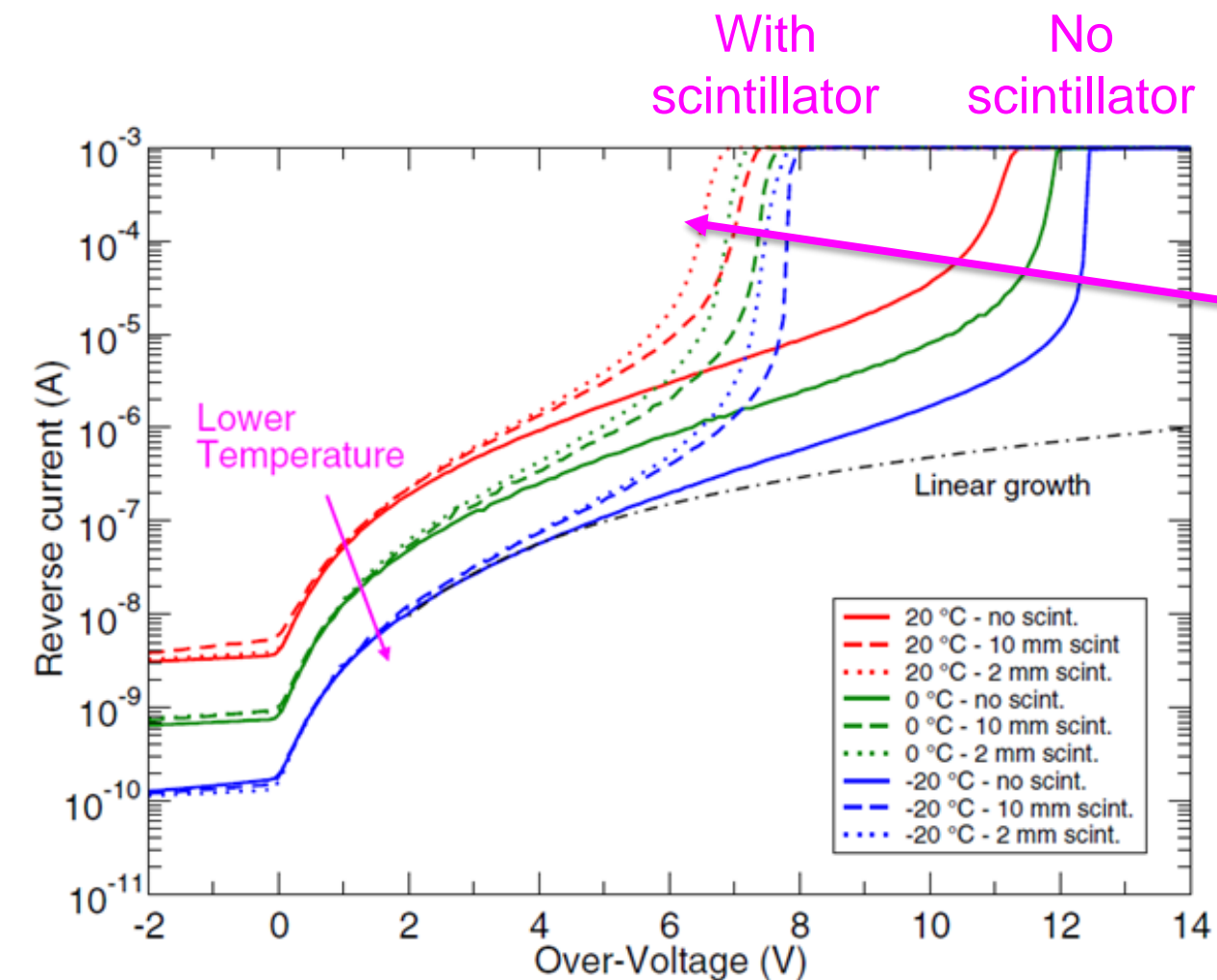


$$ECF \cong \frac{1}{1 - P_{CN}}$$

Geometric series approximation of the **Excess Charge Factor**.

Mechanism of optical crosstalk probability enhancement because of the scintillator.

Gola, Alberto, et al. "SiPM optical crosstalk amplification due to scintillator crystal: effects on timing performance." *Physics in Medicine & Biology* 59.13 (2014): 3615.



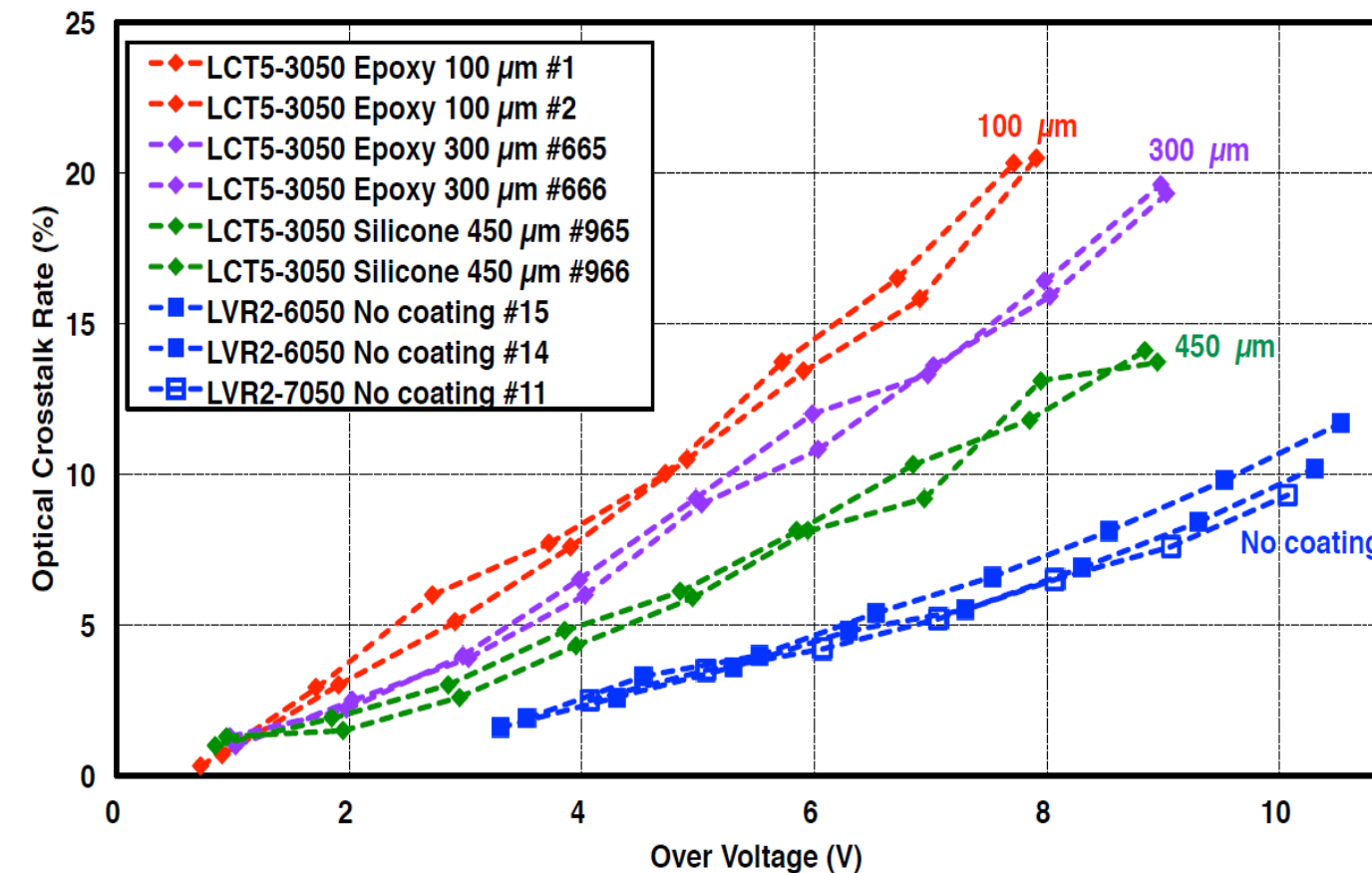
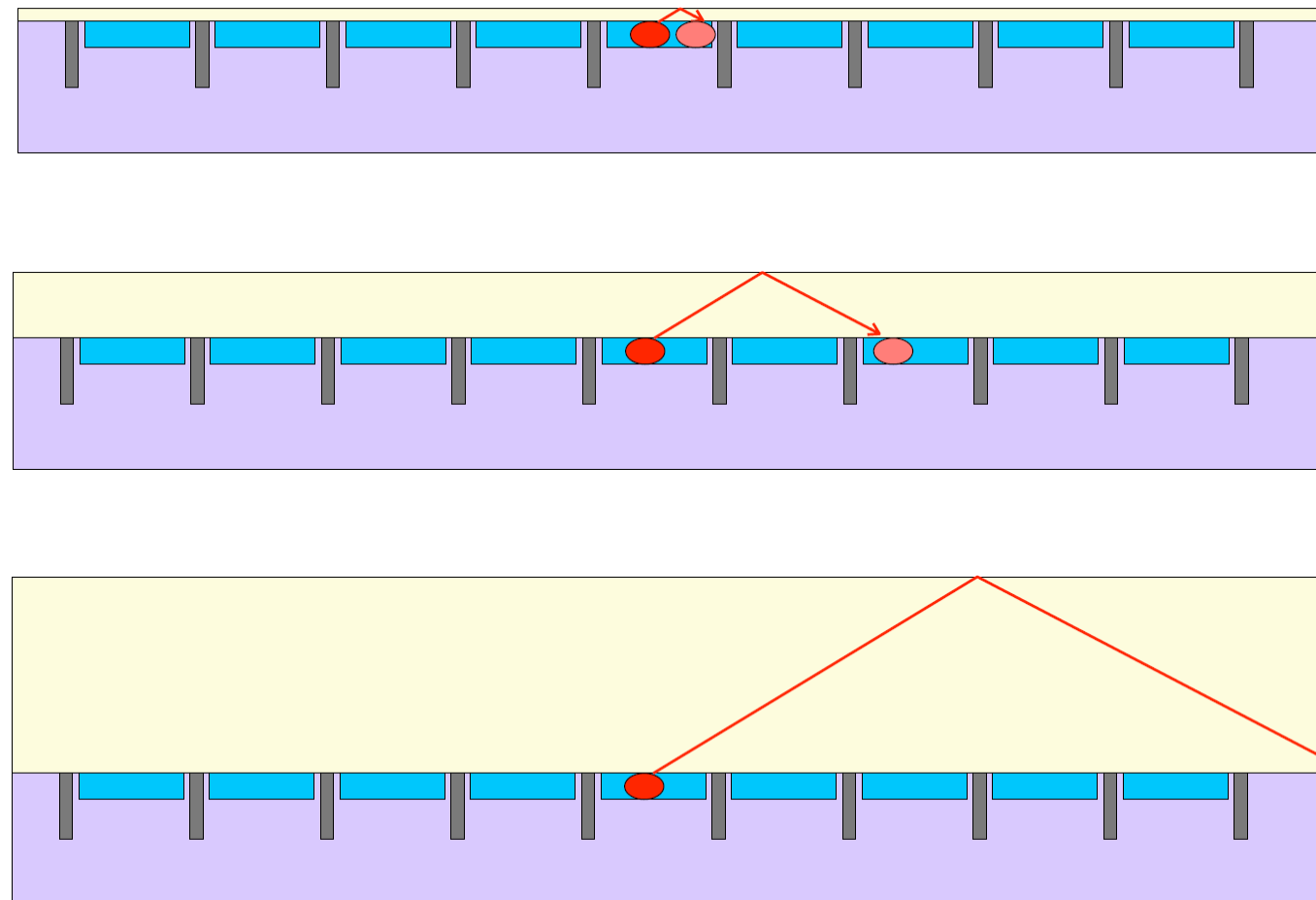
Comparison of SiPM IV with different scintillator sizes placed on top of them, at different temperatures.

# Optical crosstalk

## External Crosstalk and protective resin

The package geometry, in particular the **resin thickness**, has a significant effect on the optical crosstalk probability.

The effect was studied on Hamamatsu SiPMs and discussed in the ICASiPM conference.

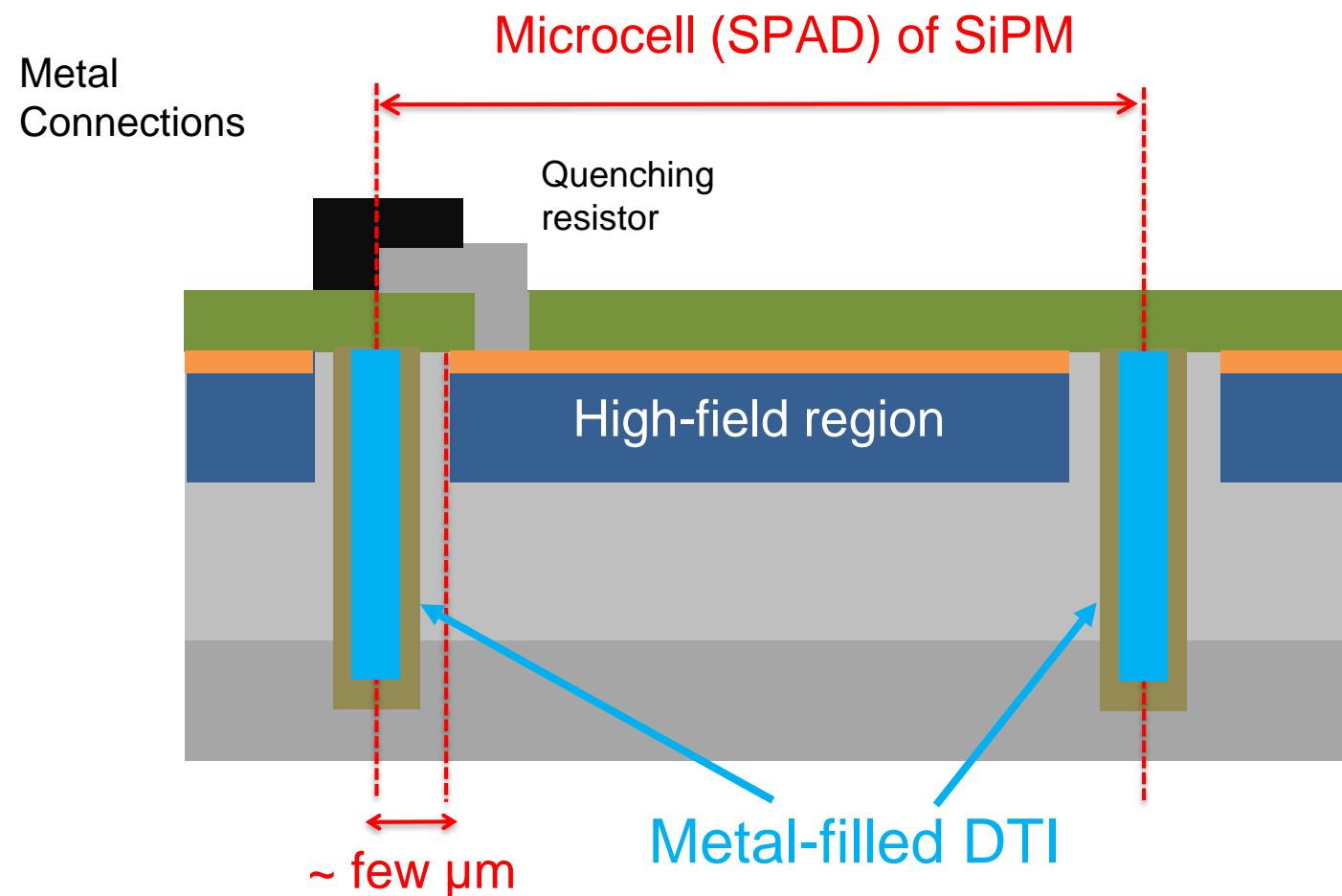


We can identify an **optimal thickness of the encapsulating resin**

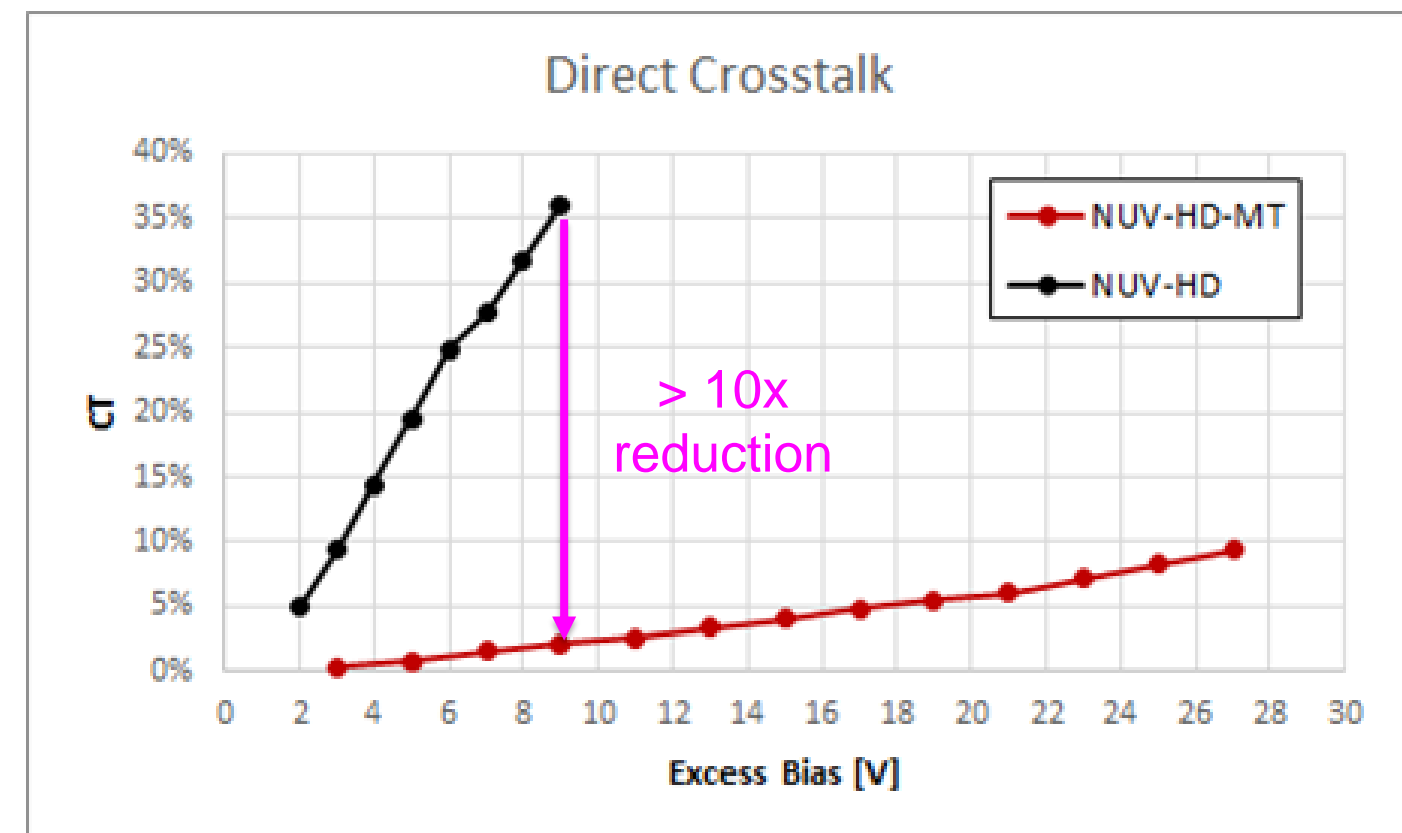
# Reduction of optical crosstalk NUV-HD-MT development

Starting from the NUV-HD technology, FBK and Broadcom jointly developed the NUV-HD-MT technology, adding *metal-filled DTI isolation to strongly suppress optical crosstalk*.

Other changes: low electric field variant, layout optimized for timing.



Conceptual drawing of the NUV-HD-MT, with the addition of metal-filled Deep Trench Isolation.

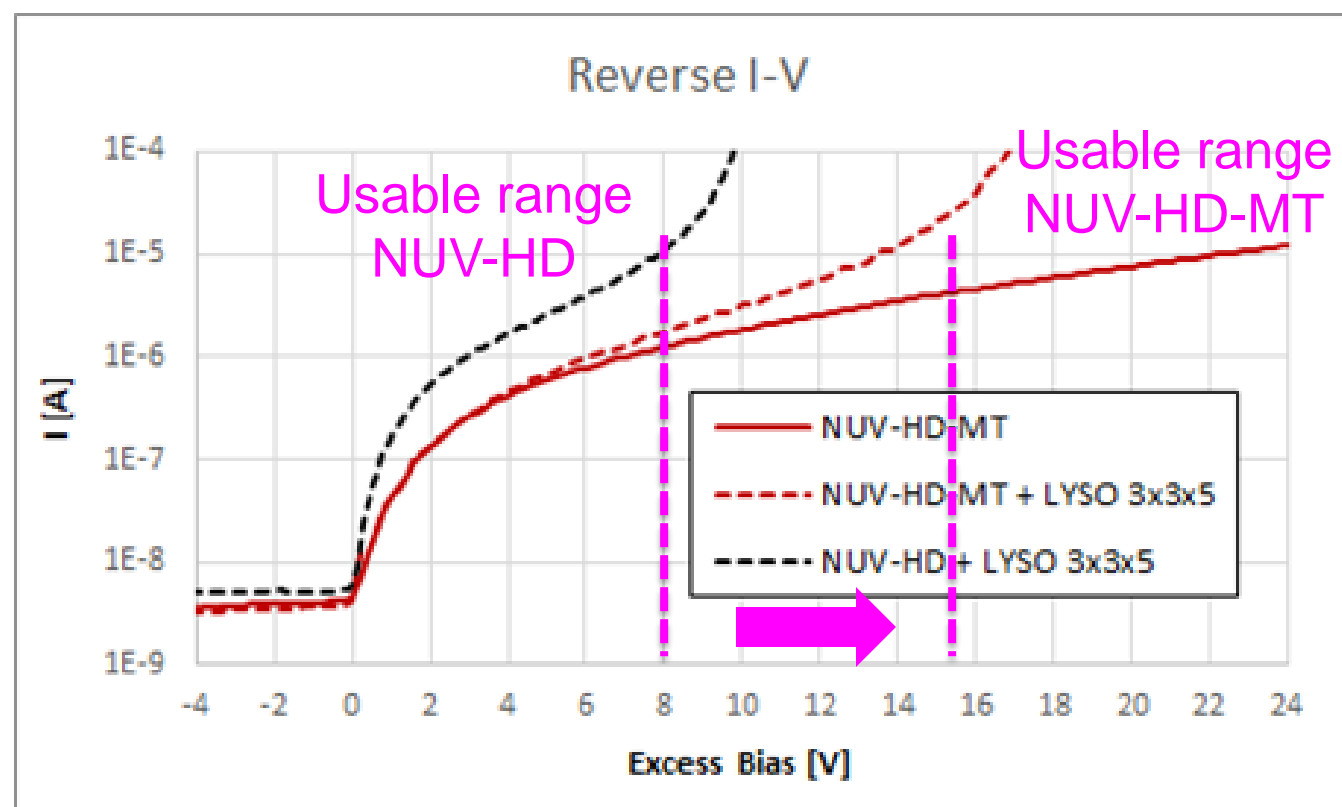


Reduction of optical crosstalk probability in NUV-HD-MT, compared to the “standard” NUV-HD. Measurement without encapsulation resin, i.e. *only considering internal crosstalk probability*.

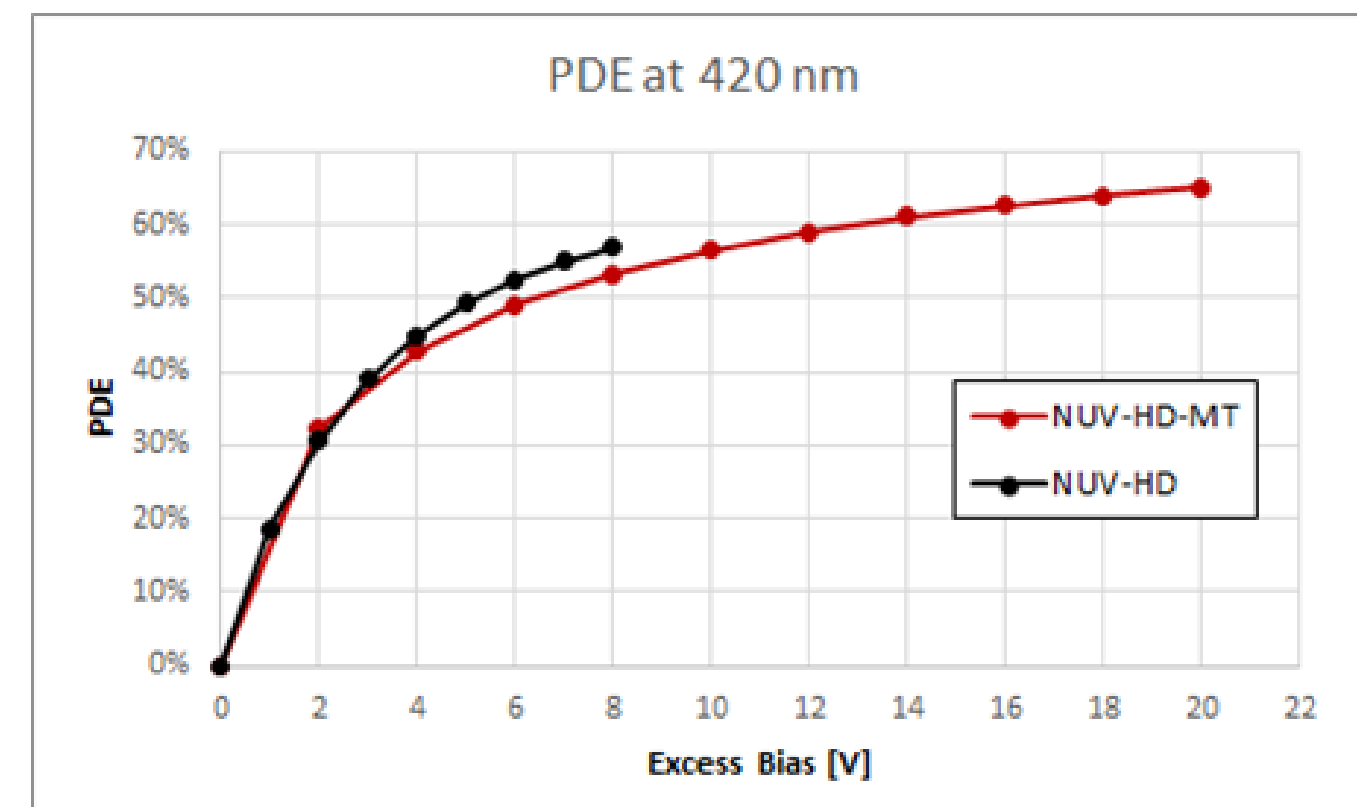
# Reduction of optical crosstalk NUV-HD-MT bias range

Reduction of optical crosstalk probability *increases maximum usable excess bias of SiPM*, also with the scintillator on top of the SiPM.

Increase of excess bias *more than compensates the slight reduction of Fill Factor* caused by the addition of metal inside the DTI.



Reverse IV measured on a 4x4 mm<sup>2</sup> NUV-HD-MT SiPM with 45  $\mu$ m cell pitch under different conditions.

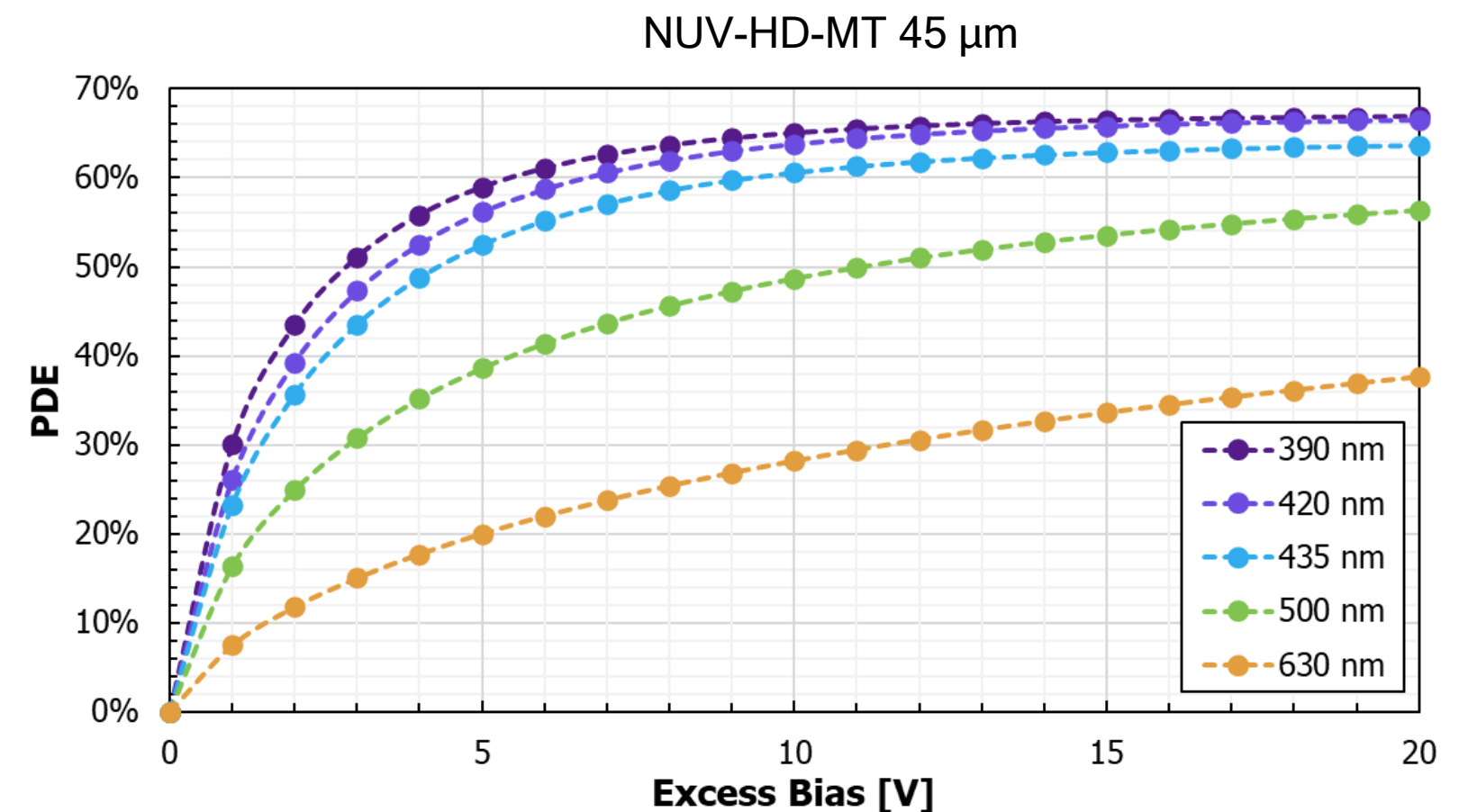
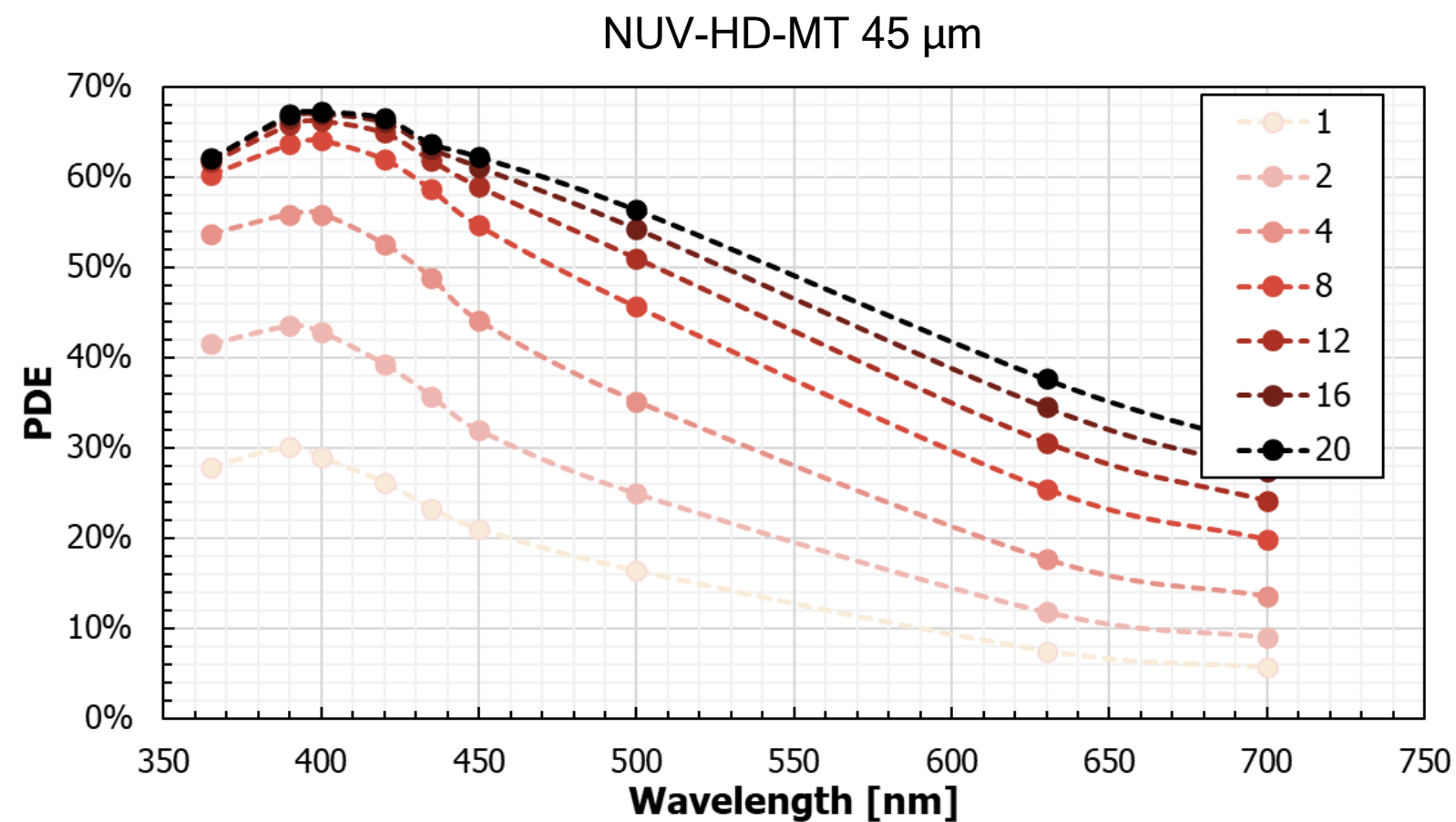


PDE at 420 nm measured on a NUV-HD-MT SiPM with 45  $\mu$ m cell size.

# Reduction of optical crosstalk NUV-HD-MT PDE

NUV-HD-MT is *based on a p-on-n junction*, thus peak PDE is around 390 – 420 nm.

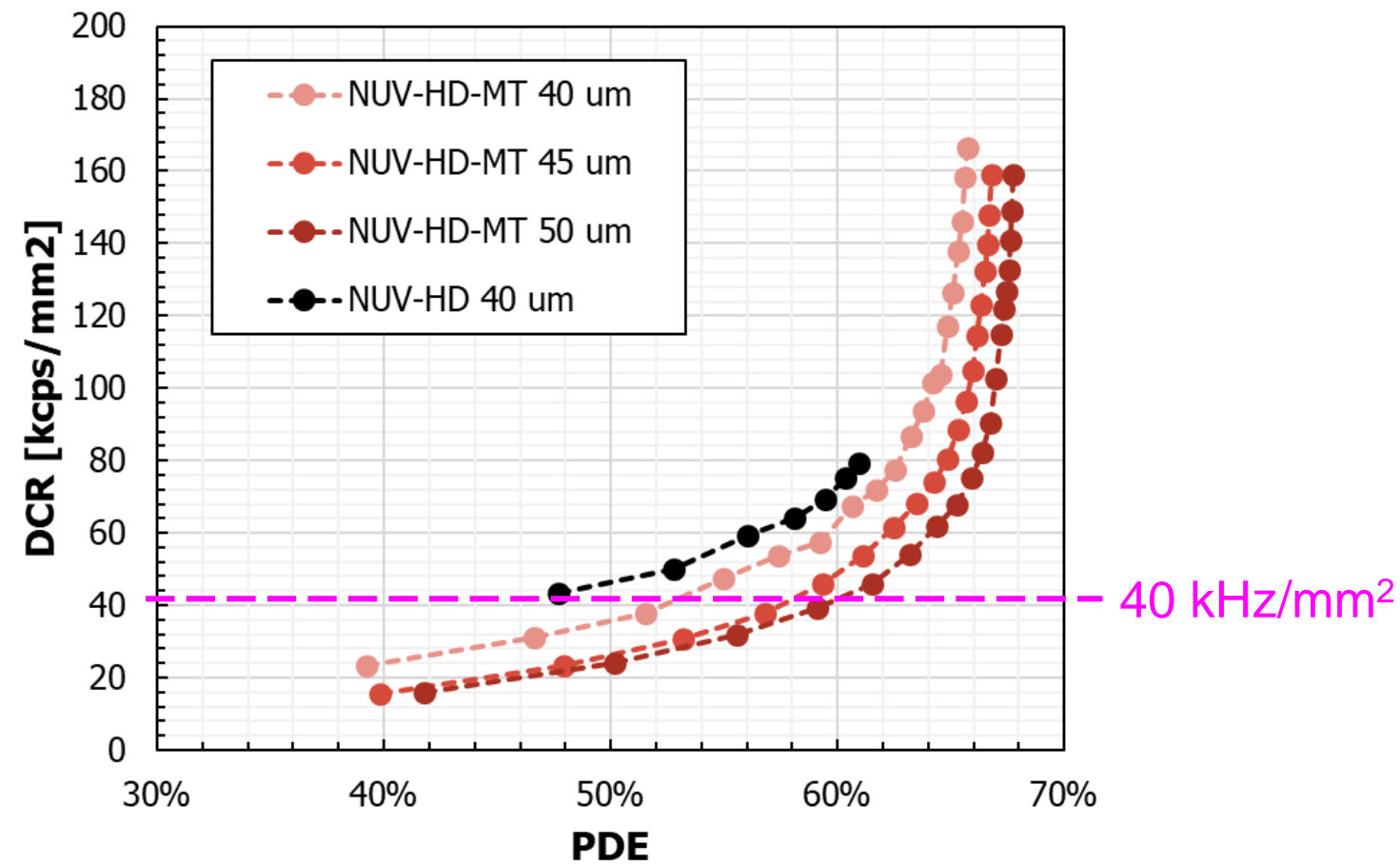
Thanks to the very high maximum excess bias, *also PDE in the red (avalanche triggering by holes) approaches saturation*.



# Reduction of optical crosstalk NUV-HD-MT electro optical performance

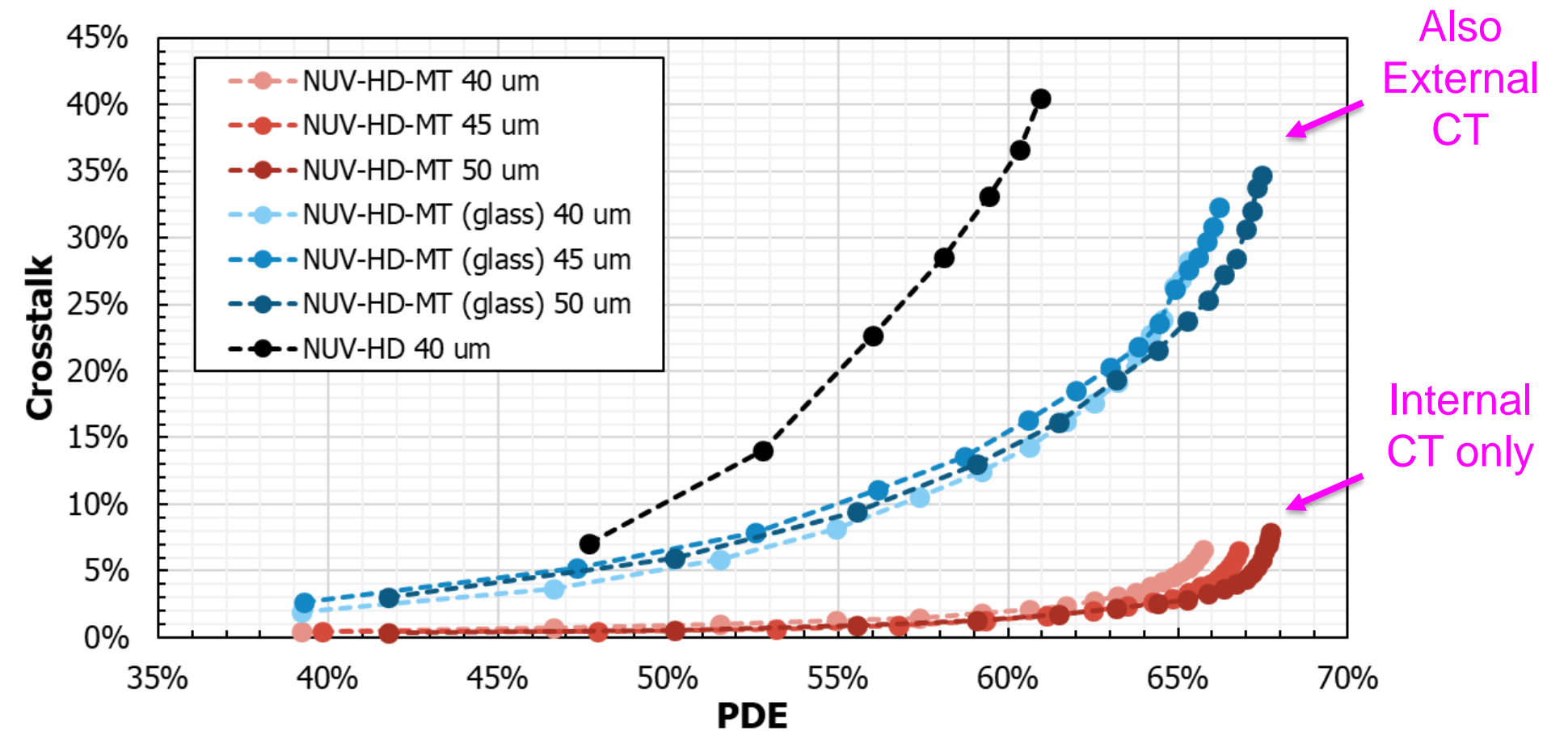
NUV-HD-MT *nuisance parameters are better represented and compared as a function of the PDE.*

DCR vs. PDE



DCR vs. peak PDE (measured at 420 nm) for different cell sizes of the NUV-HD-MT technology.

Direct Optical CT vs. PDE



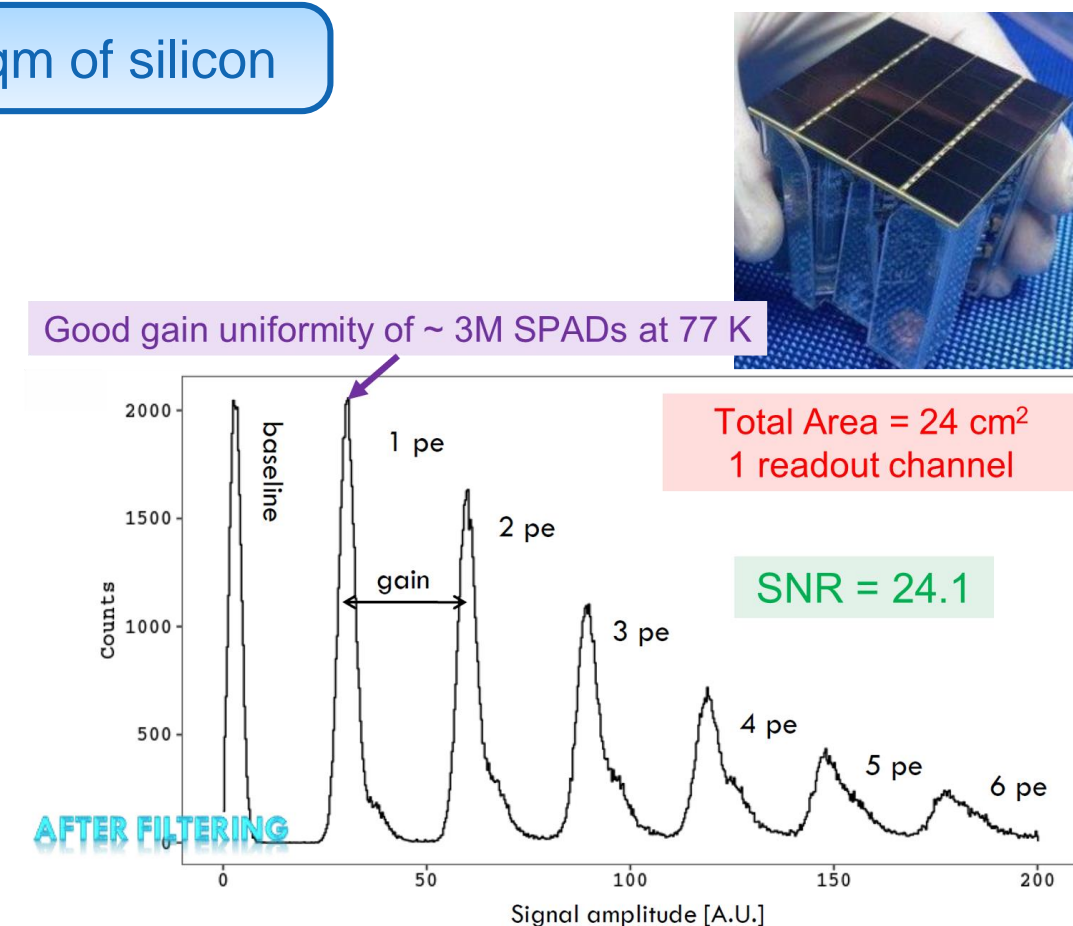
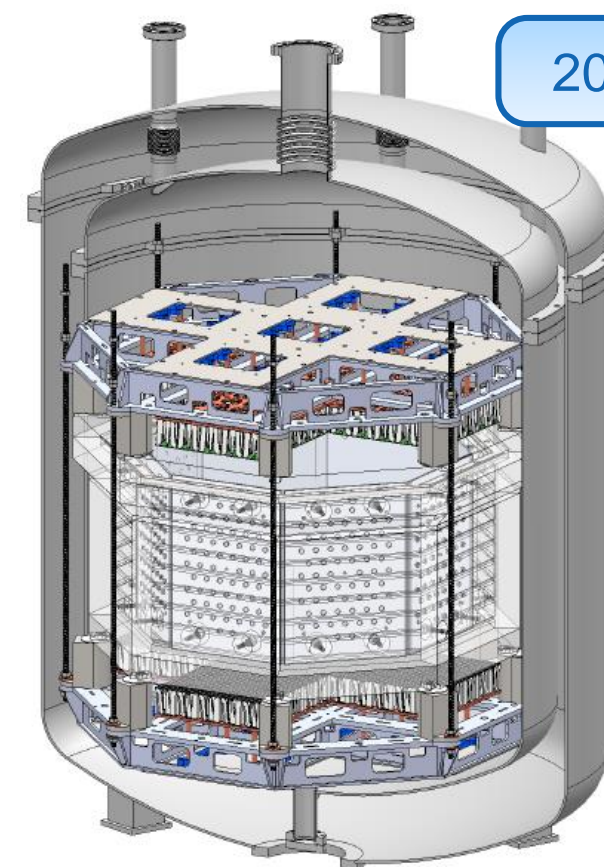
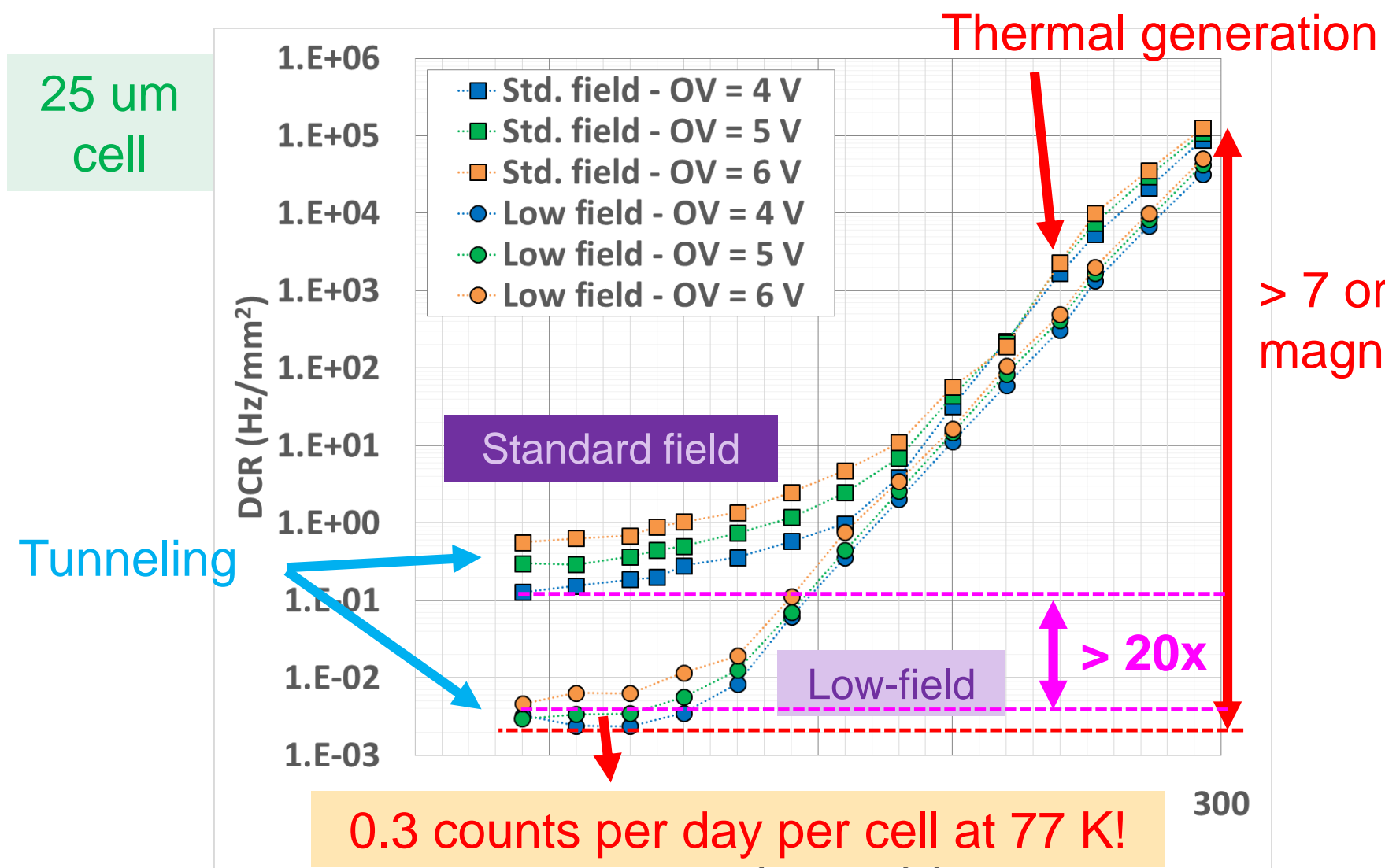
DiCT vs. peak PDE (measured at 420 nm) for different cell sizes of the NUV-HD-MT technology, with and without protective glass on top of the SiPM (used for TSV)



# Cryogenic operation DarkSide-20k SiPMs



NUV-HD-Cryo SiPM technology is an *enabling technology for the DarkSide-20k* experiment, currently under construction.



Darkside-20k experiment under construction at LNGS using FBK SiPMs fabricated at Lfoundry: **20 m<sup>2</sup> of SiPMs** operated at 87 K.

Photon counting at 77 K with a single, 24 cm<sup>2</sup> SiPM Tile.

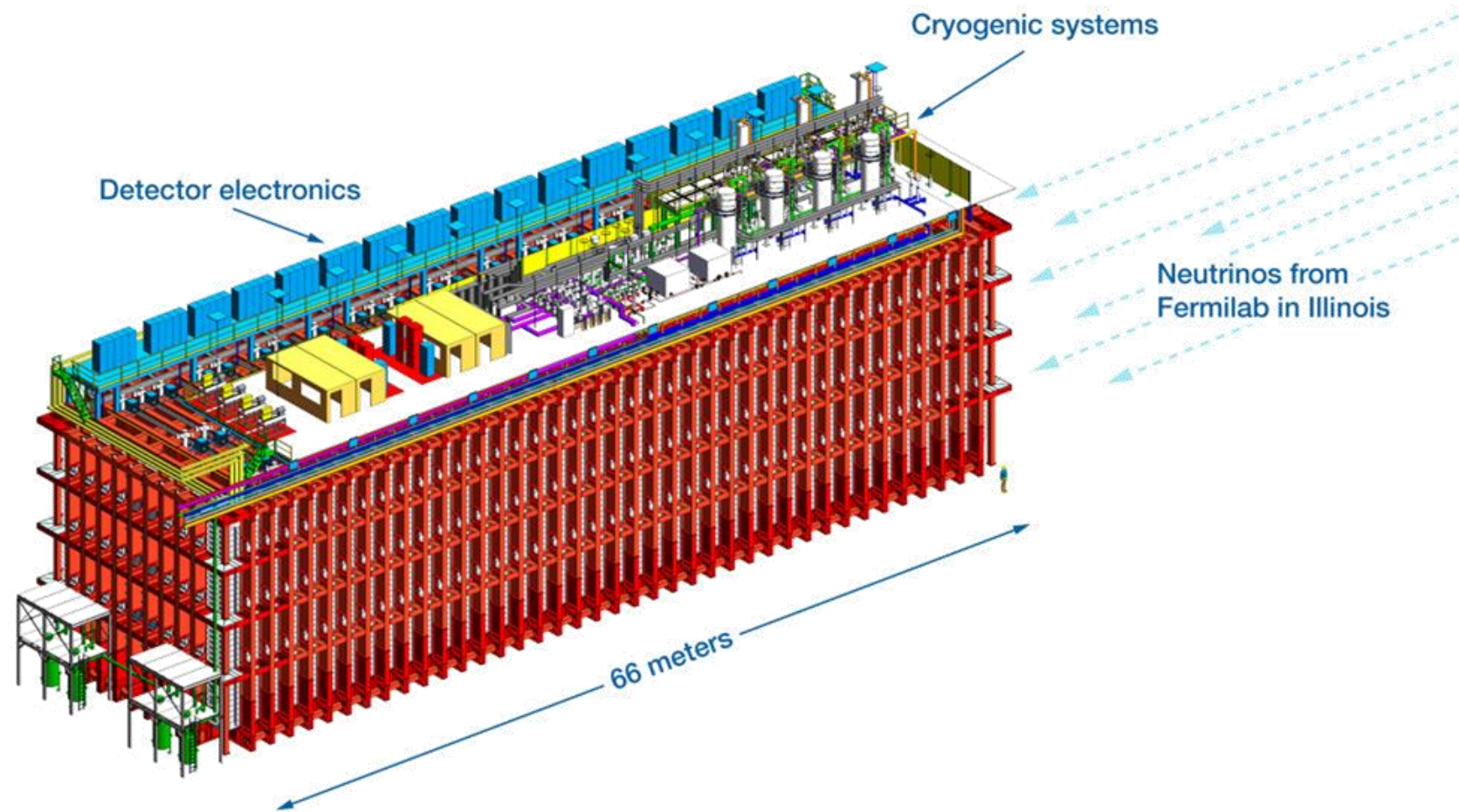
**A 10x10 cm<sup>2</sup> SiPM array would have a total DCR < 100 cps!**

Reduction of Dark Count Rate at cryogenic temperature thanks to electric field engineering in FBK SiPMs.

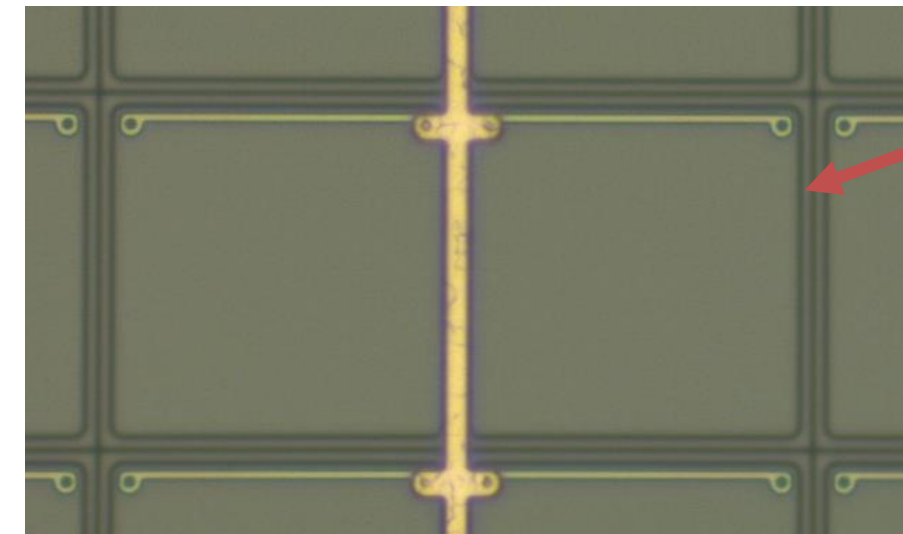


# Cryogenic operation DUNE SiPMs

NUV-HD-Cryo SiPM technology is at the basis of the *ongoing R&D collaboration between FBK and UniMiB* for the production of >250k channels for the DUNE experiment.



One of the four far-detector modules for the Deep Underground Neutrino Experiment.



SiPM microcell optimized for DUNE



Prototype 6-channel array based on NUV-HD-Cryo fabricated at Lfoundry and packaging developed by FBK.

# Radiation Hardness Motivation for R&D

Improving radiation hardness of SiPMs is *one of the next frontiers of development at FBK* for very important applications, both in big science experiments and in space.

**Detectors for collider experiments:** from  $10^{10}$  neq/cm<sup>2</sup> to  $>10^{14}$  neq/cm<sup>2</sup>



**Geostationary orbit space experiments:**  $\sim 5 \cdot 10^{10}$  neq/cm<sup>2</sup>



What is the definition of radiation hardness for SiPMs?

R&D approach:

- *Qualification* of radiation tolerance of current SiPM technologies.
- *Study / modeling* of the effects of radiation damage on SiPM characteristics, under different sources of radiation.
- Development of a *highly customized SiPM technology* for optimal performance after irradiation is likely needed.

# Test Beam 1 – Trento Proton Therapy Experimental Setup and DoE

*Relatively low maximum irradiation dose*, targeting space applications and certain HEP experiments.

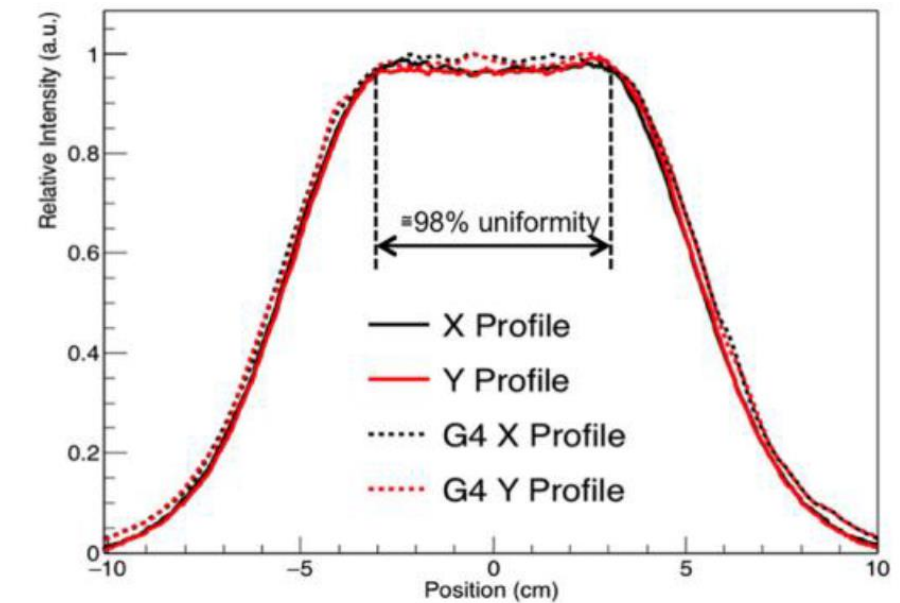
**Energy:** 148 MeV source + inhibitor → **74 MeV proton energy**

**Dose:** 12 dose steps:

$$\begin{aligned} &\sim 5 \cdot 10^6 - 4 \cdot 10^{11} \text{ p/cm}^2 \\ &\quad \downarrow \text{ (NIEL scaling hypothesis) } \\ &\sim 7 \cdot 10^6 - 6 \cdot 10^{11} \text{ 1 MeV } n_{eq}/\text{cm}^2 \end{aligned}$$

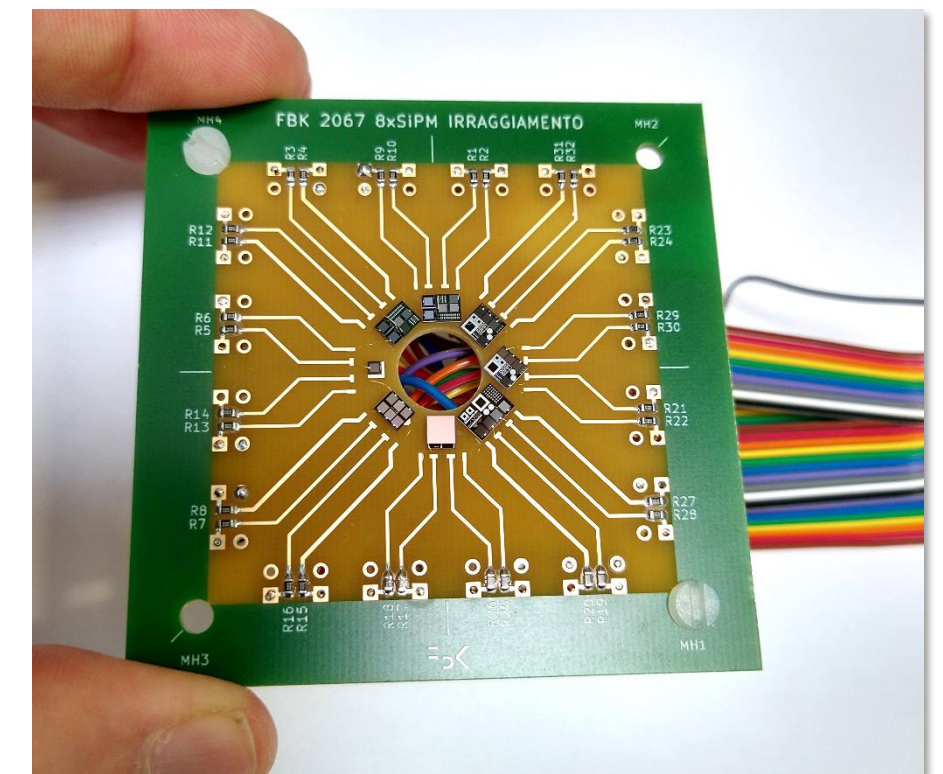
**Analysis:**

- *Online IV measurement* between each irradiation step;  
+
- *Functional measurements* after 1 month RT annealing:  
→ Waveform analysis on irradiated samples **only at -40°C** (High DCR, event separation is not possible / reliable above 20 Mc.p.s.)



Tommasino (2019) <https://doi.org/10.1016/j.ejmp.2019.02.001>

“Dual ring setup”<sup>[1]</sup>: 98% uniformity on ~6 cm diameter



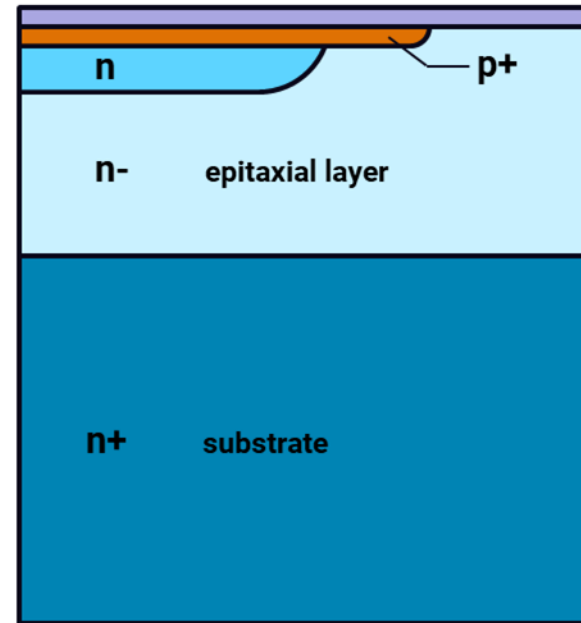
Customized PCB for irradiation tests, housing multiple SiPMs and allowing online IV measurements.

# Test Beam 1 – Trento Proton Therapy

## Tested Technologies

We tested a relatively *wide range of different customized SiPM technologies*, fabricated in FBK internal R&D clean-room, looking for differences, general trends, etc..

**VUV-HD<sup>[2]</sup>**  
Vacuum Ultraviolet



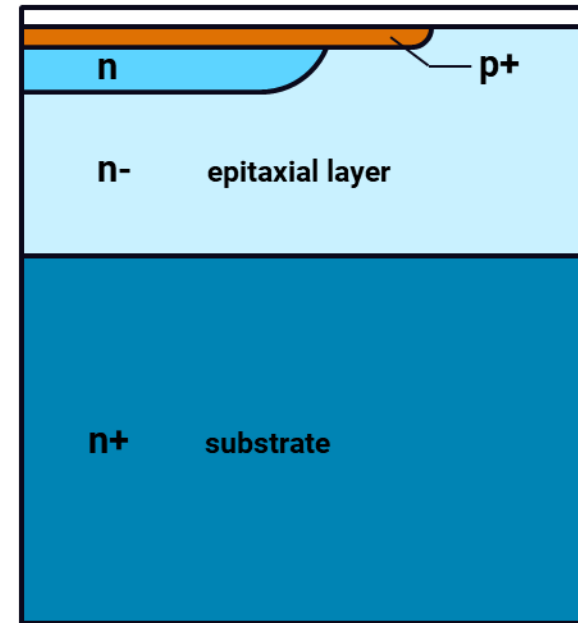
Peak PDE = 420 nm

- Different ARC
- High sensitivity in VUV

[2] Capasso (2020)

<https://doi.org/10.1016/j.nima.2020.164478>

**NUV-HD<sup>[3]</sup>**  
Near Ultraviolet



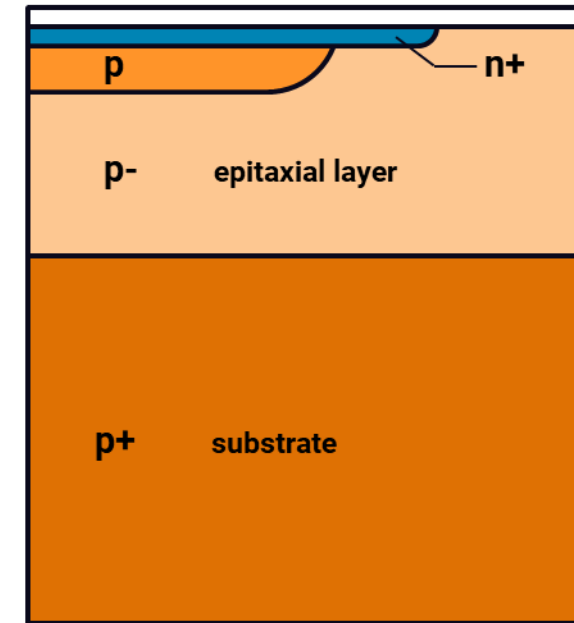
Peak PDE = 420 nm

- CRYO = Cryo temp opt.
- RH = High radiation opt.

[3] Gola (2019)

<https://doi.org/10.3390/s19020308>

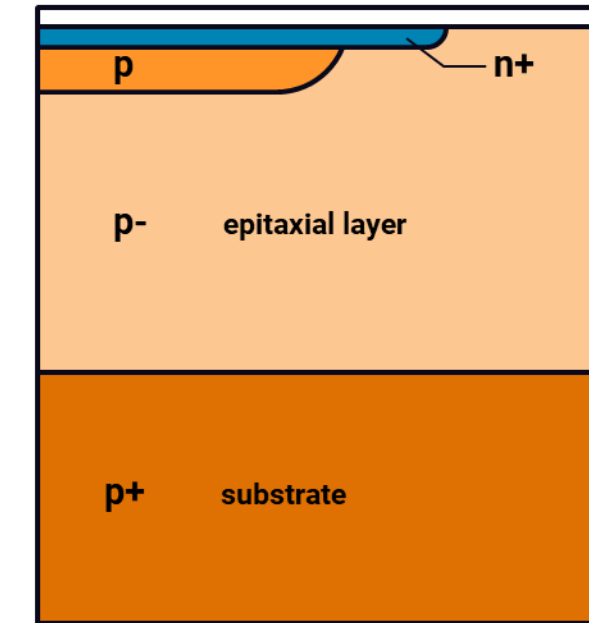
**RGB-HD<sup>[4]</sup>**  
Visible



Peak PDE = 530 nm

[4] Ferri (2015)  
<https://doi.org/10.1186/2197-7364-2-S1-A86>

**NIR-HD<sup>[5]</sup>**  
Near Infrared



Peak PDE = 530 nm

- Thick epitaxial layer
- High sensitivity in IR

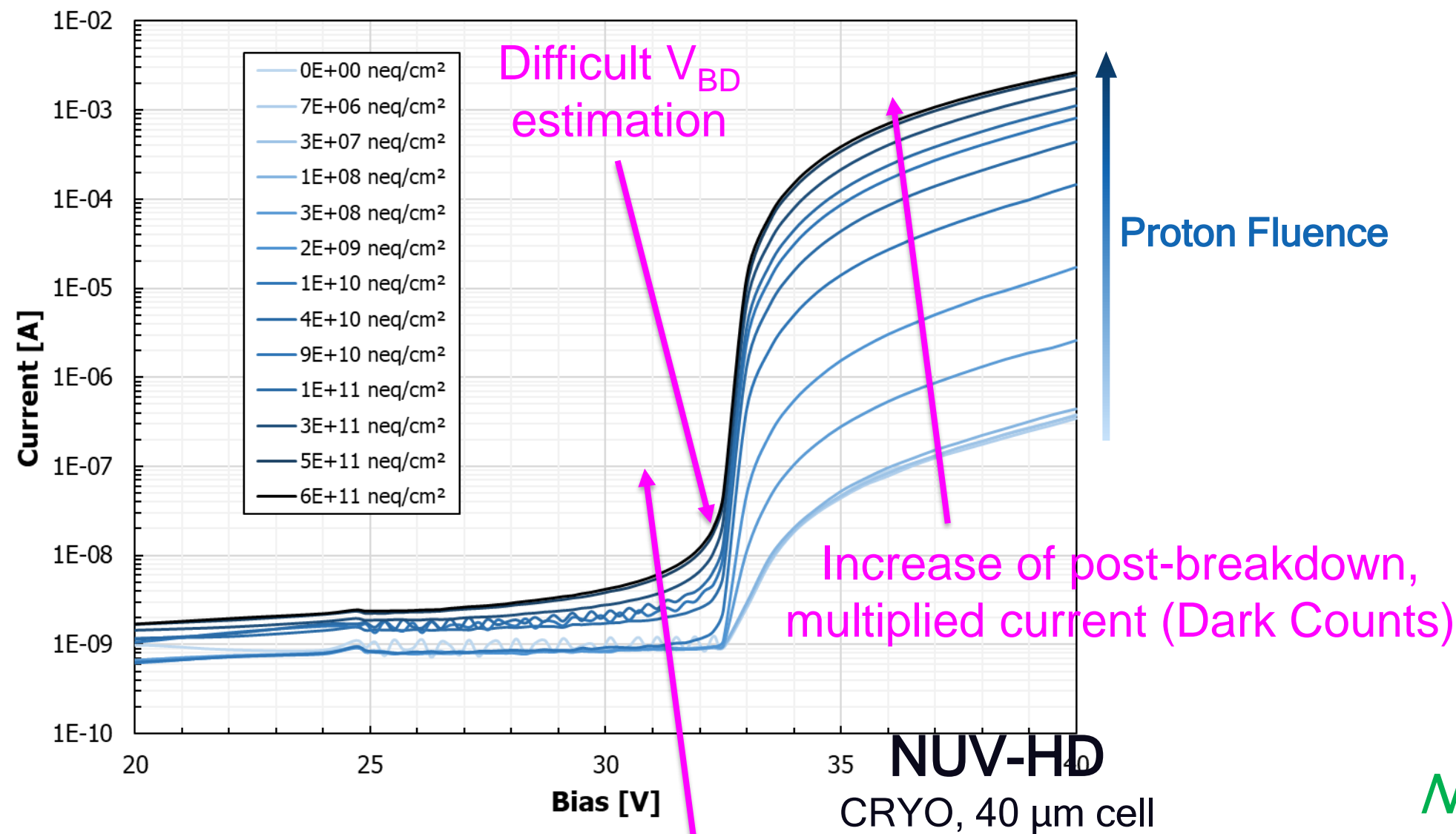
[5] Acerbi (2018)

<https://doi.org/10.1016/j.nima.2017.11.098>

# Test Beam 1 – Trento Proton Therapy

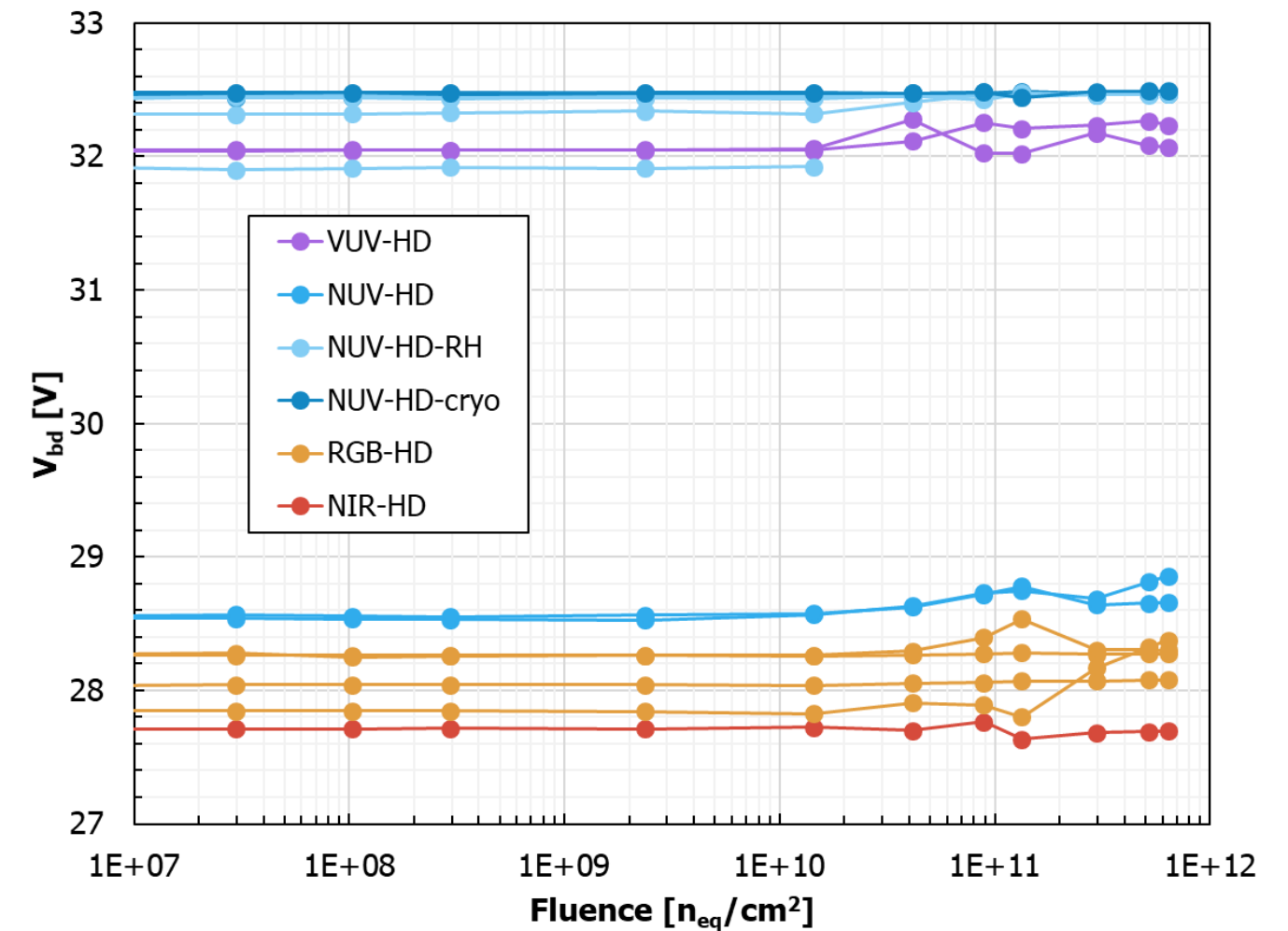
## Online IV measurements

### Effects of irradiation on reverse IVs



Increase of pre-breakdown, non-multiplied (~surface) current

### Breakdown Voltage Estimation

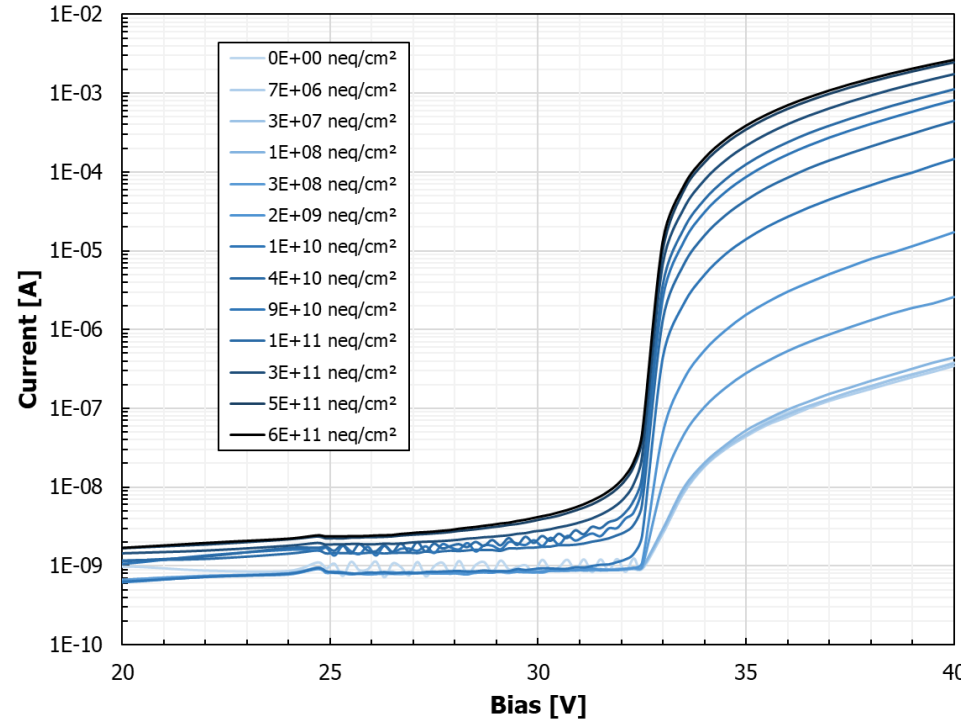


*No change* observed in  $V_{BD}$  up to fluence  $6 \cdot 10^{11}$   $n_{eq}/\text{cm}^2$  (2<sup>nd</sup> derivative method, faint illumination)

# Test Beam 1 – Trento Proton Therapy

## Dark Count Rate Estimation from reverse IV

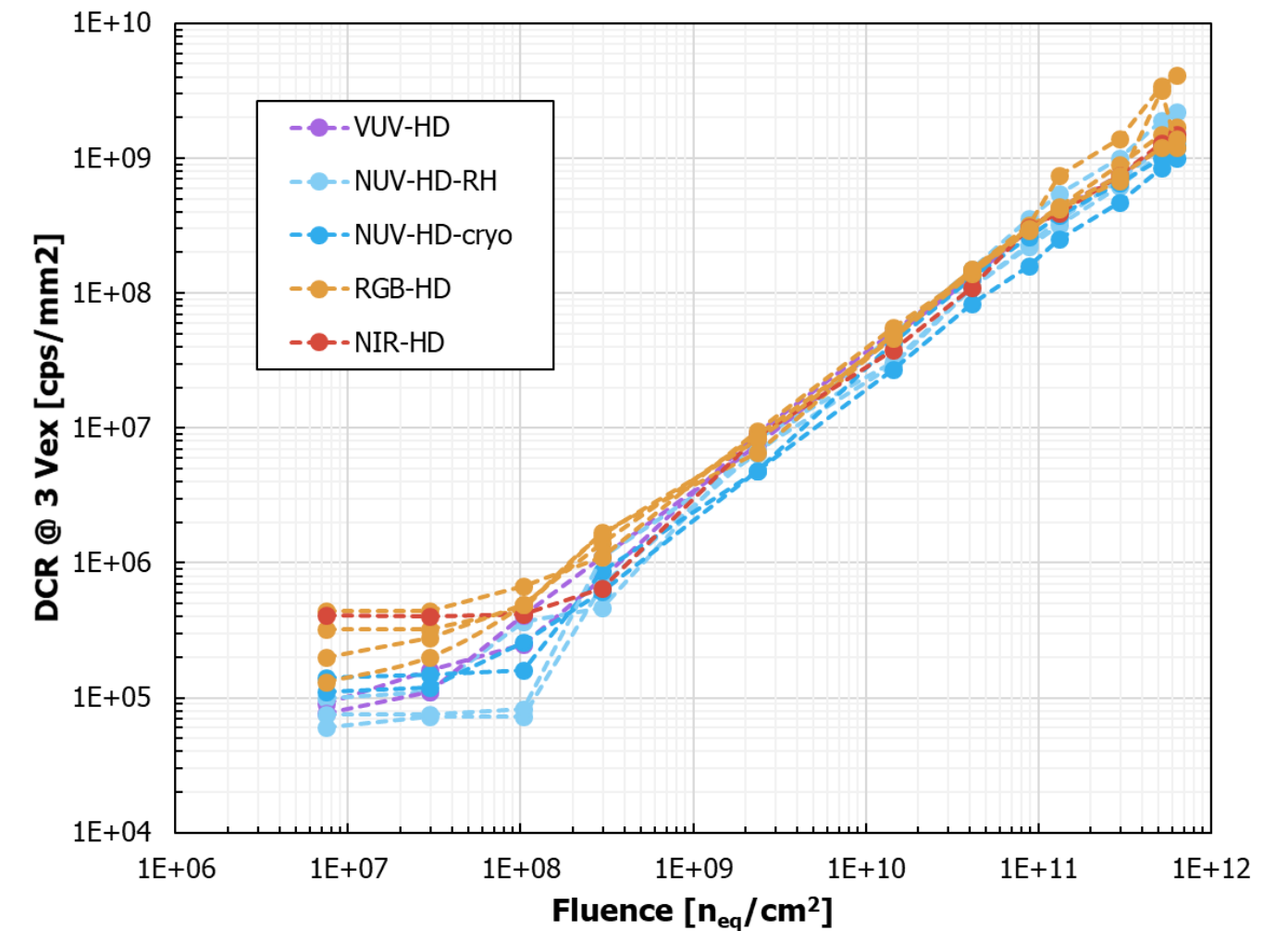
*Comparison* of radiation hardness of different SiPM technologies *cannot be done directly from their IVs* because they usually have different Gain and correlated noise (ECF).



$$\text{DCR} = \frac{I_{\text{dark}}}{q * G * \text{ECF}} = \frac{I_{\text{dark}}}{q * G_C}$$



$G_C = G * \text{ECF} = \text{Current Gain}$   
 $\text{ECF} = \text{Excess Charge Factor}$



**Assumption:** ECF and Gain do not change with irradiation (will be shown later)

DCR estimation for different FBK SiPM technologies.

# Test Beam 1 – Trento Proton Thera

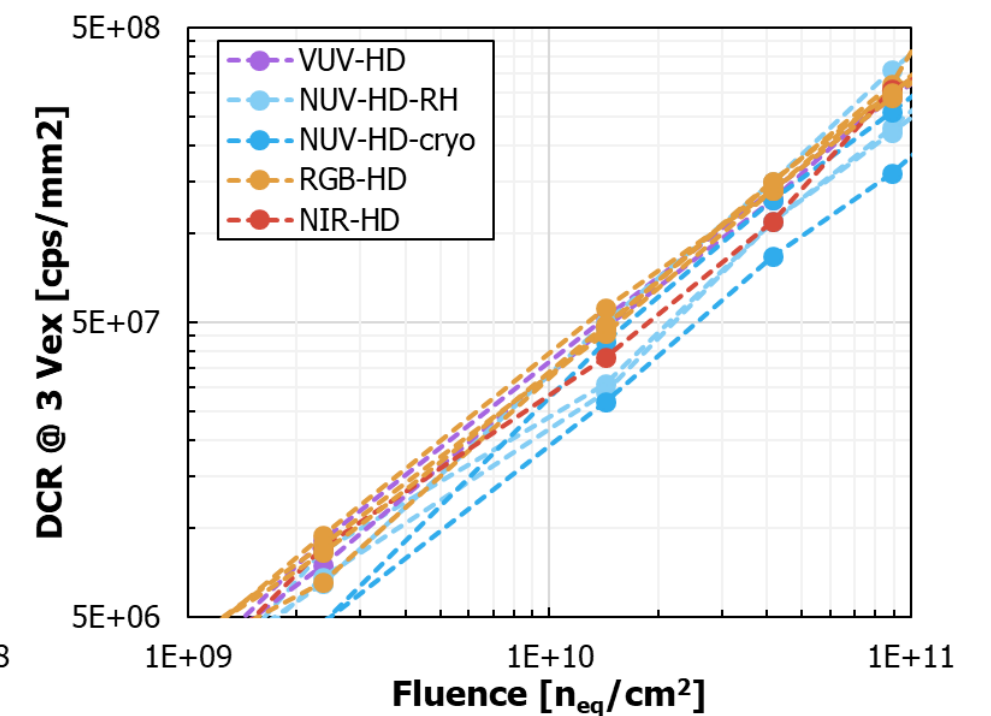
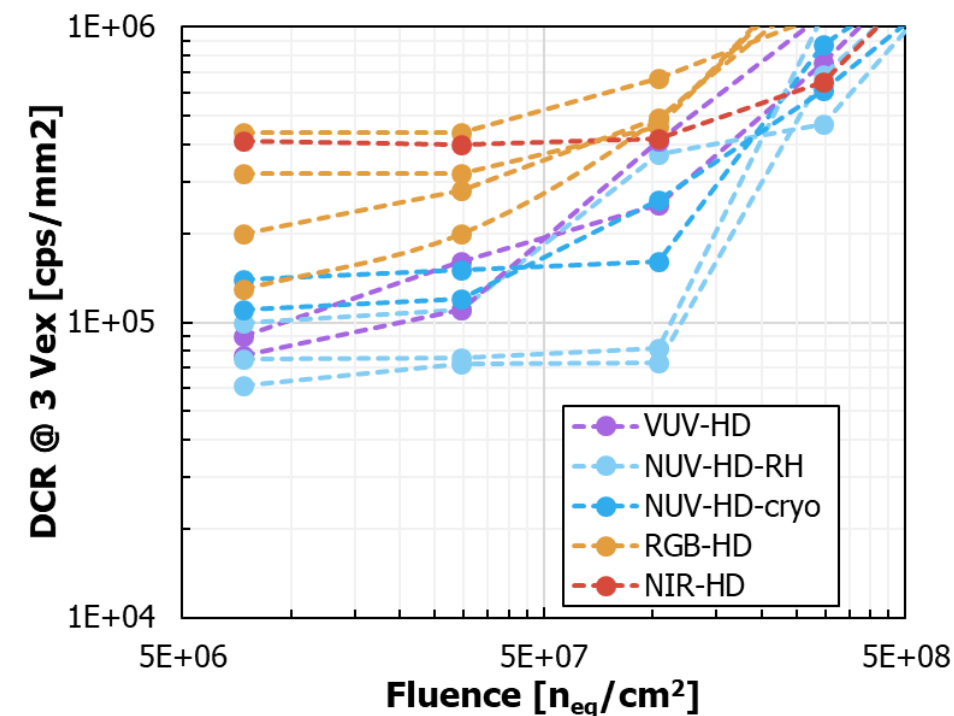
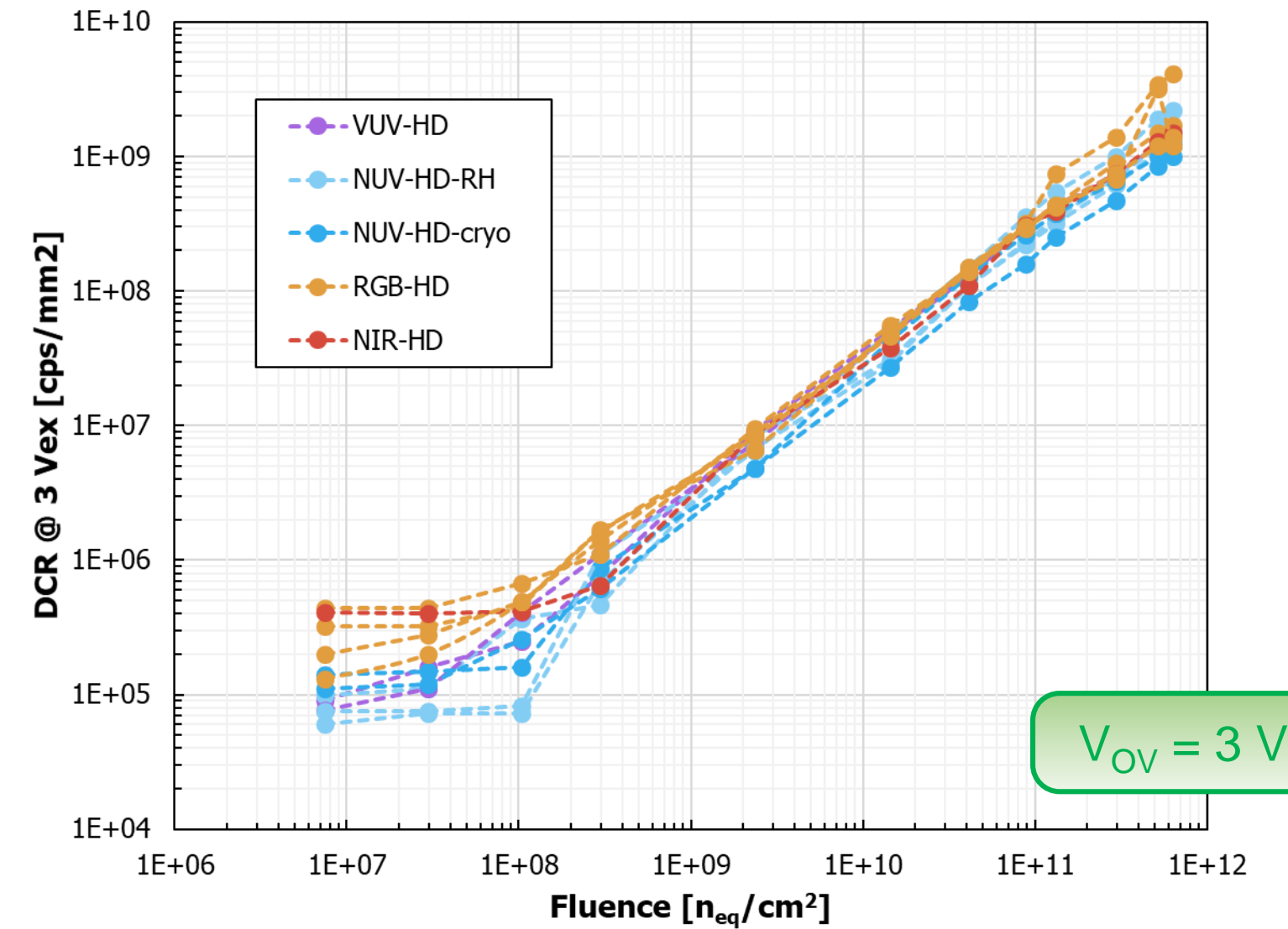
## Dark Count Rate vs. Fluence

There is *little correlation between the DCR before and after irradiation*:

- All technologies seem to “converge” towards similar values
- Knee between  $10^7 \div 10^8$   $n_{eq}/cm^2$
- Independence of bulk damage from contaminants in the SiPM starting material?

*DCR variation after irradiation is reduced:*

- from  $\sim 1$  OoM to  $< \sim 0.5$  OoM
- Still worth investigating *differences between technologies*





# Test Beam 1 – Trento Proton Therapy

## Damage Factor

To estimate the sensitivity of different SiPM technologies to the radiation damage, we suggest *using a version of the Damage Factor, modified for the Geiger-mode detectors.*

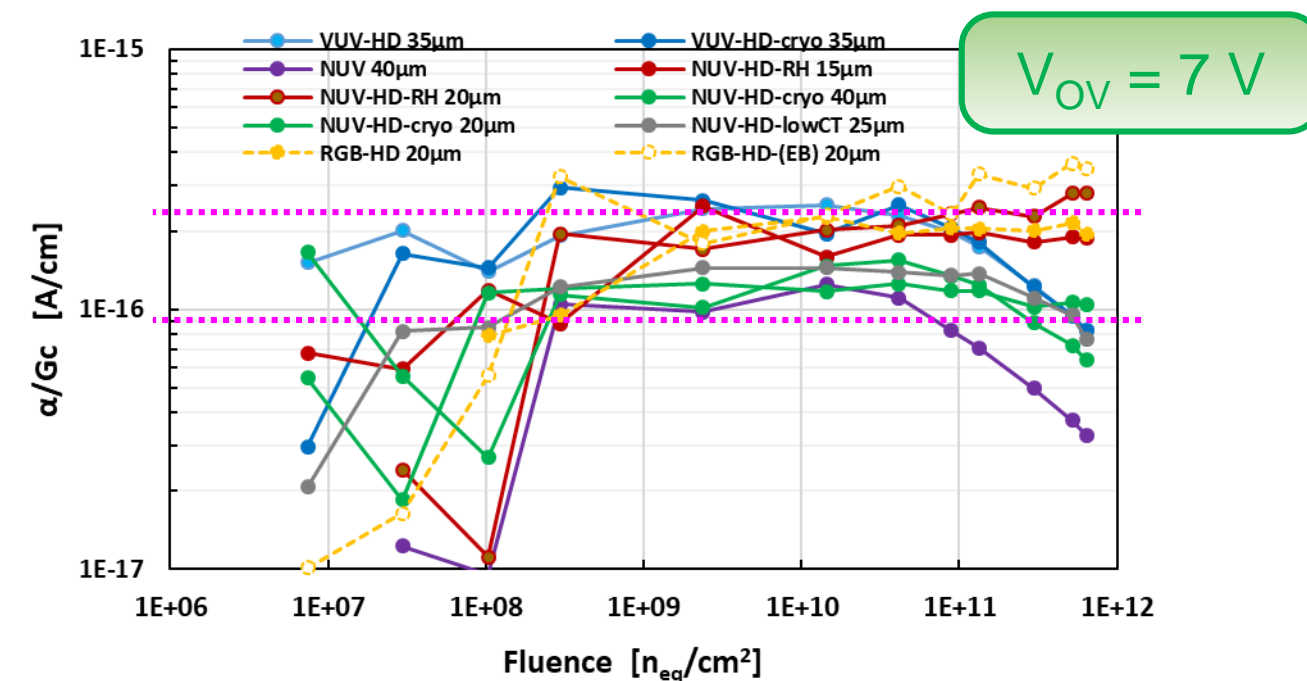
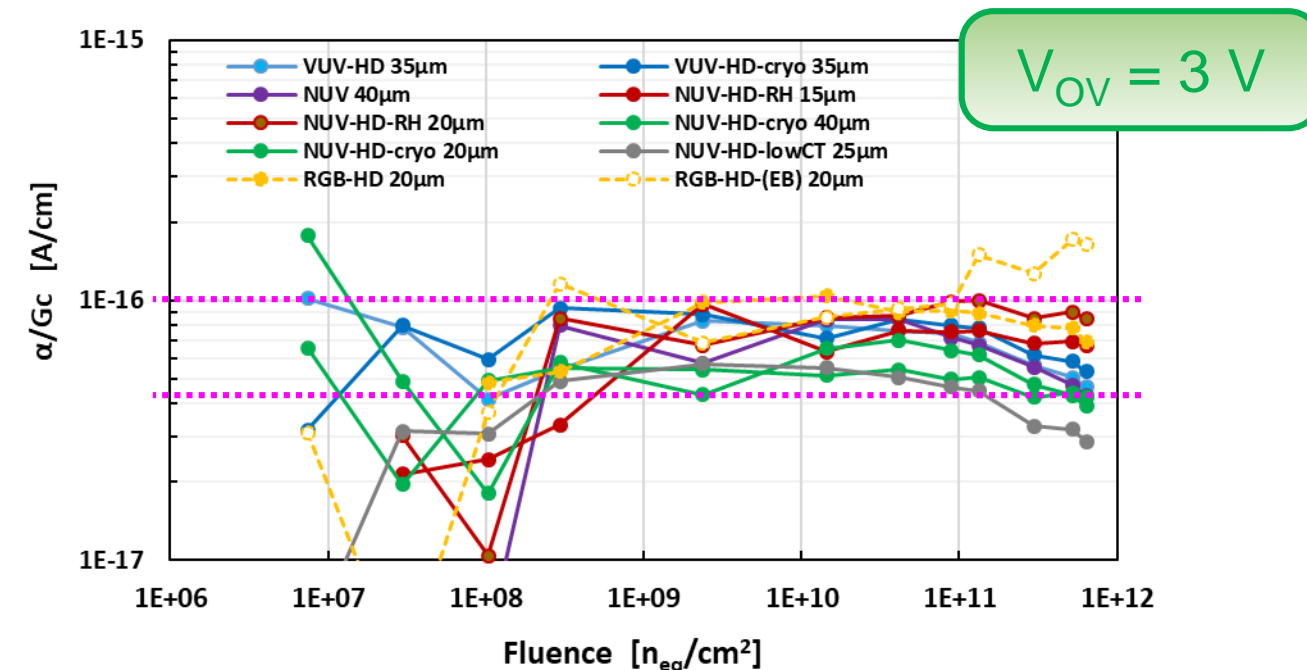
Damage Factor  
detectors without internal gain

$$\alpha = \frac{\Delta I}{\Phi V}$$



Damage Factor  
Geiger-mode detectors

$$\frac{\alpha}{G_C} = \frac{\Delta I}{\Phi \cdot V \cdot G \cdot ECF} = \frac{\Delta I}{\Phi \cdot V \cdot G_C} \approx \frac{\Delta DCR * q}{\Phi V}$$



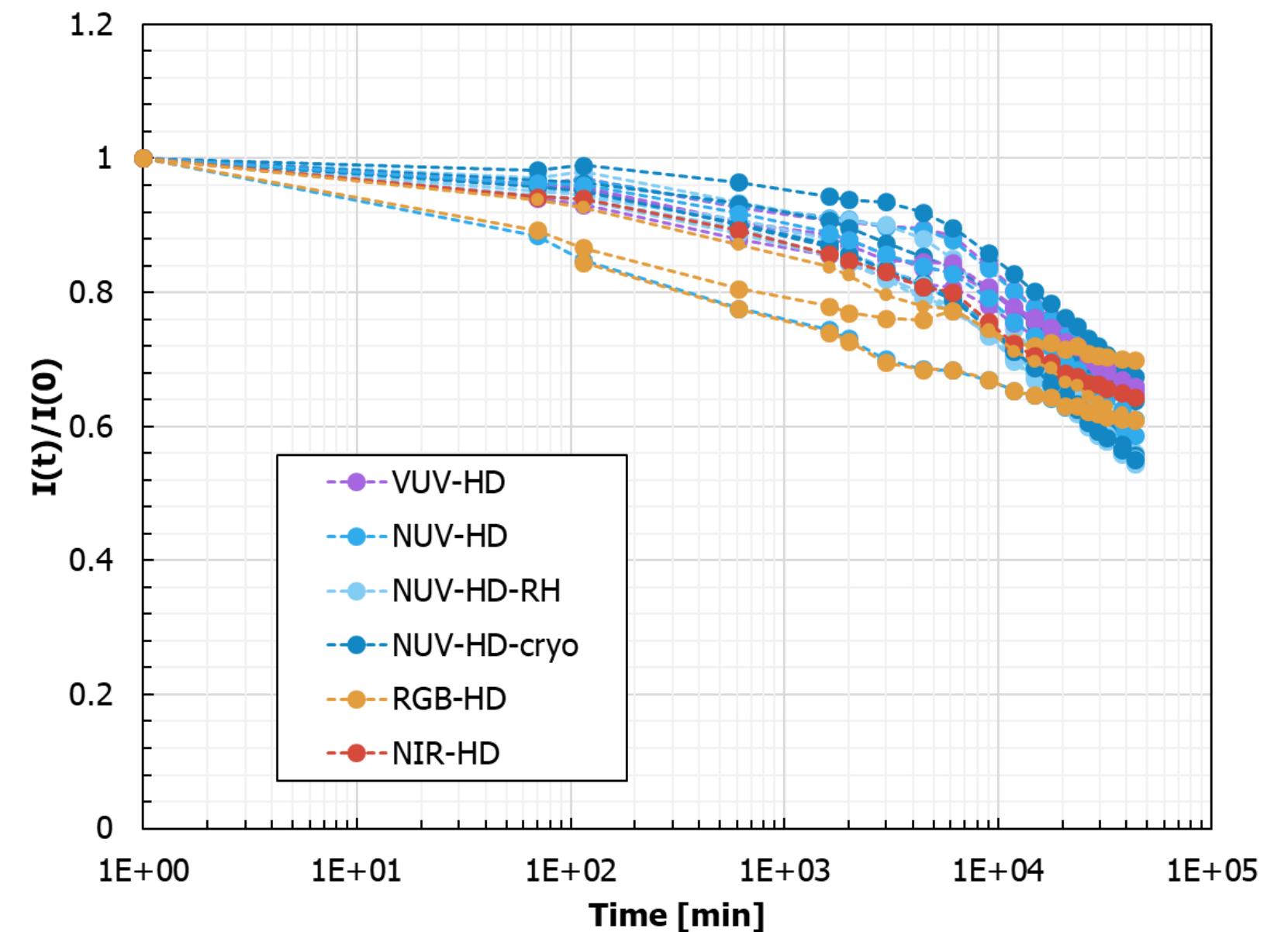
- Constant wrt. Irradiation dose.
- In accordance with literature
- *Uniform* behavior across *different technologies*:  $5 \cdot 10^{-17}$  A/cm<sup>2</sup>
- *Dependence on excess bias*: triggering probability and field-enhanced generation
- Which volume should be considered? (high E-field or collection region)

# Test Beam 1 – Trento Proton Therapy

## First Annealing studies

Annealing can be a *powerful mean of reducing DCR after irradiation* to recovers single-photon resolution.

- *Room temperature* annealing (20-25°C) on the highest dose only ( $6.4 \cdot 10^{11}$  1 MeV  $n_{eq}/cm^2$ )
- *Two slopes observed*: knee point at around  $1.5 \cdot 10^3$  min (~1 day)
- Minor dependence on excess bias for a few samples.
- *Higher annealing temperatures* have demonstrated better annealing:
  - *Factor > 10 after  $1 \cdot 10^{11}$   $n_{eq}/cm^2$  is reported in M. Calvi - <https://doi.org/10.1016/j.nima.2019.01.013>*
  - *Is there a threshold temperature* for the annealing of certain defects?



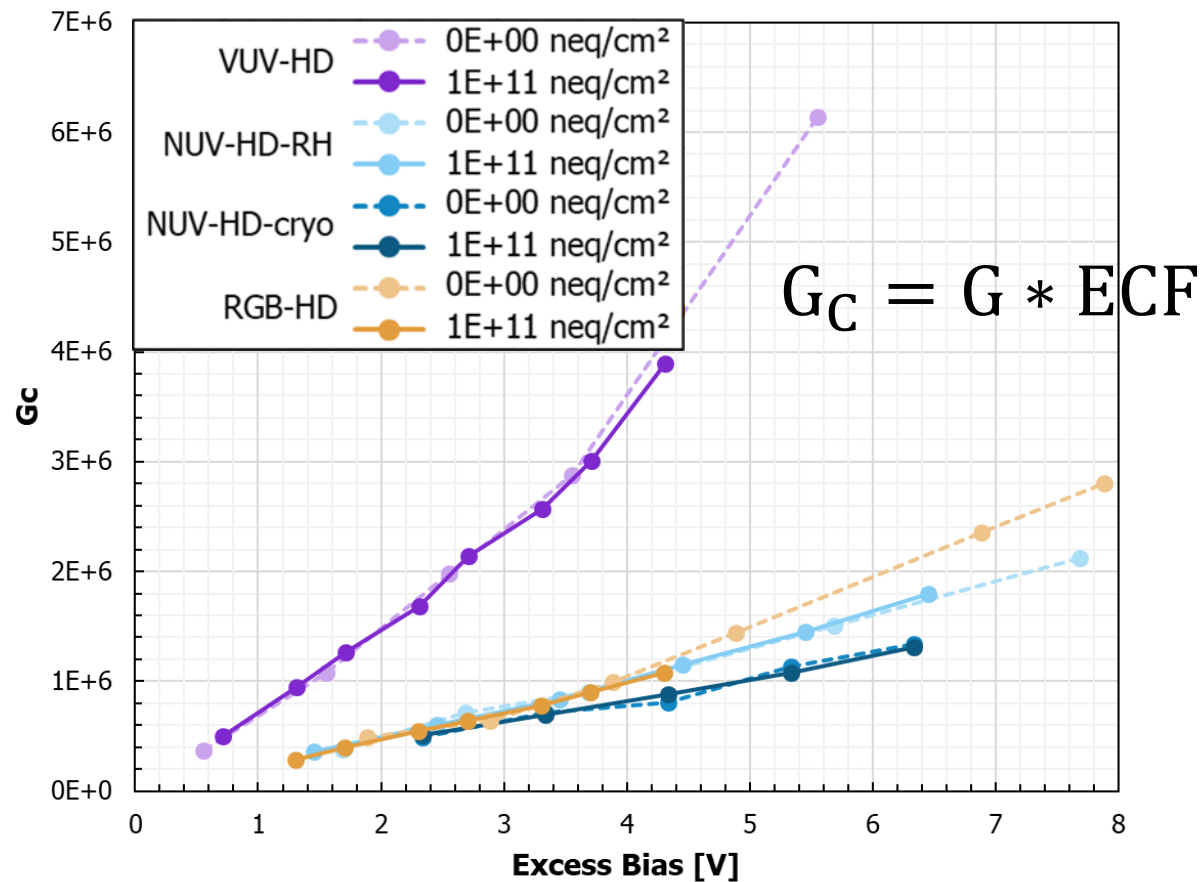
# Test Beam 1 – Trento Proton Therapy

## Variation of the other SiPM parameters

*Waveform analysis* carried out at -40°C to reduce pile-up on the highest irradiation dose ( $1 \cdot 10^{11}$  n<sub>eq</sub>/cm<sup>2</sup>).

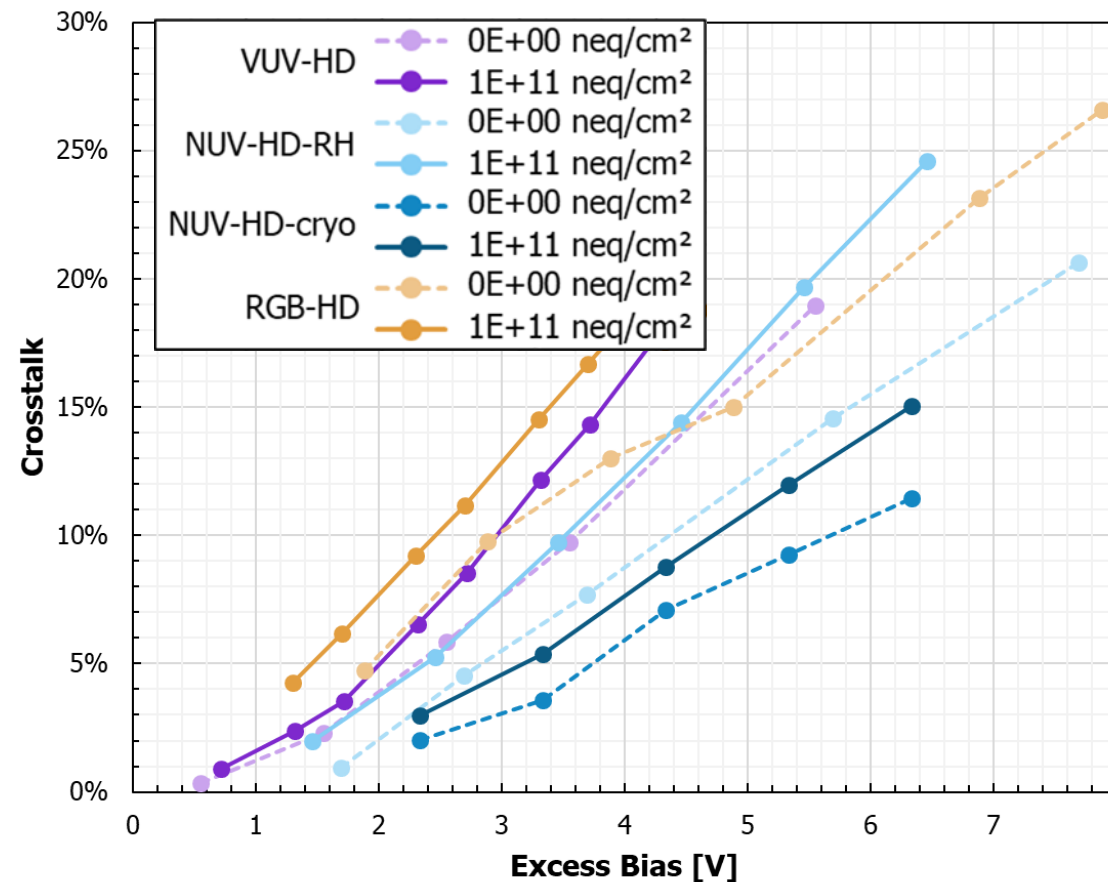
*No relevant change of the other SiPM parameters*, except for the DCR.

Current Gain



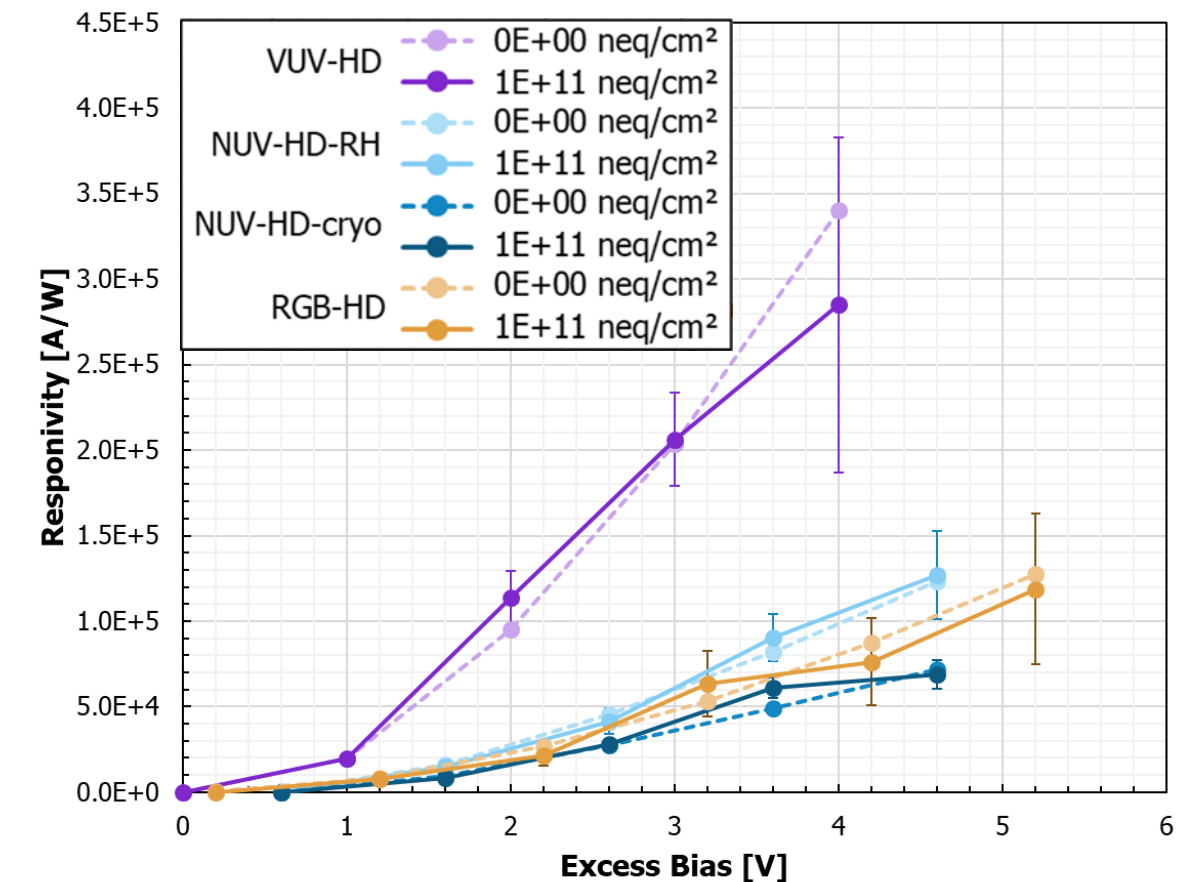
*No change in Gain \* ECF* up to  $1 \cdot 10^{11}$  n<sub>eq</sub>/cm<sup>2</sup>

Optical Crosstalk



Minor increase of CT is most likely an artifact caused by pile-up.

PDE



*No change in PDE*, measured as responsivity (loss of single photon resolution).



# Test Beam 2 – LNS Catania Experimental Setup and DoE

A test beam was carried out at LNS in Catania in 2019, focusing on *higher irradiation doses and temperature dependence studies*.

**Energy:** 62 MeV protons

**Dose:** 5 samples irradiated with different doses:

$$\sim 7.4 \cdot 10^9 - 6.5 \cdot 10^{13} \text{ p/cm}^2$$

$$\downarrow$$

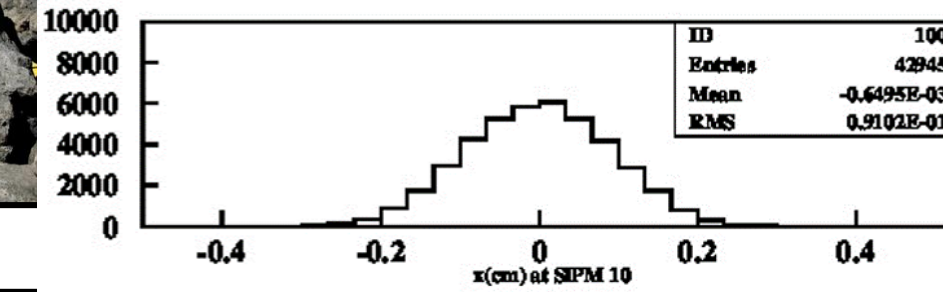
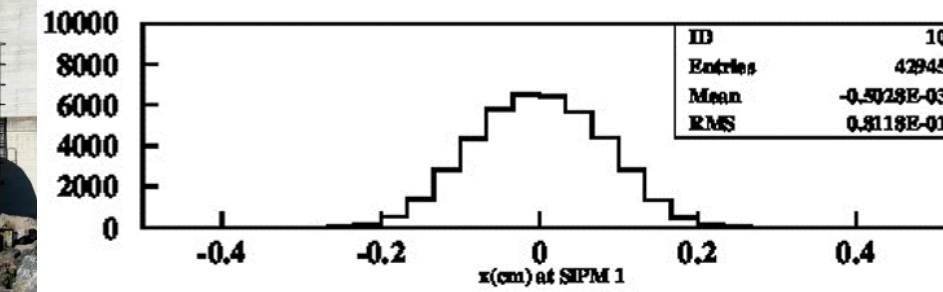
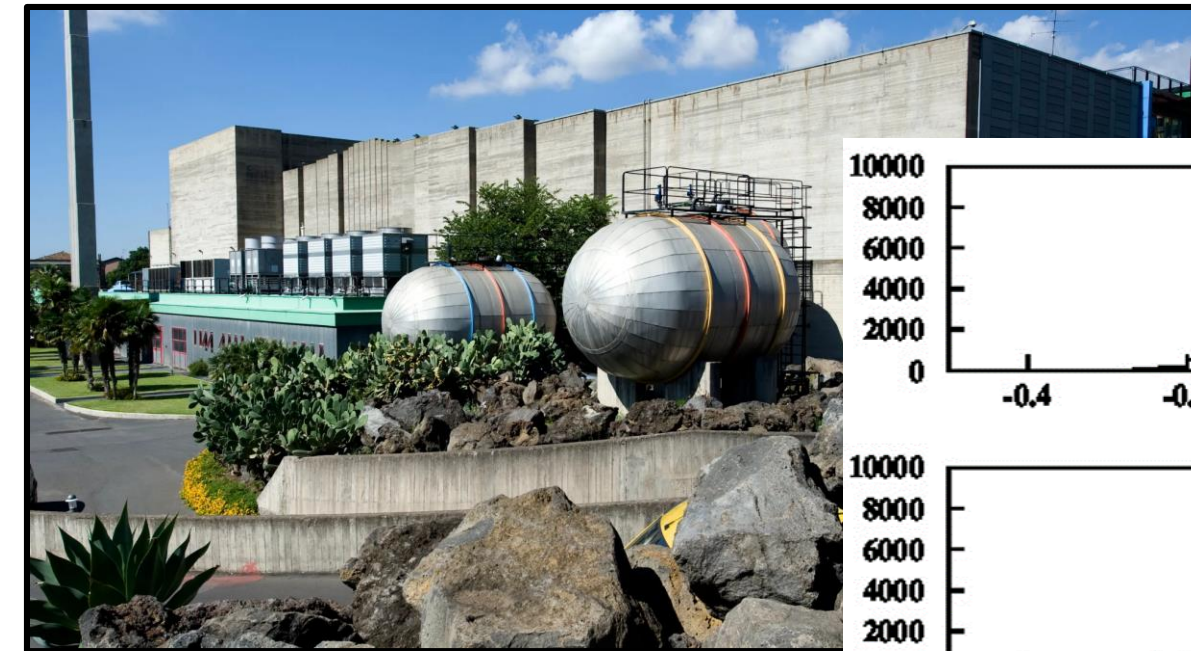
$$\sim 1.3 \cdot 10^{10} - 1.1 \cdot 10^{14} \text{ 1 MeV } n_{\text{eq}}/\text{cm}^2$$

**Analysis:** after irradiation, on each sample:

**Devices:** **NUV-HD-RH**

*15 um cell size*

1x1 mm<sup>2</sup> active area



Gaussian beam: 2.7 mm diameter collimator



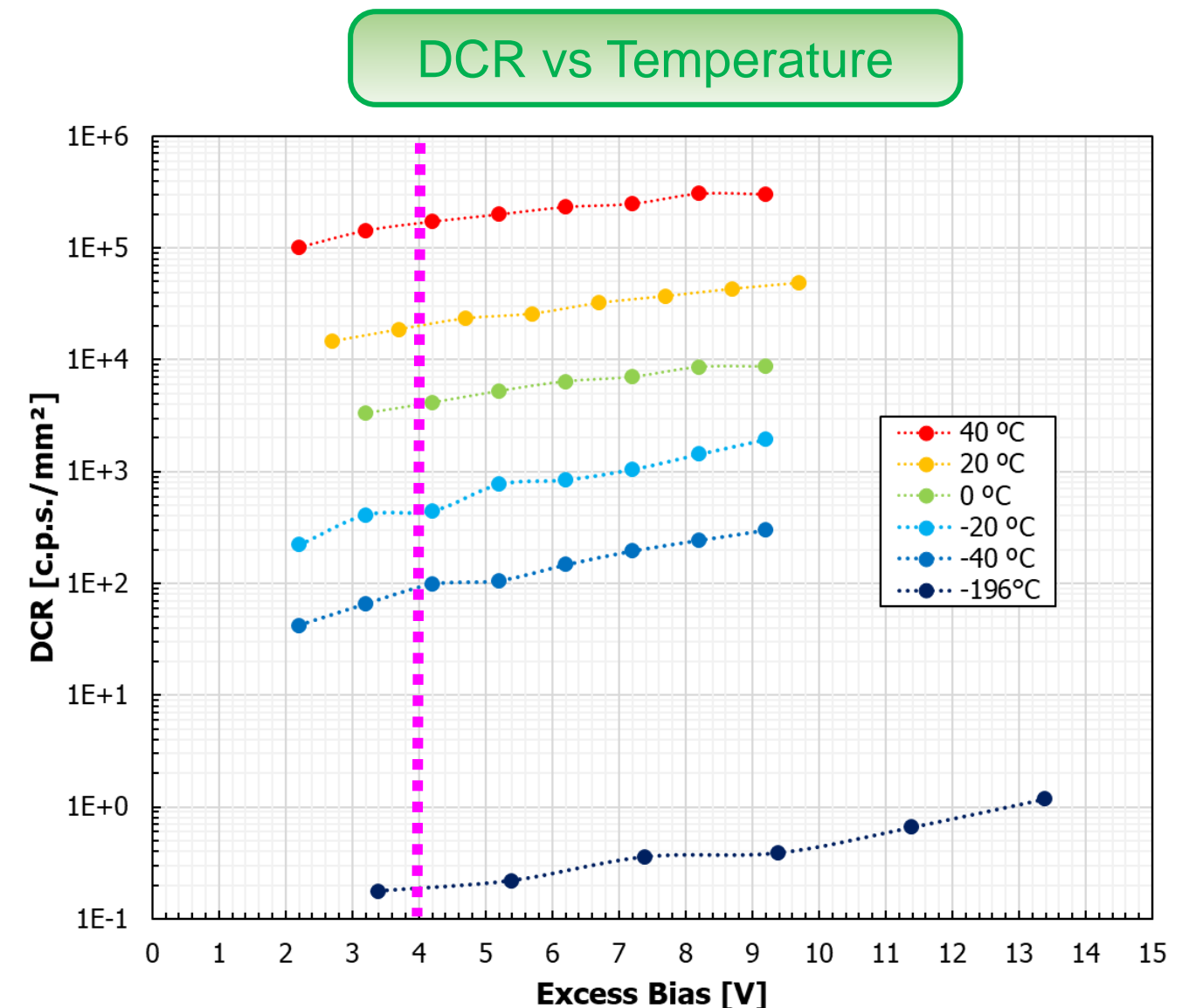
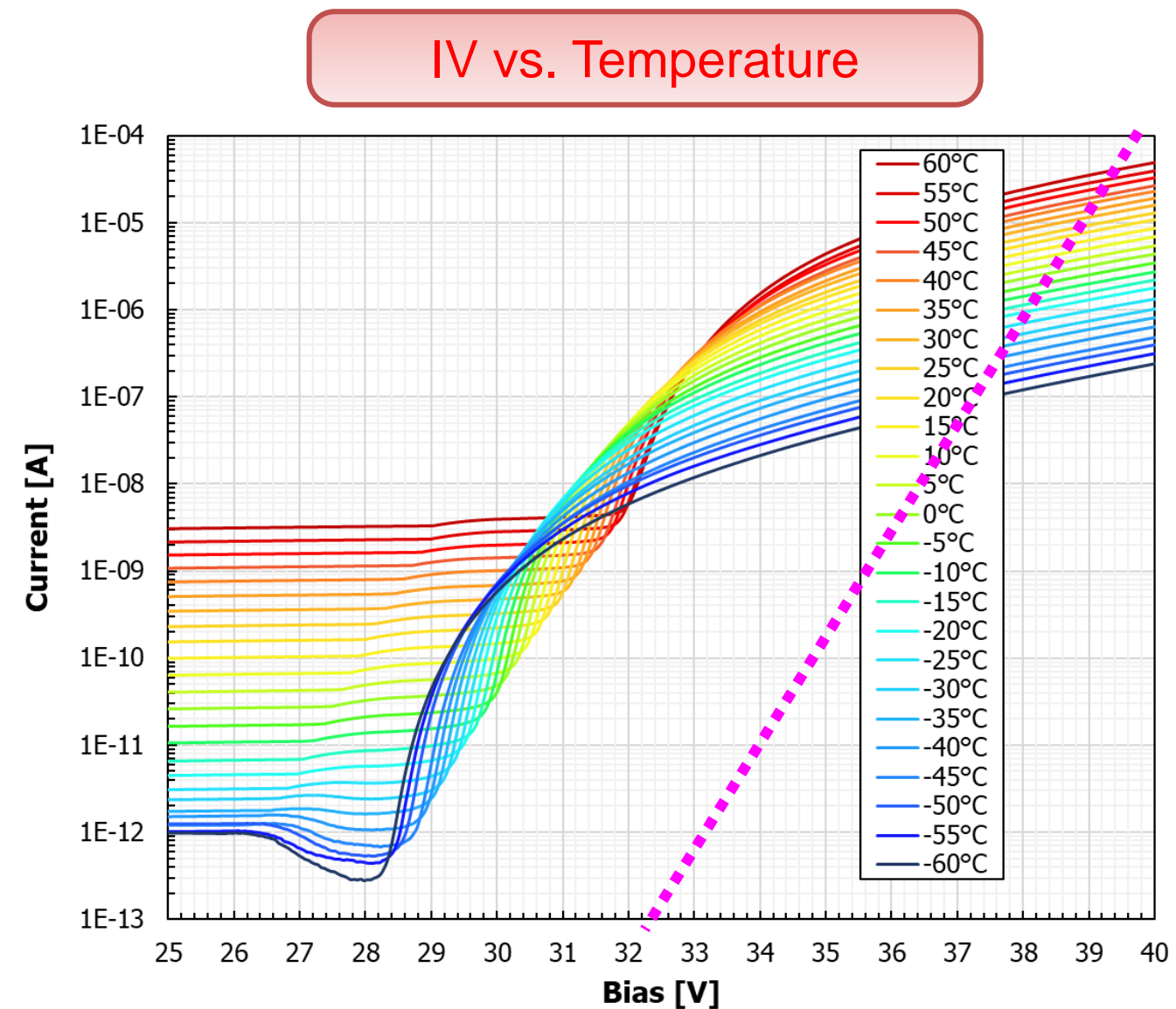
# Test Beam 2 – LNS Catania

## DCR Analysis



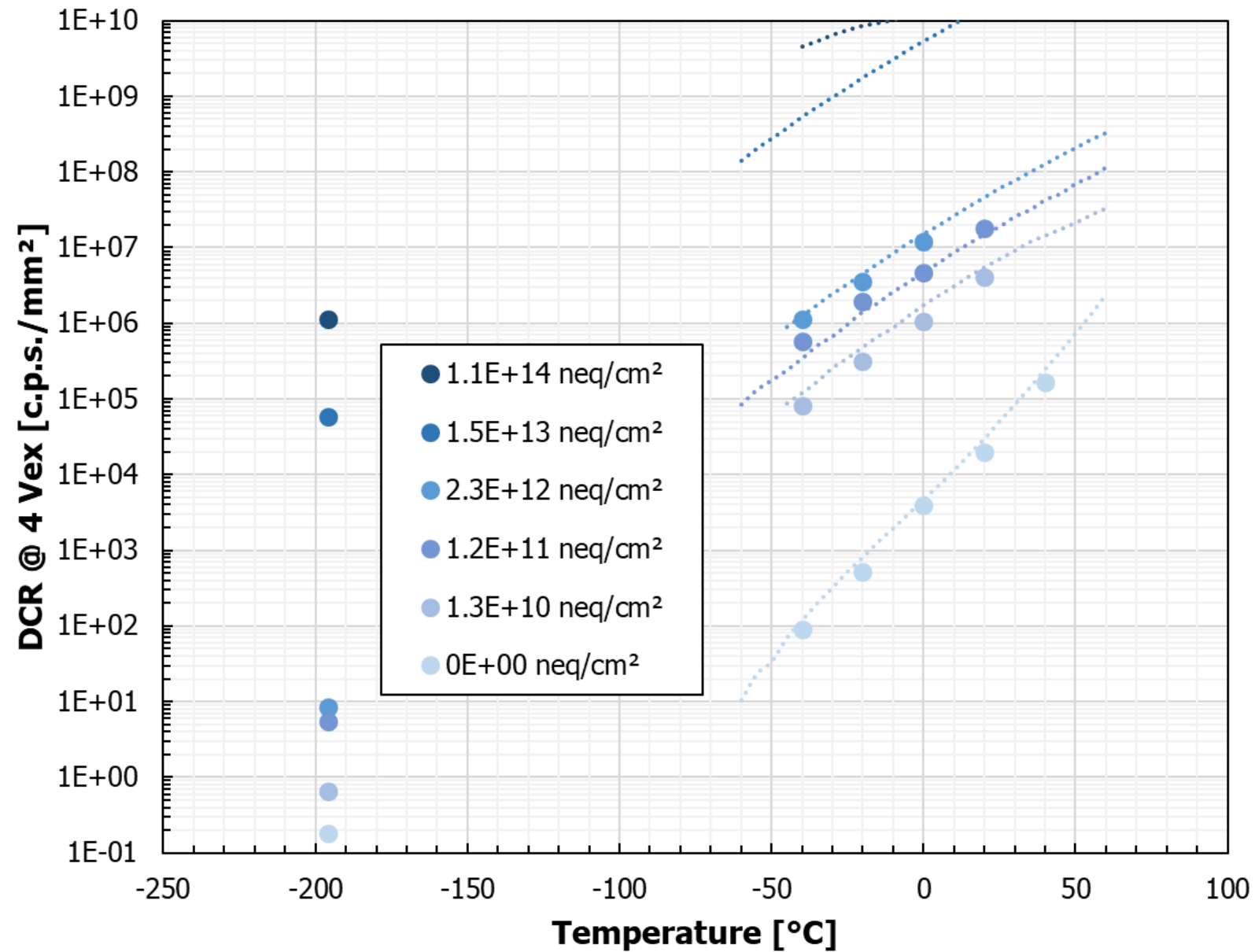
Study of *DCR after irradiation extended to cryogenic temperatures (preliminary)*.

- *IV vs Temperature*: +60°C → -60°C
- *DCR vs Temperature*: +40°C → -40°C, LN<sub>2</sub> (waveform analysis, when possible)



# Test Beam 2 – LNS Catania

## DCR vs. Temperature and Dose

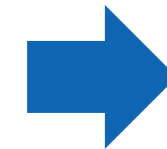


*Lines:* DCR from IV

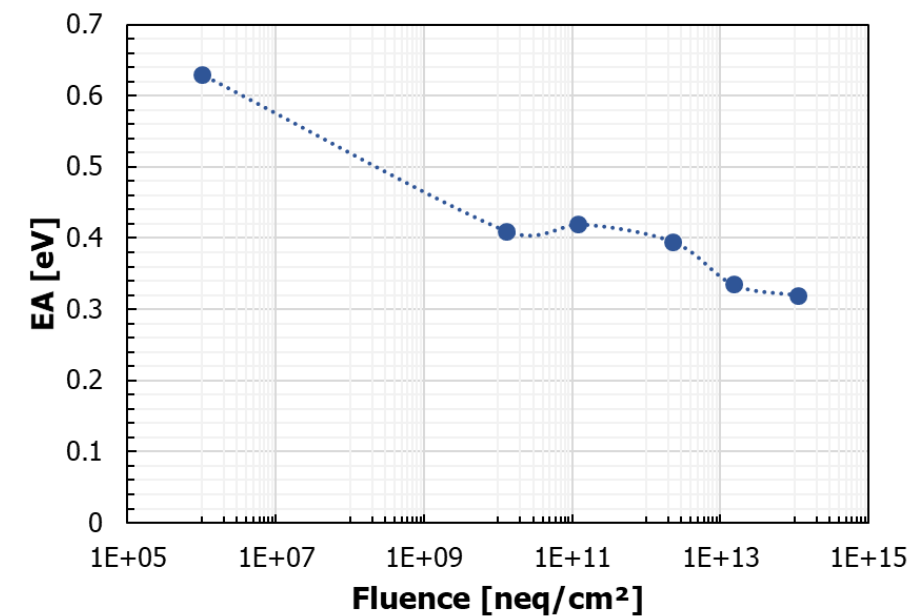
*Dots:* DCR from waveform analysis

Reduction of DCR activation energy near room temperature after irradiation was observed.

→ Cooling becomes less effective in reducing DCR.

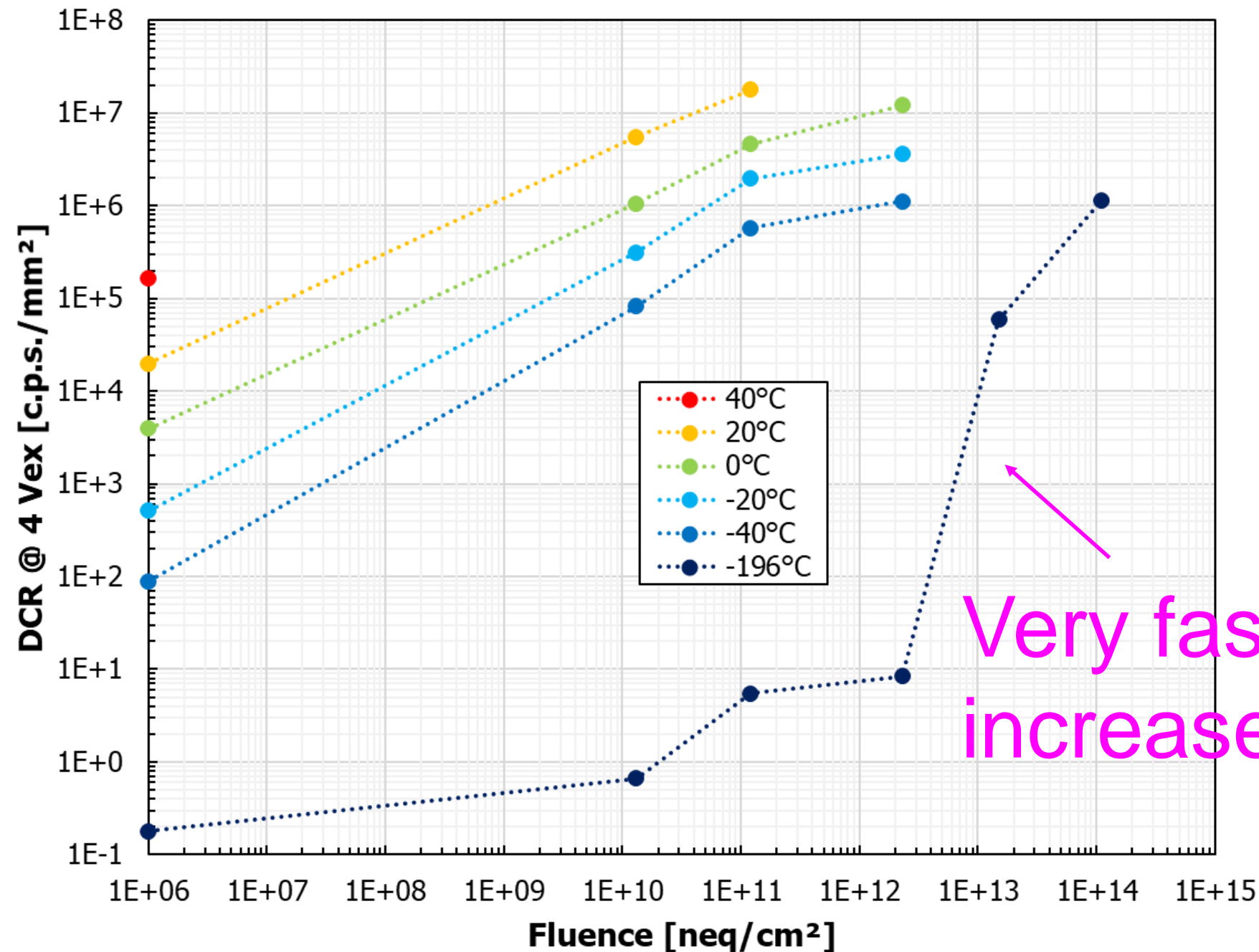


Fluence [n <sub>eq</sub> /cm <sup>2</sup> ]	E <sub>A</sub> [eV]
0E+00	0.63
1.3E+10	0.41
1.2E+11	0.42
2.3E+12	0.40
1.5E+13	0.34
1.1E+14	0.32



# Test Beam 2 – LNS Catania

## DCR at LN after irradiation



- Cooling is *extremely effective in reducing DCR after irradiation up to  $\sim 1 \cdot 10^{12}$  neq/cm<sup>2</sup>*
- Further investigations needed to understand what happens at the higher doses
- Worth checking different / new SiPM structures
- Check possible effect of annealing

# Radiation Hardness

## Definition + Mitigation strategies

It is rather obvious that *we cannot prevent the bulk damage from increasing the DCR* of the SiPM.

A *possible definition of Rad-Hardened / tolerant SiPM* is a *SiPM that retains its target performance in a given application* even after radiation damage.

→ Depends on the application!

→ *Radiation damage mitigation strategies* (+ annealing)

Use of small cells + Engineering of electric field

Issue / Hypothesis	Technical Solution	Mitigation
Increase of primary DCR	Electric field engineering	Better DCR temperature coefficient High PDE at lower bias (to reduce field-enhanced effects)
PDE loss due to cells busy triggering dark counts.	Smaller Cells	More cells and faster recharge: lower PDE loss.
Increased power consumption due to higher DCR.	Smaller Cells	Lower gain: less current (for a given DCR).



.. But, at the same time, we need high PDE!

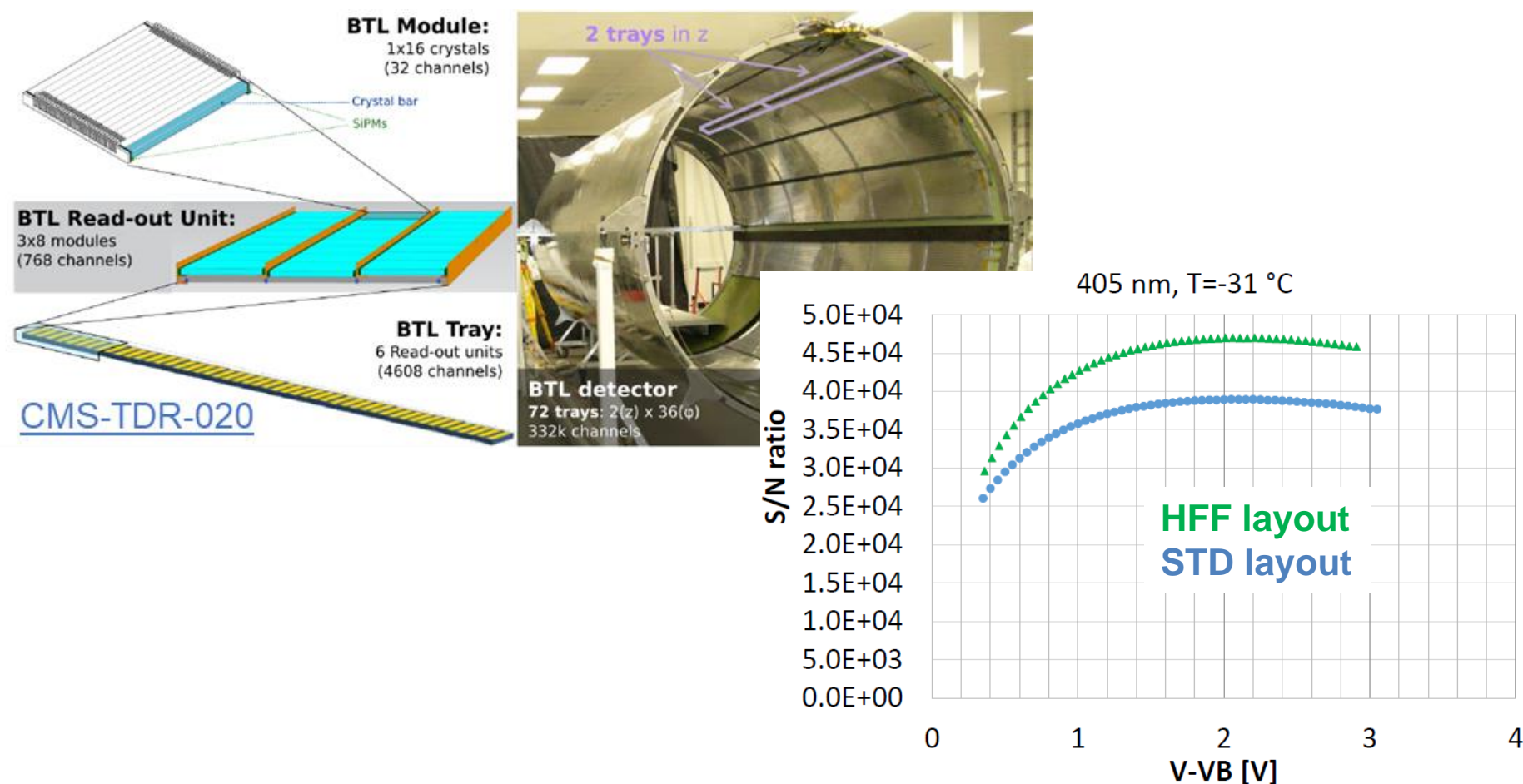


# Mitigation of Radiation Damage

## NUV-HD-RH SiPMs for CMS-BTL

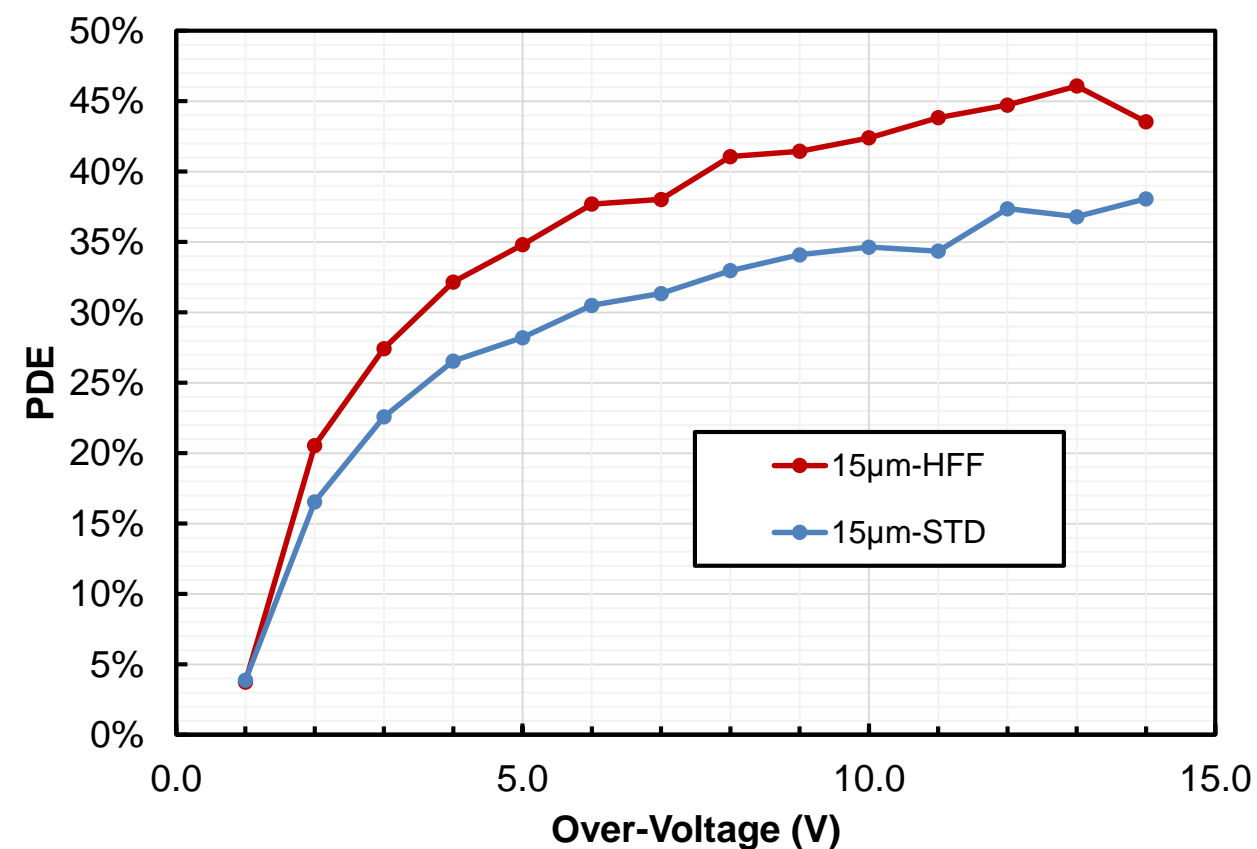
*SiPMs with extreme radiation tolerance* are required for the Barrel Timing Layer of the CMS experiment, at CERN:  $1.9 \times 10^{14}$  1 MeV  $n_{eq}/cm^2$ .

Custom SiPM technology was developed, combining *electric field engineering with small-pitch SiPM technology*, for enhanced radiation hardness.



FoM measured by from CMS collaboration:  
A. Heering, Y. Musienko, M. Lucchini et al.)

### NUV-HD-RH SiPMs



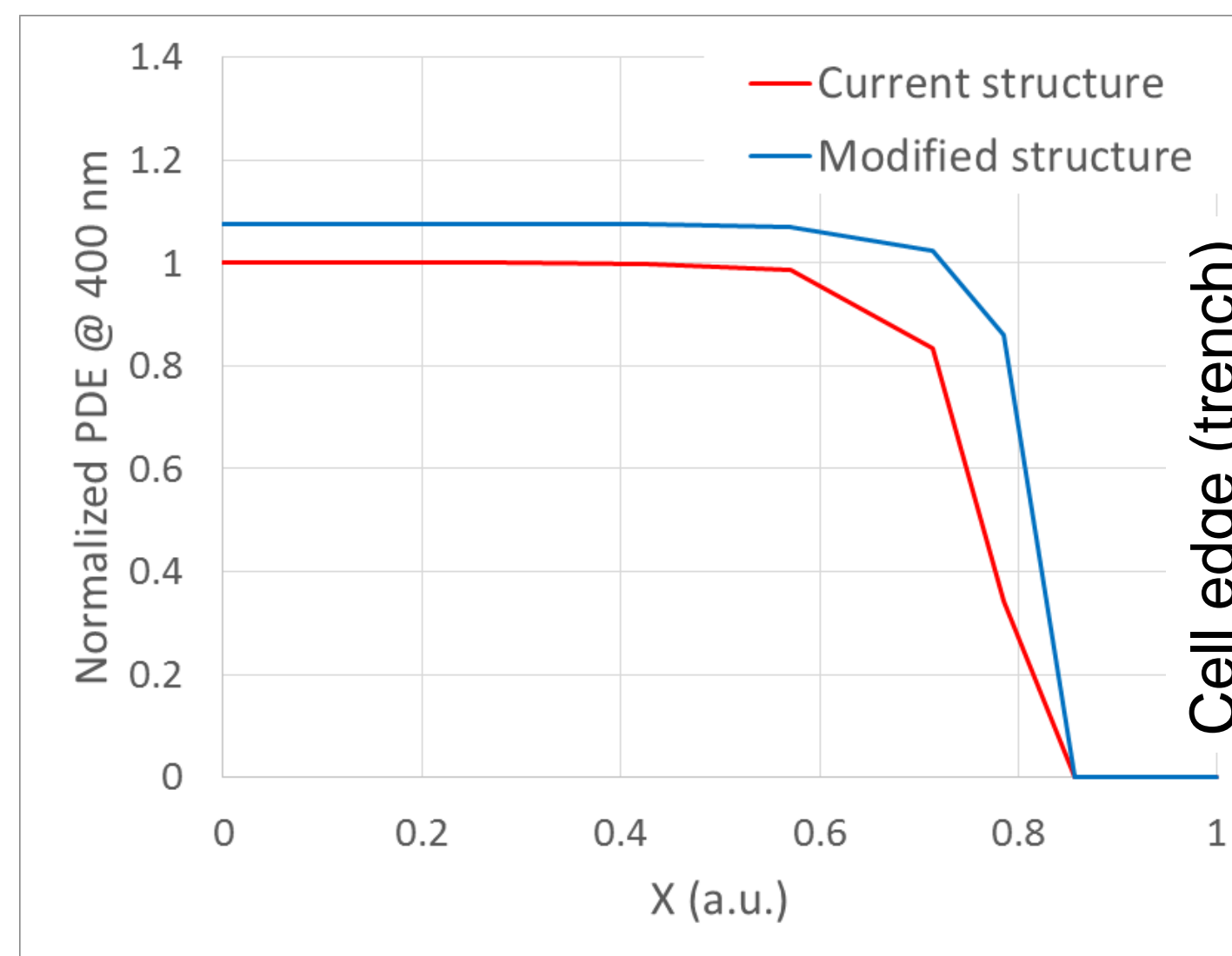
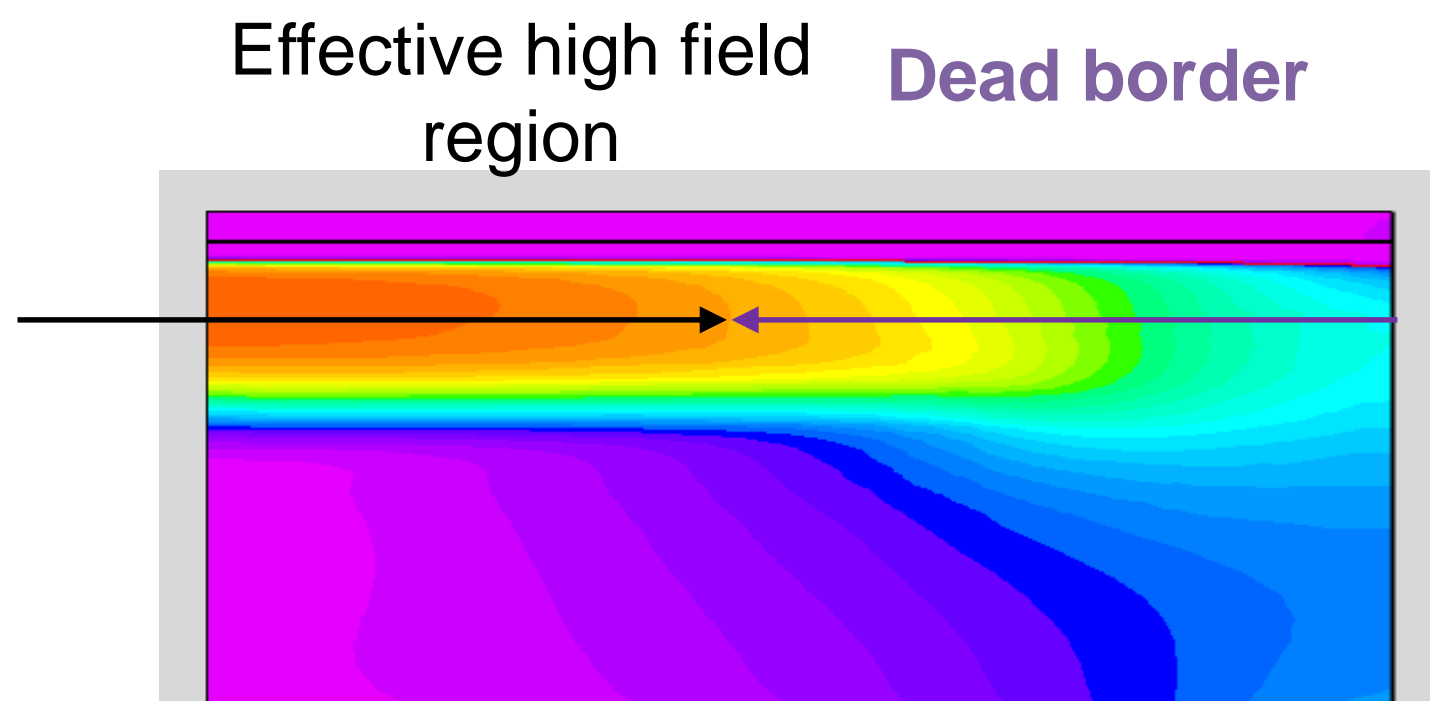
The advantage of using small cells for radiation hardness is relevant *only if they can still provide very high PDE*

# Mitigation of Radiation Damage

## NUV-HD-RH SiPMs for CMS-BTL

R&D still in progress to improve the electric field profile and to select optimal cell size:

- *Narrower dead border at small OV*
- *Faster increase of PDE vs OV*

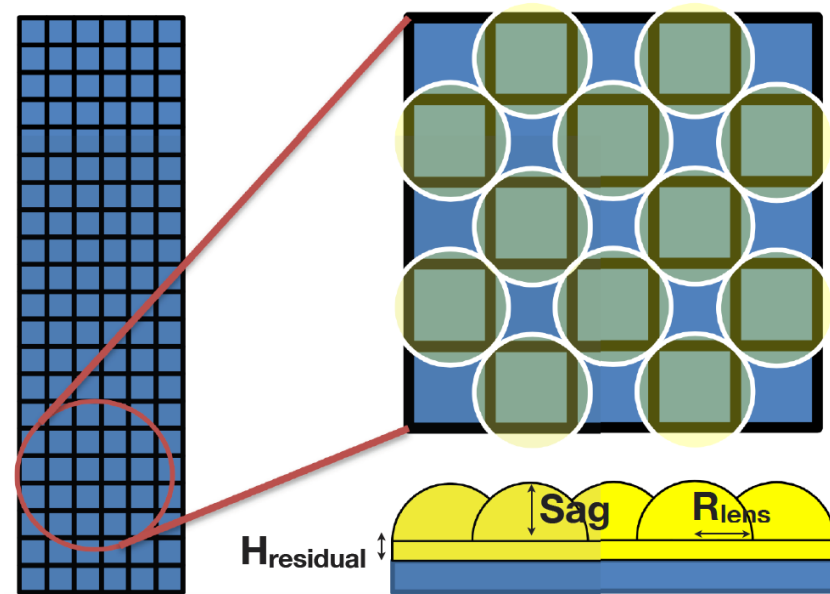


Simulated PDE @ 400 nm vs normalized distance from cell center

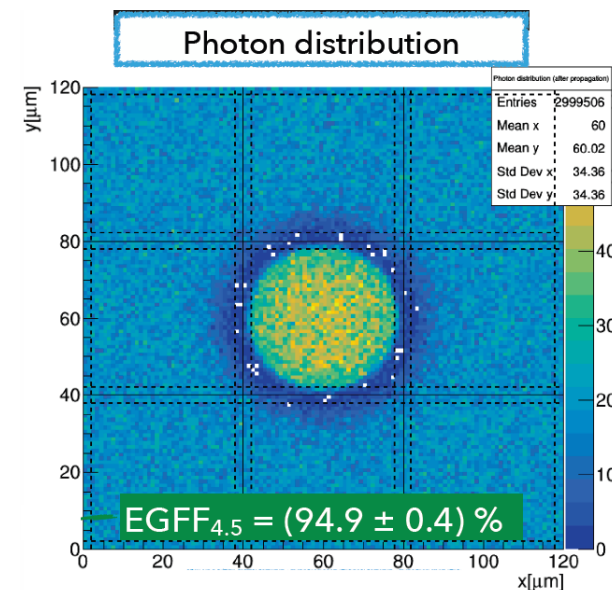
# Light concentration Microlenses

Microlenses can be used to *enhance the Fill Factor (FF) and thus the PDE of the SiPM microcells.*

- Exploratory project between FBK and EPFL for LHCb SciFi tracker → Sensitivity-enhanced SiPMs
- Effectiveness *depends on the angular distribution of photons.*



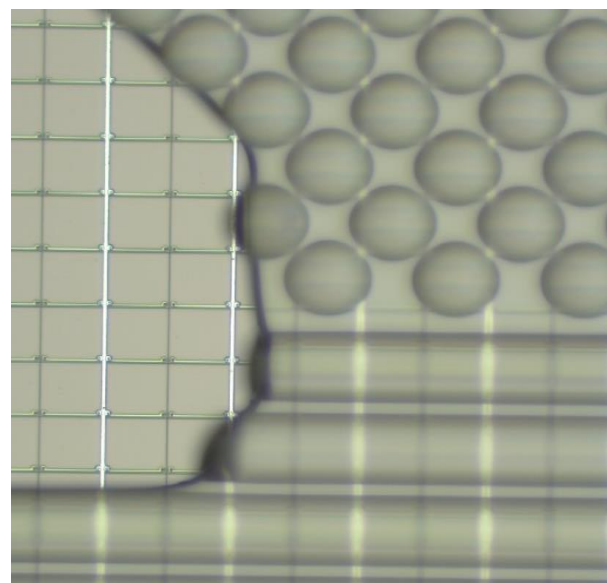
Proposed microlens geometry



95% FF on 40 um SiPM microcells  
(80% without microlenses)

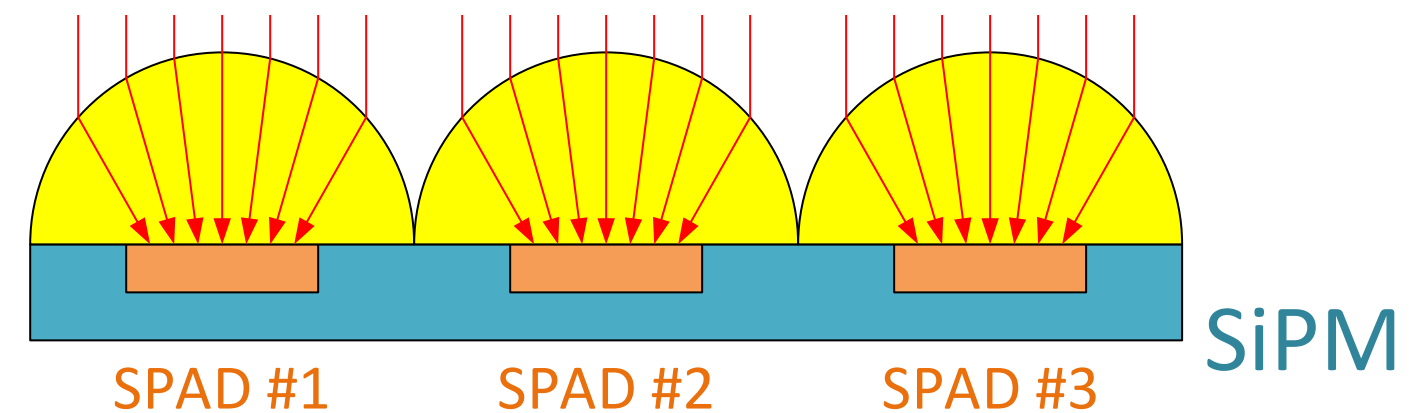
Microlenses to enhance radiation hardness

- Photons can be focused on a much smaller light-sensitive area within each microcell.
- The silicon *area sensitive to radiation damage is reduced.*



23% improvement!

Courtesy of C. Trippi, G. Haefeli  
<https://doi.org/10.1016/j.nima.2022.167216>



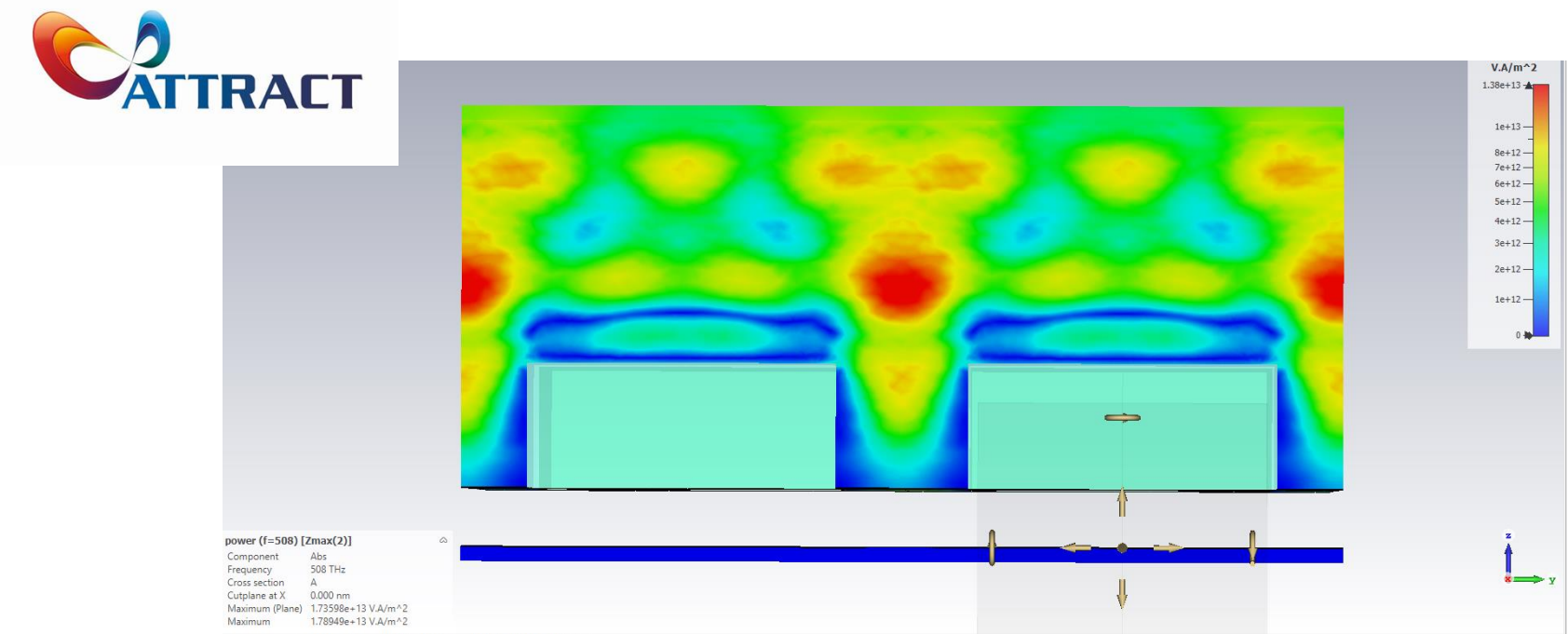
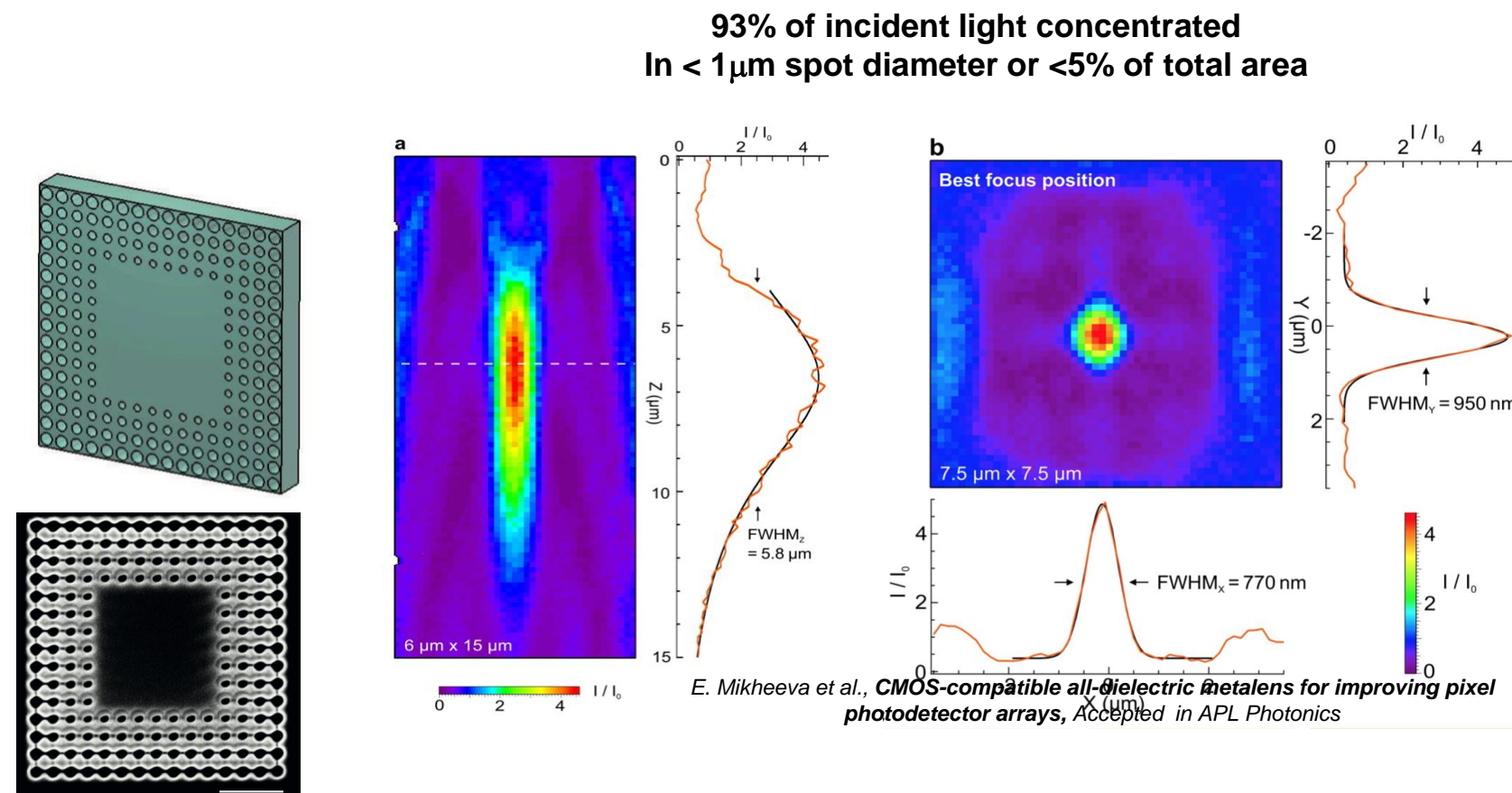
# Light concentration Metasurfaces and Metamaterials



FBK investigated the possibility of *using nanophotonics to enhance SiPM performance* in the context of the PHOTOQUANT ATTRACT project.

*Metalens-based light concentrators* can work similarly to microlenses *to enhance SiPM radiation hardness*.

- Advantages: rad-hard metalens material (TBC), compatibility with CMOS planar processing.



Deeper modification of the SiPM structure to evaluate enhancement of efficiency with nanophotonics.

Experimental metalens designed and fabricated  $4 \times 4 \mu\text{m}$   $\text{Nb}_2\text{O}_5$  metalens with refractive index gradient introduced by holes of varying diameter, (joint ATTRACT project CERN, FBK, Institut Fresnel.)

# 2.5D and 3D Integration

## FBK IPCEI clean-room upgrade

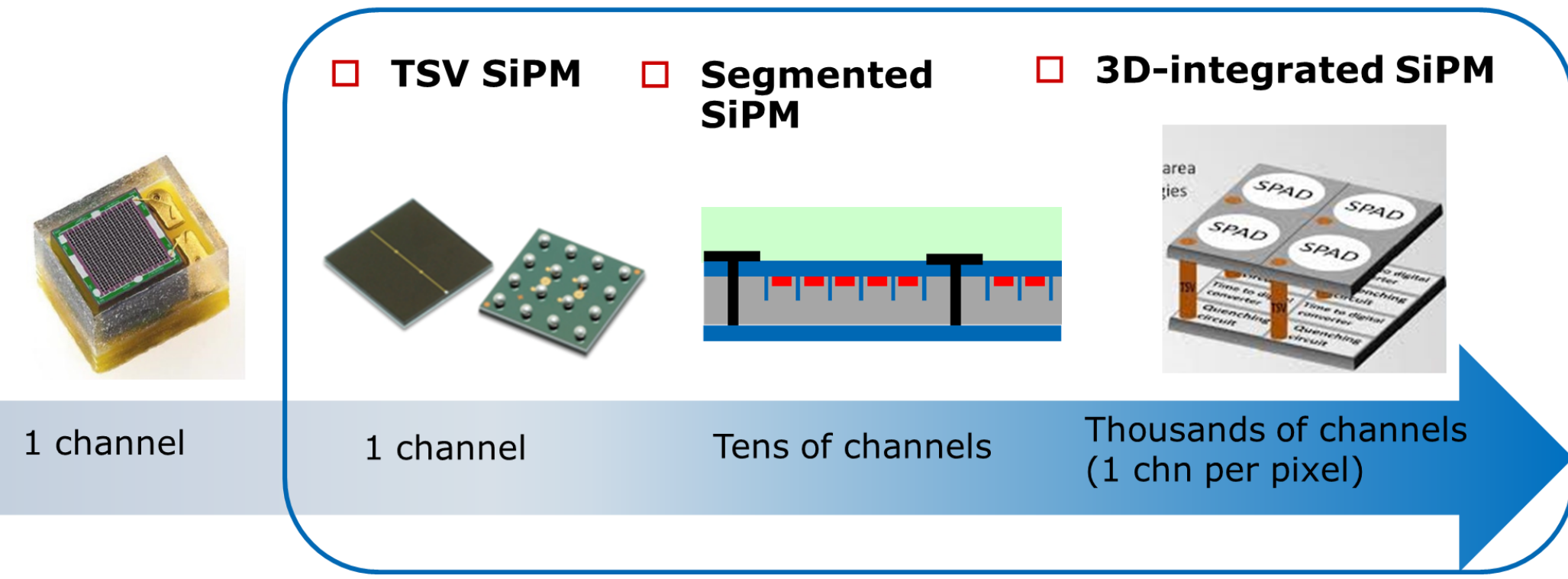
FBK is part of the *IPCEI on microelectronics* project (Important Project of Common European Interest - €1.75 billion total public support, 12 M€ to FBK).

The goal for FBK is upgrading its optical sensors technologies, by *developing TSVs, micro-TSV and Backside Illuminated SiPMs*. This will allow high-density interconnections to the front-end and high-segmentation.

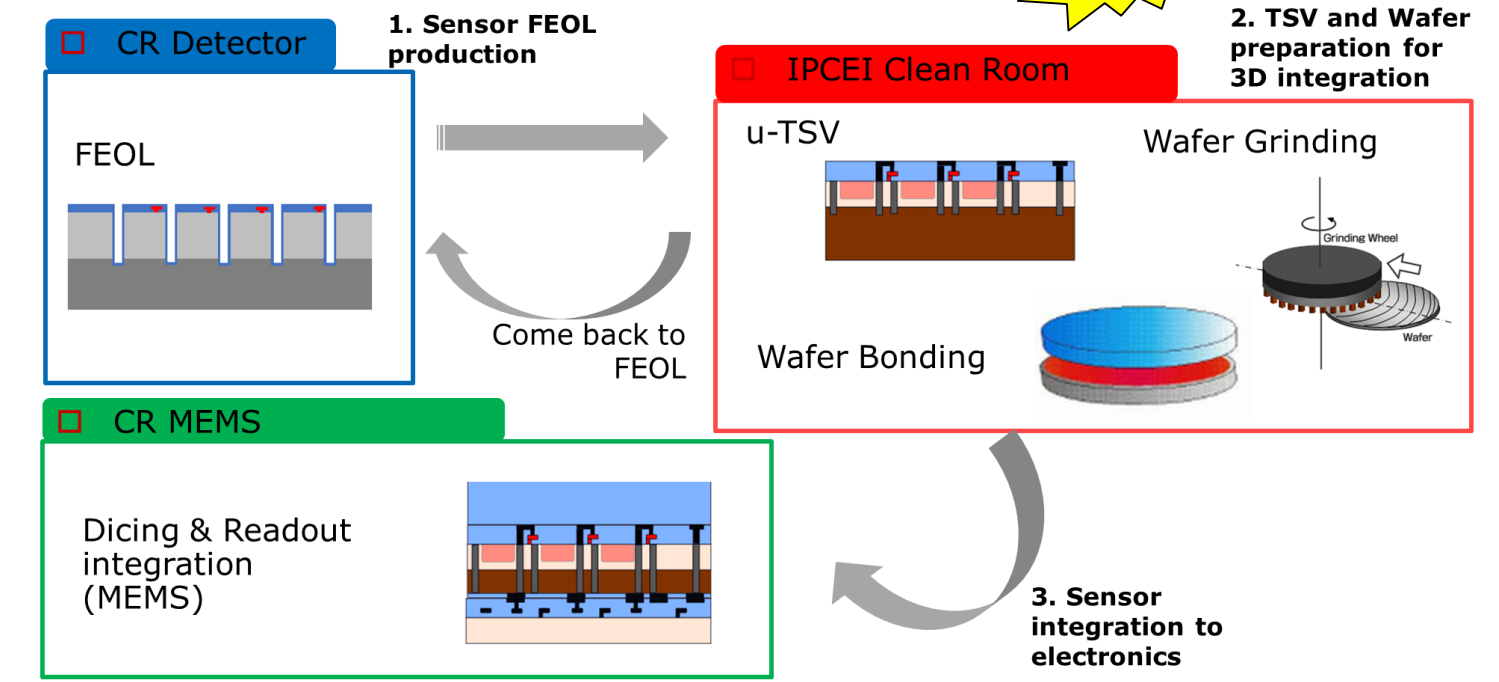
*Customized TSVs* will be optimized to preserve the NUV-HD electro optical and timing performance.

New clean-room under construction for 3D integration

new



Range of technologies being developed within IPCEI



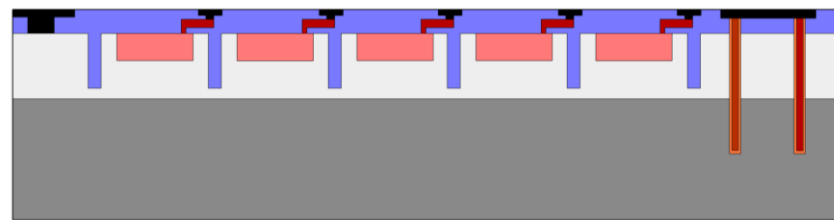
The future system composed of 3 research clean-rooms in FBK.

# 2.5D and 3D Integration

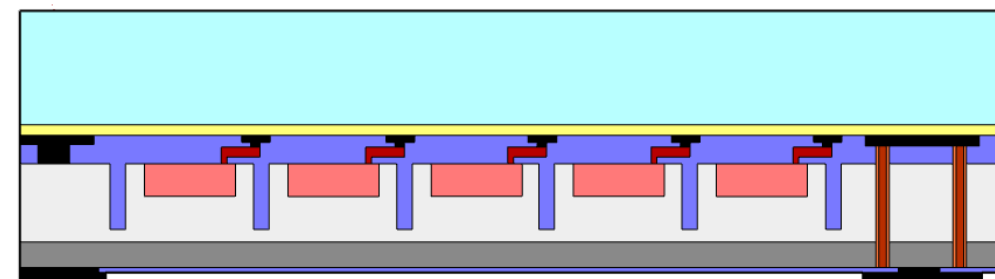
## TSV – via mid: process flow

In the via-mid process, the *TSV is formed during the fabrication of the SiPM, modifying its process flow.*

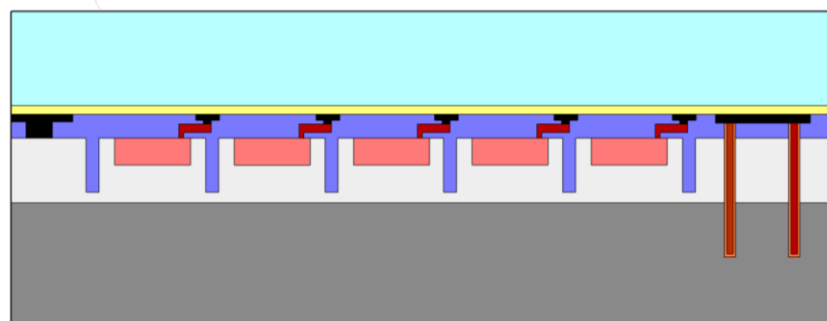
- SiPM fabrication + TSV formation



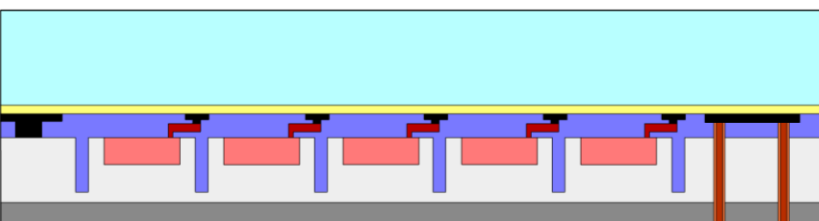
- Contacts formation



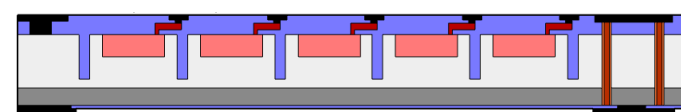
- Edge Trimming + BONDING



- THINNING



- DEBONDING



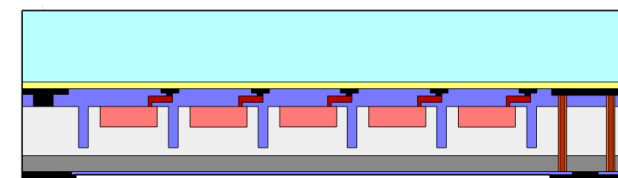
Thickness at least 150  $\mu\text{m}$

**Glass-less TSV**

concept

500  $\mu\text{m}$  SiPM pitch

- NO-DEBONDING

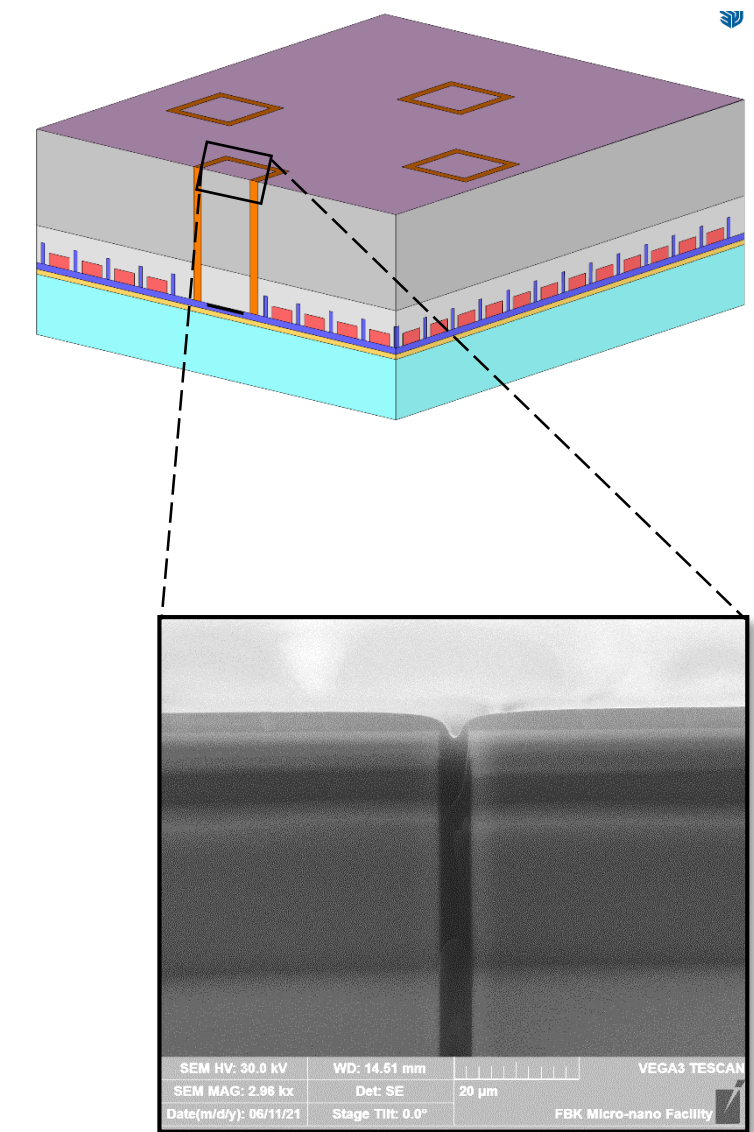


Thickness 10-50  $\mu\text{m}$

Standard TSV

**microTSV**

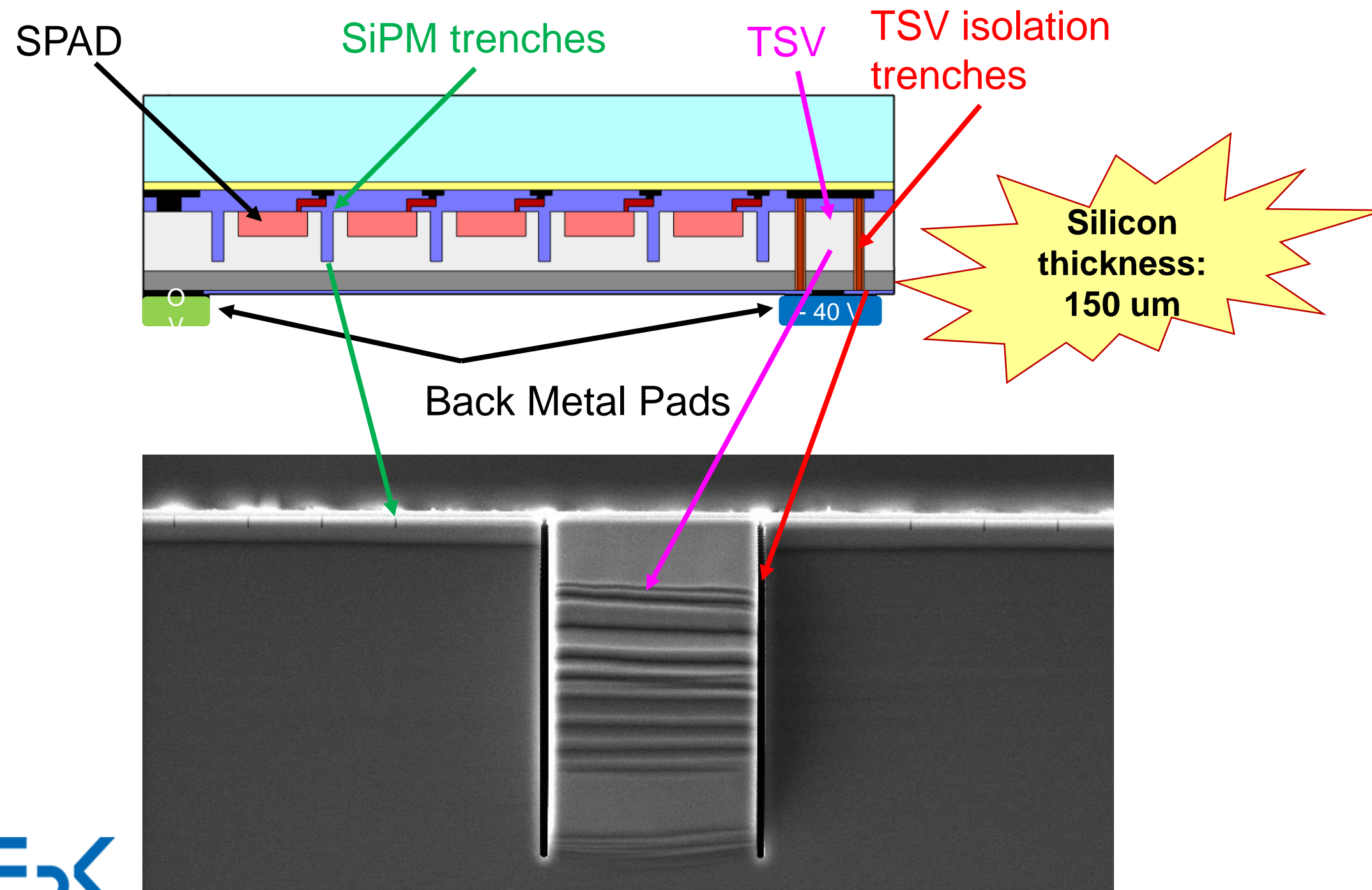
< 50  $\mu\text{m}$  SPAD pitch



# 2.5D and 3D Integration

## TSV – via mid: first results

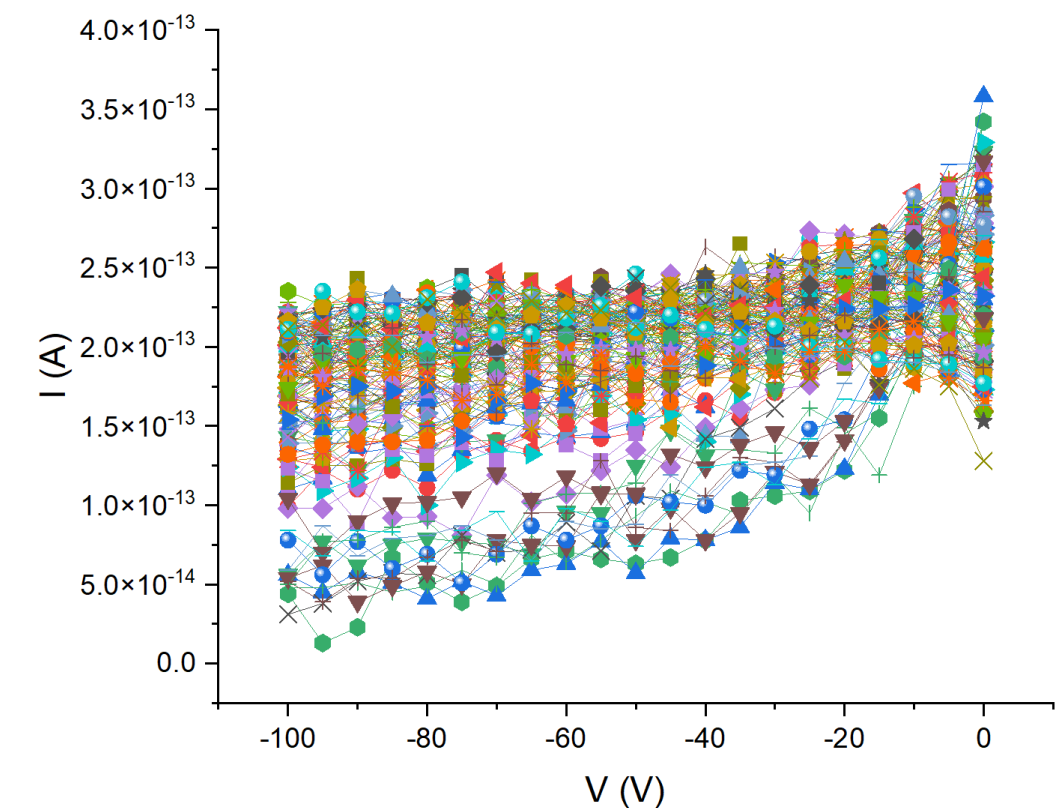
Preliminary results on TSV via-mid development, with partial SiPM process, to *check isolation and continuity* (no Geiger-mode multiplication).



At **-100 V** of bias applied the intensity varies from **30 to 200 fA**



Trough Silicon Vias – Via Mid are isolated from the bulk silicon contact

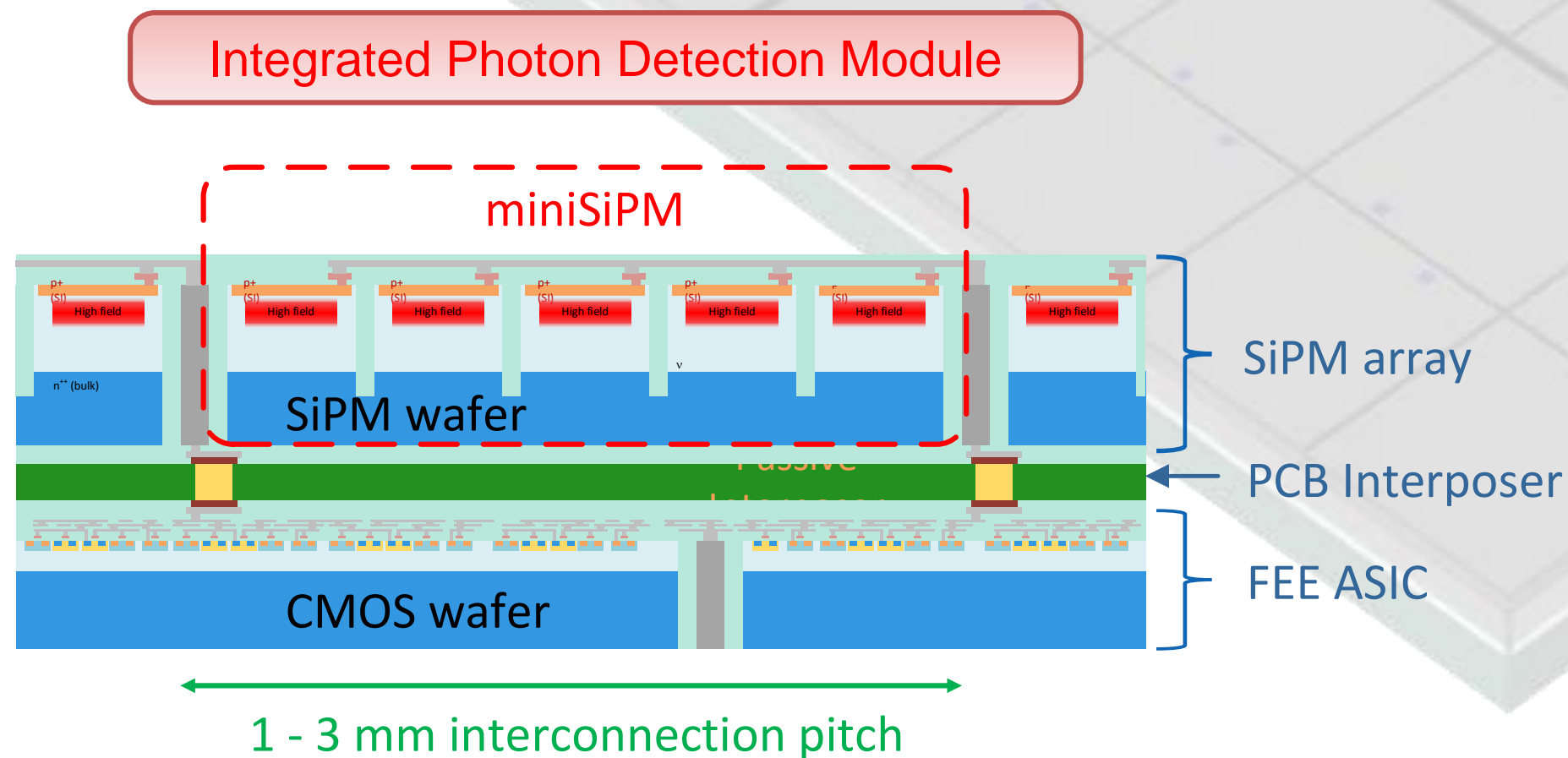


# 2.5D and 3D Integration

## 2.5D integrated SiPM tile

In the *short and medium term*, medium density interconnection seems the sweet spot to obtain *excellent performance (e.g. timing) on large photosensitive areas while not increasing complexity and cost too much*.

We propose a Photon Detection Module (PDM) in which *SiPMs with TSVs down to 1 mm pitch* are connected to the *readout ASIC on the opposite side of a passive interposer*, in a *2.5D integration scheme*.



Core partners:



Jožef Stefan Institute



MASSACHUSETTS  
GENERAL HOSPITAL



Hybrid SiPM module being developed for ultimate timing performance in ToF-PET

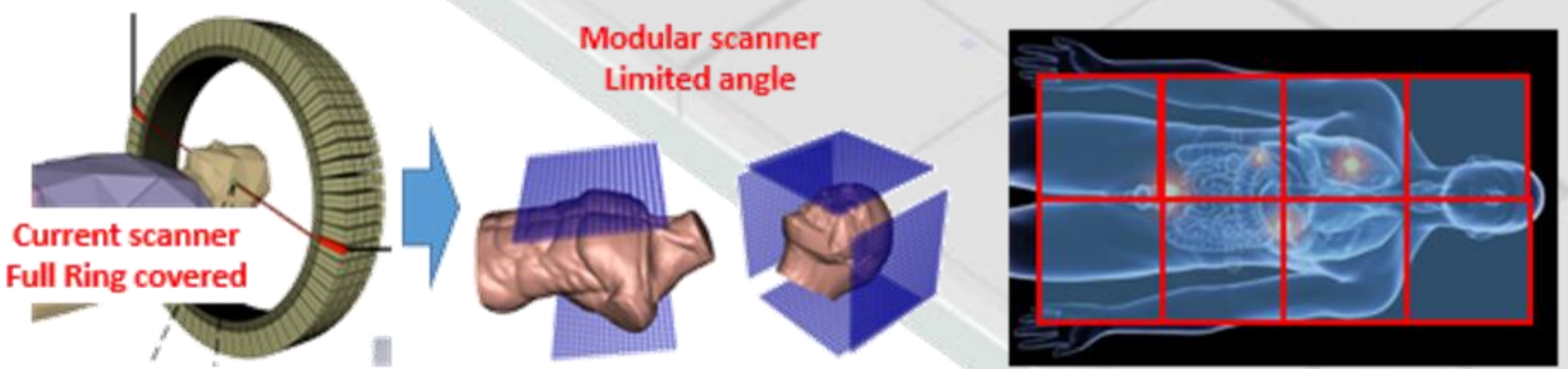


# 2.5D and 3D Integration

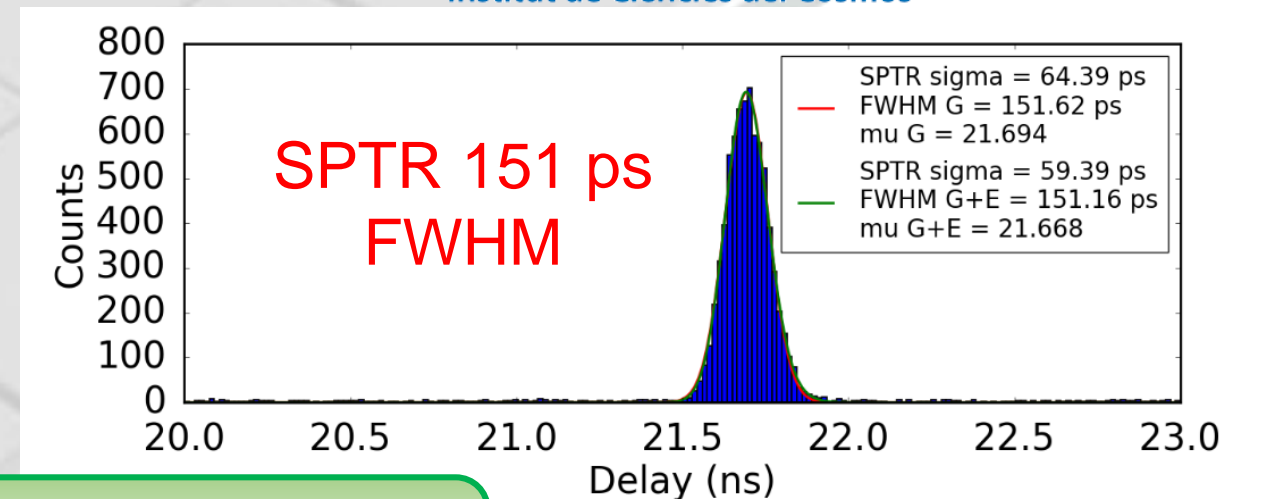
## 2.5D integrated SiPM tile for timing

The 2.5D integrated PDM (50x50 mm<sup>2</sup>) will be the basis of a *30x30 cm<sup>2</sup> ToF-PET panel*, which will be used to build limited-angle ToF-PET systems, for brain PET, Cardiac PET and full-body scanners.

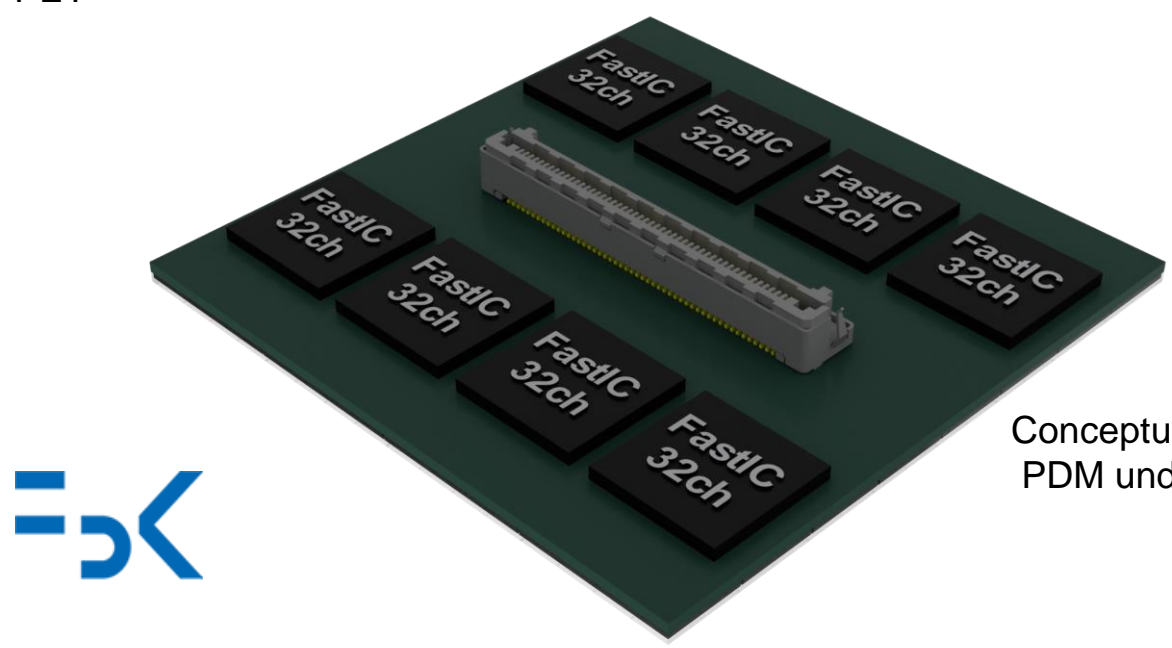
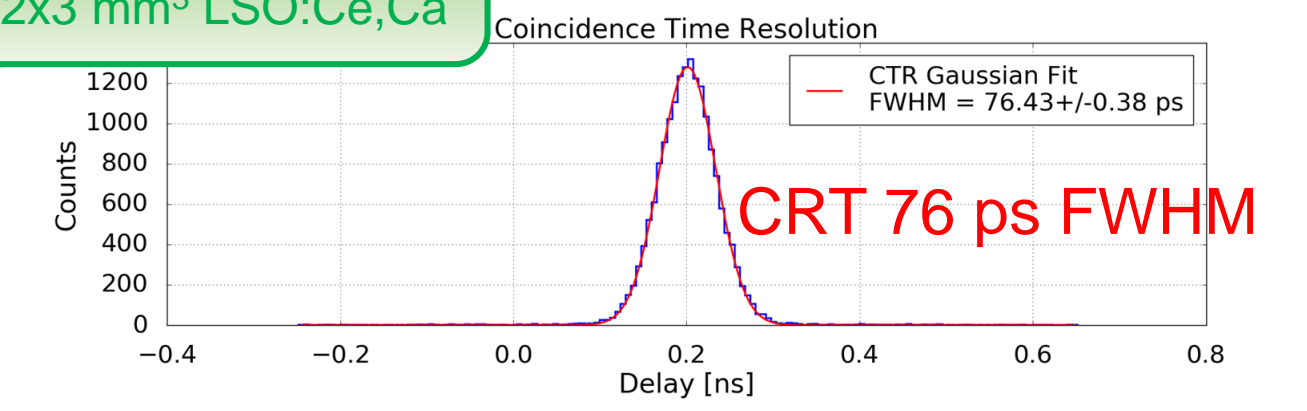
We *expect very good timing performance*, supported by preliminary measurements achieved with NUV-HD SiPMs coupled to FastIC ASIC.



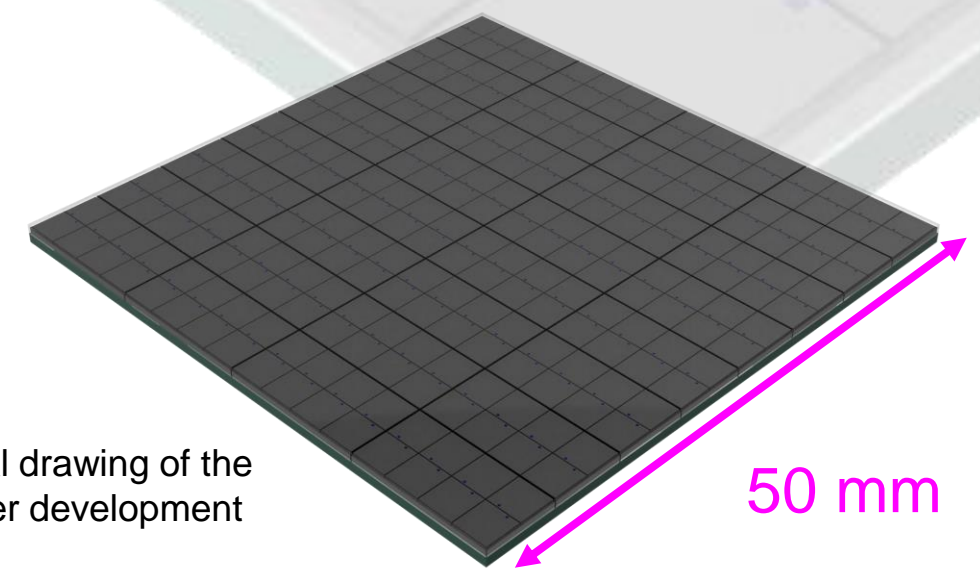
Application of the PDM to build large panes used in new, limited-angle PET applications: Brain Pet, Cardiac PET, while-body PET



2x2x3 mm<sup>3</sup> LSO:Ce,Ca



Conceptual drawing of the PDM under development



Alberto Gola - RICH 2022

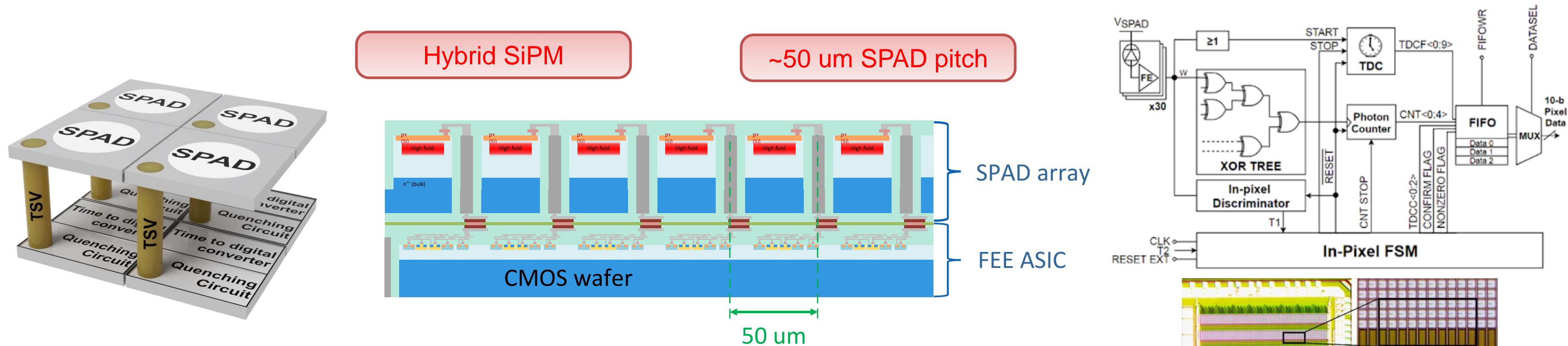
SPTR and CRT measured at FBK NUV-HD-SiPMs read by the FastIC ASIC developed by ICCUB.

**Sensor:** NUV-HD-LFv2 SiPMs, 3x3 mm<sup>2</sup>  
**Scintillator:** 2x2x3 mm<sup>3</sup> LSO:Ce,Ca  
**Power consumption:** 3 mW / channel

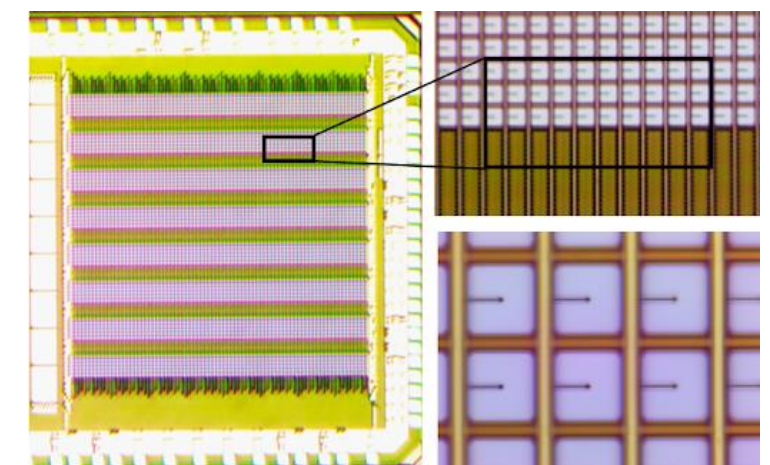
# 2.5D and 3D Integration

## Full 3D integration with micro TSVs: Hybrid SiPM

FBK is investigating the potential of microTSVs to achieve *single cell connection*. While complexity of the system increases, it might provide *ultimate timing performance*.



- FBK can apply all the *know-how on system architecture* already developed in the field of digital SiPMs.
- Finally solve the duality between analog and digital SiPM: *Hybrid SiPM concept*.

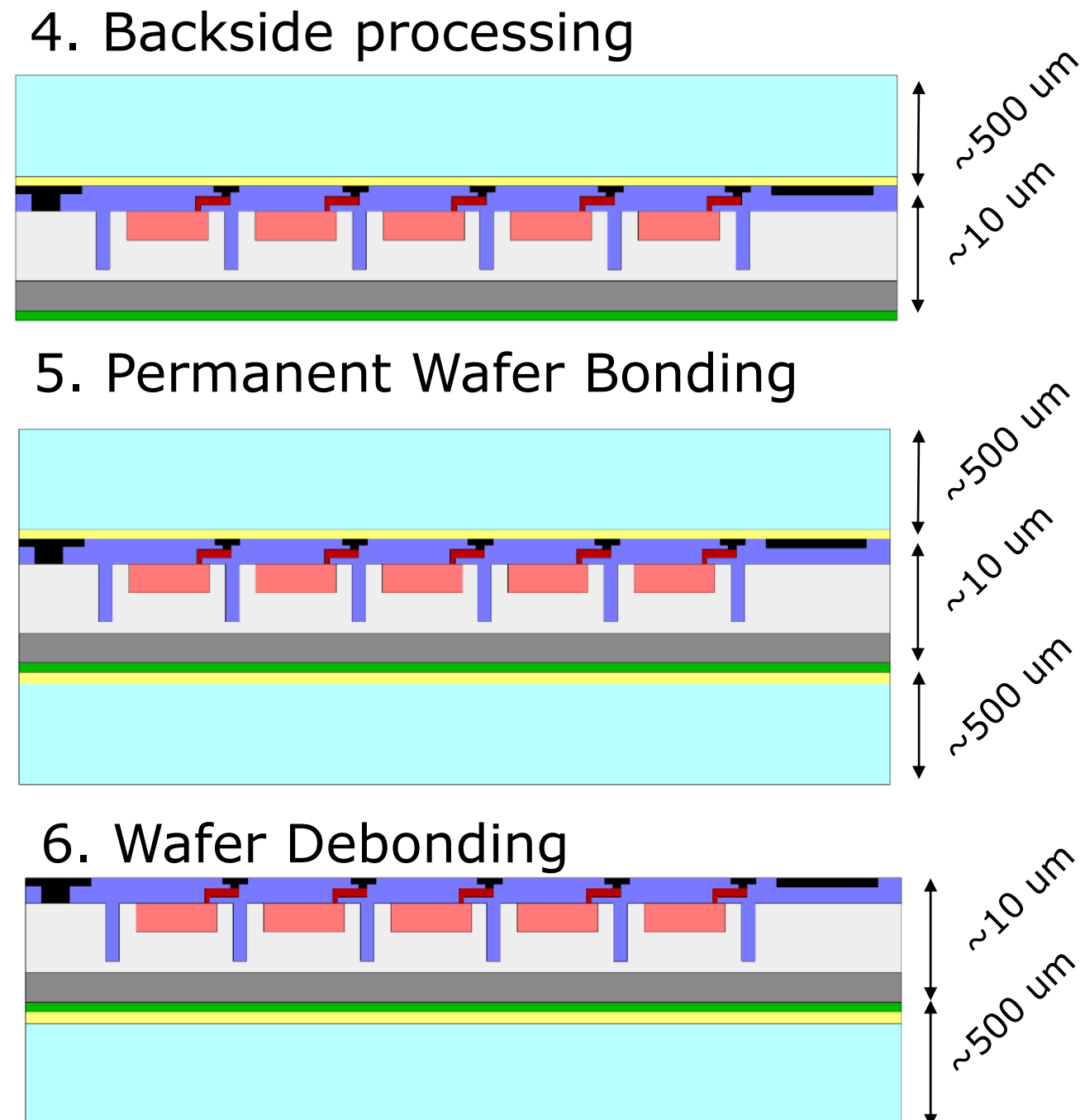
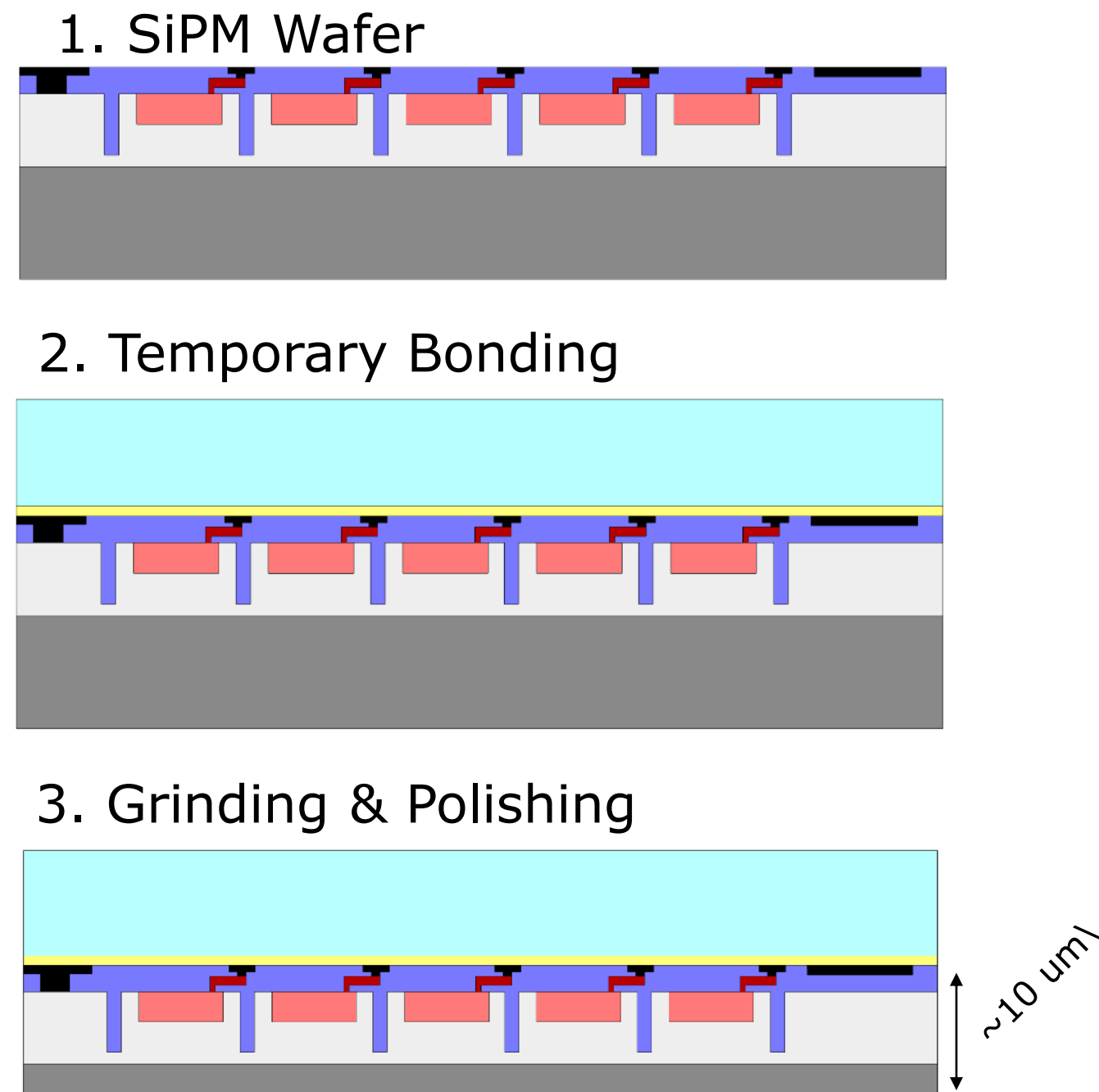


Example of dSiPM architecture developed at FBK (SBAM project)

# 2.5D and 3D Integration

## Backside Illuminated SiPMs: process flow

BSI development started on *NIR-sensitive SiPMs* → *no need to create a new entrance window* on the backside with high efficiency in the NUV.



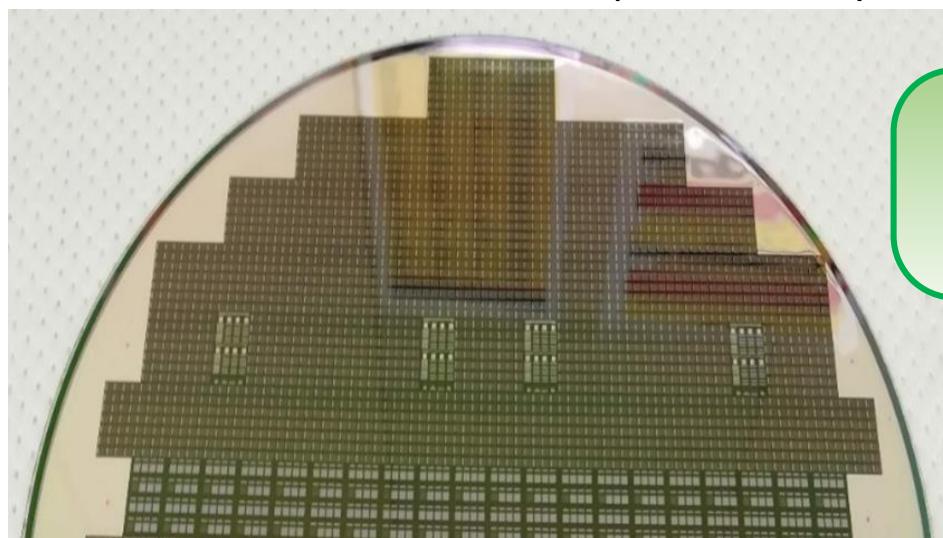
# 2.5D and 3D Integration

## BSI SiPMs: first results

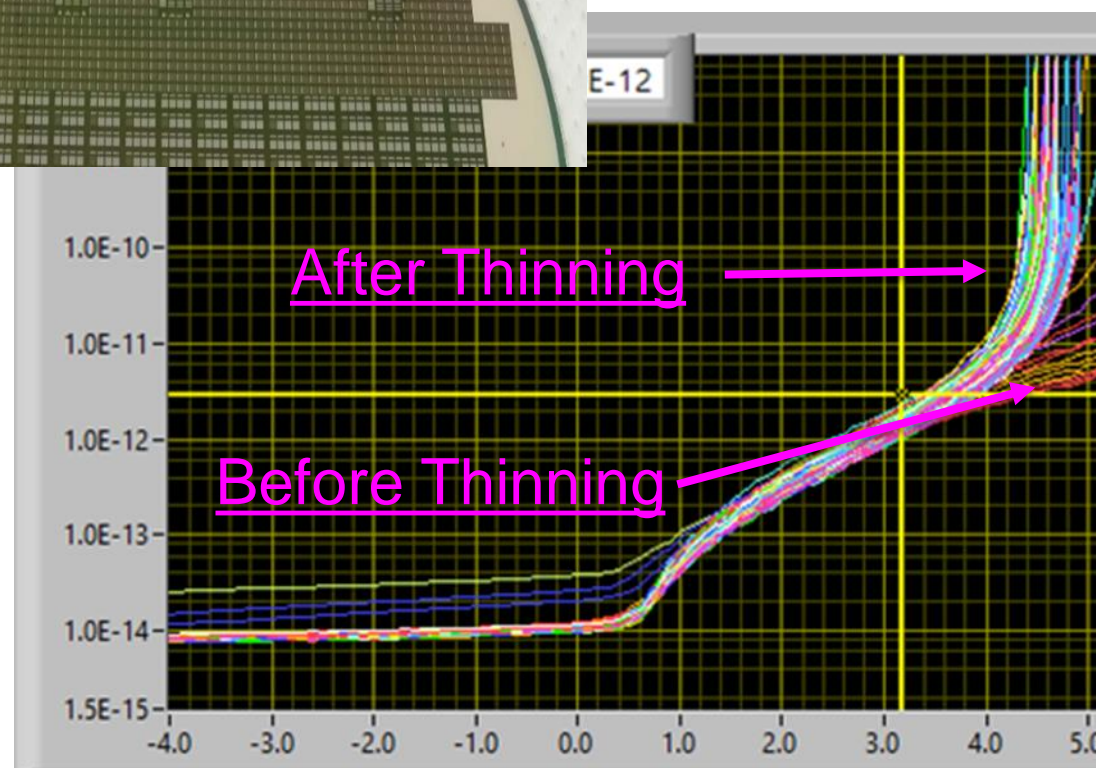
The *first NIR-sensitive BSI wafers were fabricated* in FBK clean room (1x1 mm<sup>2</sup> devices).

Minor differences in the IVs after thinning, compared to the FSI devices (without thinning).

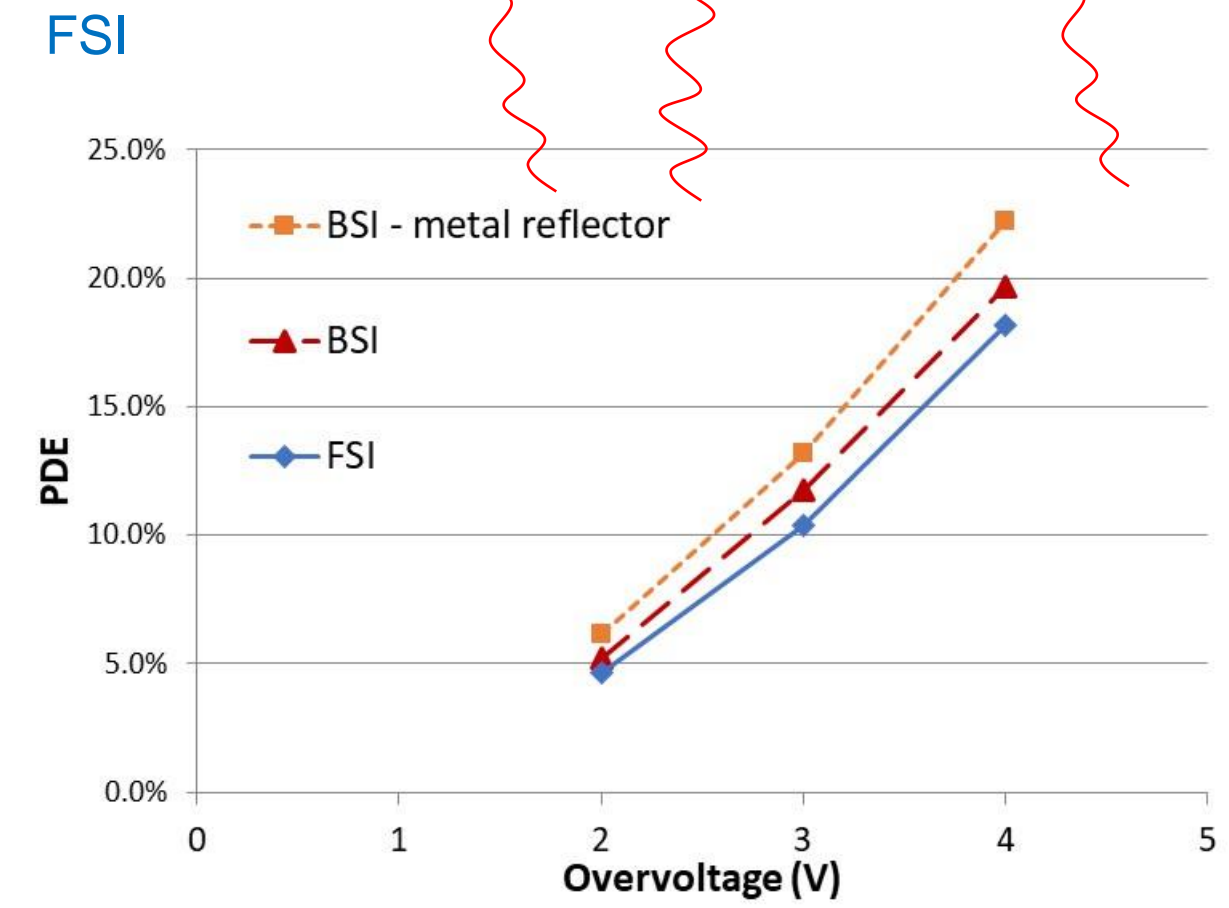
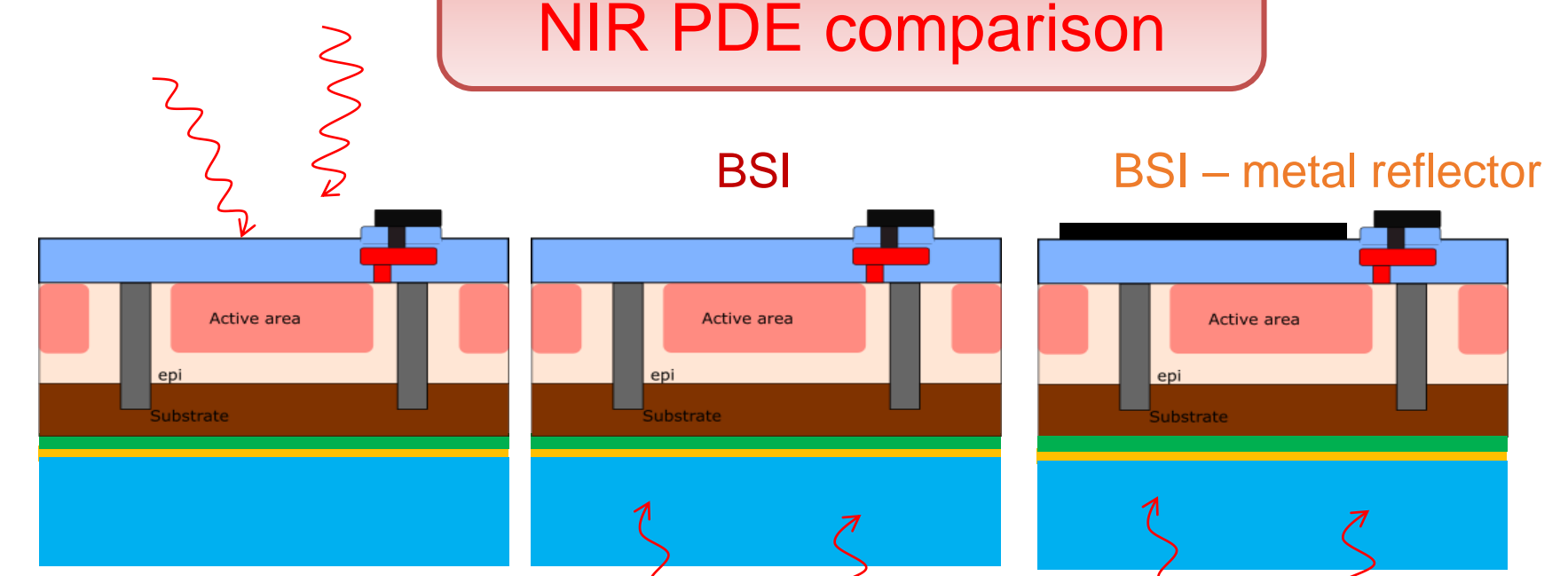
Ultrathin substrate (~ 10 μm)



NIR BSI process is working!



### NIR PDE comparison



# 2.5D and 3D Integration

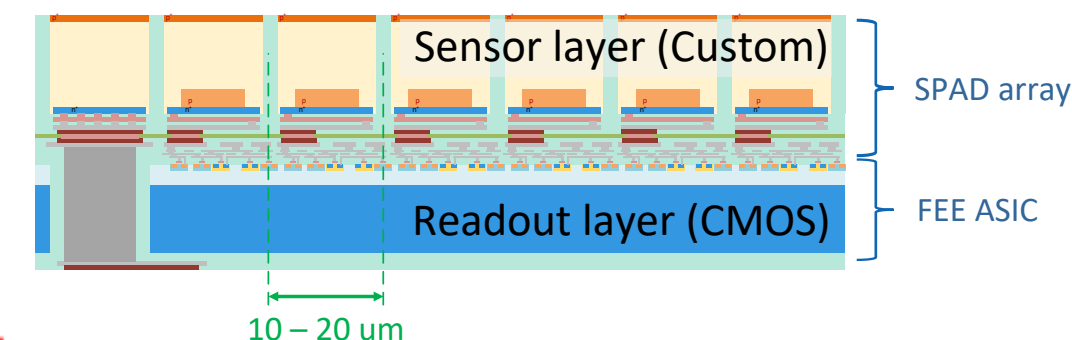
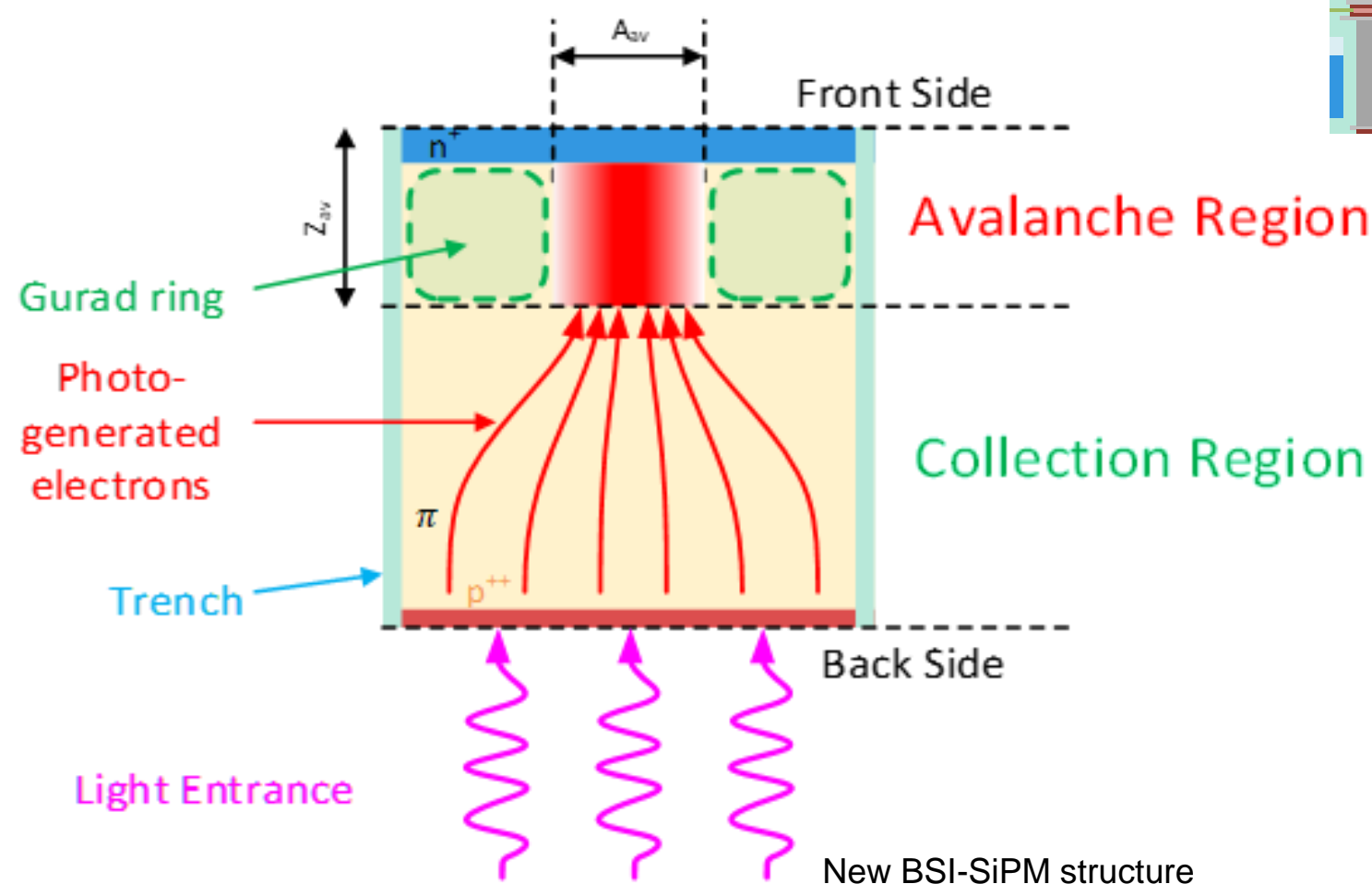
## Next-generation development: Backside Illuminated SiPMs

The next-generation of developments, currently being investigated at FBK, is building a *backside-illuminated, NUV-sensitive SiPM*. Several technological challenges should be overcome.

Clear *separation between charge collection and multiplication regions*.

### Potential Advantages:

- Up to 100% FF even with small cell pitch
- Ultimate Interconnection density:  $< 15 \text{ um}$
- High speed and dynamic range
- Low gain and external crosstalk
- (Uniform) entrance window on the backside, ideal for enhanced optical stack (VUV sensitivity, nanophotonics)
- Local electronics: ultra fast and possibly low-power.



### Development Risks:

- Charge collection time jitter
- Low Gain  $\rightarrow$  SPTR?
- Effectiveness of the new entrance window

### Radiation hardness:

- The SiPM area sensitive to radiation damage, is much smaller than the light sensitive area
- Assumption: the main source of DCR is field-enhanced generation (or tunneling).



# Thank you!



Thanks to all the members of the team working on custom SiPM technology at FBK:

- **Fabio Acerbi**
- **Andrea Ficorella**
- **Stefano Merzi**
- **Laura Parellada Monreal**
- **Elena Moretti**
- **Giovanni Palù**
- **Giovanni Paternoster**
- **Michele Penna**
- **Maria Ruzzarin**
- **Tiziano Stedile**
- **Nicola Zorzi**